

INCH-POUND

MIL-M-38510/315D
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SUPERSEDING
MIL-M-38510/315C
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MILITARY SPECIFICATION

MICROCIRCUITS, DIGITAL, LOW-POWER SCHOTTKY TTL, COUNTERS, MONOLITHIC SILICON

Inactive for new design after 18 April 1997.

This specification is approved for use by all Departments
and Agencies of the Department of Defense.

The requirements for acquiring the product herein shall consist of this specification sheet and MIL-PRF 38535

1. SCOPE

1.1 Scope. This specification covers the detail requirements for monolithic silicon, low power Schottky TTL, binary and decade counters. Two product assurance classes and a choice of case outlines/lead finish are provided for each type and are reflected in the complete part number. For this product, the requirements of MIL-M-38510 have been superseded by MIL-PRF-38535, (see 6.3).

1.2 Part or Identifying Number (PIN). The PIN should be in accordance with MIL-PRF-38535, and as specified herein.

1.2.1 Device types. The device types should be as follows:

<u>Device type</u>	<u>Circuit</u>
01	Decade counter
02	4-bit binary counter
03	Synchronous 4-bit decade counter (asynchronous clear)
04	Synchronous 4-bit binary counter (asynchronous clear)
05	Synchronous 4-bit up/down decade counter
06	Synchronous 4-bit up/down binary counter
07	Synchronous 4-bit up/down decade counter (with clear)
08	Synchronous 4-bit up/down binary counter (with clear)
09	Synchronous 4-bit up/down binary counter (with mode control)
10	Divide-by-twelve counter
11	Synchronous 4-bit decade counter (with synchronous clear)
12	Synchronous 4-bit binary counter (with synchronous clear)
13	Synchronous 4-bit decade counter (with mode control)

1.2.2 Device class. The device class should be the product assurance level as defined in MIL-PRF-38535.

Comments, suggestions, or questions on this document should be addressed to: Commander, Defense Supply Center Columbus, ATTN: DSCC-VAS, 3990 East Broad St., Columbus, OH 43216-5000, or emailed to bipolar@dsccl.dla.mil. Since contact information can change, you may want to verify the currency of this address information using the ASSIST Online database at www.dodssp.daps.mil.

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1.2.3 Case outlines. The case outlines should be as designated in MIL-STD-1835 and as follows:

<u>Outline letter</u>	<u>Descriptive designator</u>	<u>Terminals</u>	<u>Package style</u>
A	<u>GDFP5-F14 or CDFP6-F14</u>	14	Flat pack
B	<u>GDFP4-F14</u>	14	Flat pack
C	<u>GDIP1-T14 or CDIP2-T14</u>	14	Dual-in-line
D	<u>GDFP1-F14 or CDFP2-F14</u>	14	Flat pack
E	<u>GDIP1-T16 or CDIP2-T16</u>	16	Dual-in-line
F	<u>GDFP2-F16 or CDFP3-F16</u>	16	Flat pack
2	<u>CQCC1-N20</u>	20	Square leadless chip carrier

1.3 Absolute maximum ratings.

Supply voltage range	-0.5 V dc to 7.0 V dc
Input voltage range	-1.2 V dc at -18 mA to 5.5 V dc
Storage temperature range	-65° to +150°C
Maximum power dissipation, (P _D) <u>1/</u> :	
Device type 05, 06, 07, 08.....	187 mW
Device type 01, 02, 10.....	83 mW
Device type 03, 04, 11, 12.....	176 mW
Device type 09, 13	193 mW
Lead temperature (soldering, 10 seconds)	300°C
Thermal resistance, junction to case (θ _{JC}):	
Cases A, B, C, D, E, F, and 2	(See MIL-STD-1835)
Junction temperature (T _J) <u>3/</u>	175°C

1.4 Recommended operating conditions. 2/

Maximum low level output current (I _{oL})	4.0 mA
Supply voltage (V _{CC})	4.5 V dc minimum to 5.5 V dc maximum
Minimum high-level input voltage (V _{IH})	2.0 V dc
Maximum low-level input voltage (V _{IL})	0.7 V dc
Normalized fanout (each output)	
Types 01, 02, 05, 06, 07, 08, 10.....	10 maximum
Types 03, 04, 09, 11, 12, 13.....	
Low-level	10 maximum
High-level	20 maximum
Width of input count pulse, t _p (IN)	
Types 01, 02, 10	
Input A, reset	15 ns minimum
Input B	30 ns minimum
Types 07, 08	20 ns minimum
Width of reset pulse, t _p (reset)	
Types 01, 02, 10	25 ns minimum
Count enable time	
Type 09, enable	40 ns minimum

1/ Must withstand the added P_D due to short-circuit test (e.g., I_{os}).

2/ A change of states on the U/ \bar{D} input for device types 09 and 13 is not recommended when the clock input is low. This may result in an erroneous count.

3/ Maximum junction temperature shall not be exceeded except for allowable short duration burn-in screening conditions in accordance with MIL-PRF-38535.

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Input clock frequency, f_{clock}	
Types 01, 02, 10	
Input A	0 to 29 MHz
Types 03, 04, 11, 12	0 to 22 MHz
Types 09, 13	0 to 18 MHz
Types 07, 08	0 to 20 MHz
Types 05, 06	0 to 25 MHz
Width of clock pulse, $t_w(\text{clock})$	
Types 03, 06, 09, 11, 12, 13	25 ns minimum
Types 04	30 ns minimum
Types 05	20 ns minimum
Width of clear pulse, $t_w(\text{clear})$	
Types 03, 04, 05, 06, 07, 08, 11, 12	20 ns minimum
Setup time, t_{setup}	
Types 03, 11, 12	
Enable P	25 ns minimum
Load	25 ns minimum
Clear (types 11 and 12 only)	20 ns minimum
Type 04	
Enable P	35 ns minimum
Load	35 ns minimum
Data inputs	
Types 03, 09, 11, 12, 13	20 ns minimum
Type 04	25 ns minimum
Types 07, 08	30 ns minimum
Type 05	
Data, L inputs	15 ns minimum
U/\bar{D} input	30 ns minimum
EP, ET inputs	15 ns minimum
Type 06	
Data, L inputs	25 ns minimum
U/\bar{D} input	30 ns minimum
EP, ET, inputs	25 ns minimum
Hold time at any input, t_{hold}	
Types 09, 13	0 ns minimum
Types 07, 08	10 ns minimum
Types 05, 06	
Data, EP, ET inputs	5 ns minimum
L, U/\bar{D} inputs	0 ns minimum
Types 03, 04, 11, 12	10 ns minimum
Types 03, 04, 11, 12 $t_w(\text{clear})$	0 ns minimum
Case operating temperature range (T_c)	-55°C to +125°C

2. APPLICABLE DOCUMENTS

2.1 General. The documents listed in this section are specified in sections 3, 4, or 5 of this specification. This section does not include documents cited in other sections of this specification or recommended for additional information or as examples. While every effort has been made to ensure the completeness of this list, document users are cautioned that they must meet all specified requirements of documents cited in sections 3, 4, or 5 of this specification, whether or not they are listed.

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2.2 Government documents.

2.2.1 Specifications and Standards. The following specifications and standards form a part of this specification to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

DEPARTMENT OF DEFENSE SPECIFICATIONS

MIL-PRF-38535 - Integrated Circuits (Microcircuits) Manufacturing, General Specification for.

DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883 - Test Method Standard for Microelectronics.

MIL-STD-1835 - Interface Standard Electronic Component Case Outlines

(Copies of these documents are available online at <http://assist.daps.dla.mil;quicksearch/> or www.dodssp.daps.mil or from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.3 Order of precedence. In the event of a conflict between the text of this specification and the references cited herein, the text of this document takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Qualification. Microcircuits furnished under this specification shall be products that are manufactured by a manufacturer authorized by the qualifying activity for listing on the applicable qualified manufacturers list before contract award (see 4.3 and 6.4).

3.2 Item requirements. The individual item requirements shall be in accordance with MIL-PRF-38535 and as specified herein or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein.

3.3 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535 and herein.

3.3.1 Terminal connections and logic diagrams. The terminal connections and logic diagrams shall be as specified on figures 1 and 2.

3.3.2 Truth tables. The truth tables and logic equations shall be as specified on figure 3.

3.3.4 Schematic circuits. The schematic circuits shall be maintained by the manufacturer and made available to the qualifying activity and the preparing activity (DSCC-VAS) upon request.

3.3.5 Case outlines. The case outlines shall be as specified in 1.2.3.

3.4 Lead material and finish. The lead material and finish shall be in accordance with MIL-PRF-38535 (see 6.6).

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3.5 Electrical performance characteristics. The electrical performance characteristics are as specified in table I, and apply over the full recommended case operating temperature range, unless otherwise specified.

3.6 Electrical test requirements. The electrical test requirements for each device class shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table III.

3.7 Marking. Marking shall be in accordance with MIL-PRF-38535.

3.8 Microcircuit group assignment. The devices covered by this specification shall be in microcircuit group number 12 (see MIL-PRF-38535, appendix A).

4. VERIFICATION

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not effect the form, fit, or function as described herein.

4.2 Screening. Screening shall be in accordance with MIL-PRF-38535 and shall be conducted on all devices prior to qualification and quality conformance inspection. The following additional criteria shall apply:

- a. The burn-in test duration, test condition, and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document control by the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015 of MIL-STD-883.
- b. Interim and final electrical test parameters shall be as specified in table II, except interim electrical parameters test prior to burn-in is optional at the discretion of the manufacturer.
- c. Additional screening for space level product shall be as specified in MIL-PRF-38535, appendix B.

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TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions -55°C ≤ T _C ≤ +125°C unless otherwise specified	Device types	Limits		Unit
				Min	Max	
Low-level output voltage	V _{OL}	V _{CC} = 4.5 V, V _{IH} = 2.0 V V _{IL} = 0.7 V, I _{OL} = 4 mA <u>1/</u>	All	-	0.4	V
High-level output voltage	V _{OH}	V _{CC} = 4.5 V, V _{IH} = 2.0 V V _{IL} = 0.7 V, I _{OH} = -400m μA	All	2.5	-	V
Input clamp voltage	V _{IC}	T _C = 25°C, V _{CC} = 4.5 V I _{IN} = -18 mA	All	-	-1.5	V
Low-level input current at reset inputs	I _{IL1}	V _{CC} = 5.5 V, V _{IN} = 0.4 V	01, 02, 10	-30	-400	μA
Low-level input current at input A	I _{IL2}		01, 02, 10	-0.5	-2.4	mA
Low-level input current at input B	I _{IL3}		01, 10	-0.4	-3.2	mA
Low-level input current at data, clear, EnP	I _{IL4}		02	-0.4	-1.6	mA
Low-level input current at data, EnP	I _{IL4}		03, 04	-30	-400	μA
Low-level input current at clear	I _{IL4}		01, 12	-30	-400	μA
Low-level input current at load	I _{IL5}		01, 12	-30	-760	μA
Low-level input current at load	I _{IL5}		03, 04, 11, 12	-30	-800	μA
Low-level input current at EnT	I _{IL5}		03, 04, 11, 12	-30	-860	μA
Low-level input current at clock	I _{IL6}		03, 04, 11, 12	0	-.630	mA
Low-level input current at EnG	I _{IL7}		09	-.15	-1.08	mA
Low-level input current at data, clock, down/up	I _{IL8}		13	-.36	-1.08	mA
Low-level input current at load	I _{IL8}		09, 13	-120	-400	μA
Low-level input current at data	I _{IL9}		09, 13	-100	-400	μA
Low-level input current at load	I _{IL10}		07, 08	-100	-400	μA
Low-level input current at clear, count up, count down	I _{IL11}	07, 08	-100	-400	μA	
Low-level input current at data	I _{IL12}	07, 08	-120	-400	μA	
Low-level input current at clock, down/up	I _{IL13}	05, 06	-3.0	-400	μA	
Low-level input current at EP	I _{IL14}	05, 06	-135	-370	μA	
Low-level input current at ET	I _{IL15}	05, 06	-150	-385	μA	
Low-level input current at ET	I _{IL15}	05, 06	-280	-760	μA	

See footnotes at end of table.

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TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions -55°C ≤ T _C ≤ +125°C unless otherwise specified	Device types	Limits		Unit
				Min	Max	
High-level input current at reset inputs	I _{IH1}	V _{CC} = 5.5 V, V _{IN} = 2.7 V	01, 02 10	-	20	μA
High-level input current at reset inputs	I _{IH2}	V _{CC} = 5.5 V, V _{IN} = 5.5 V	01, 02 10	-	100	μA
High-level input current at input A	I _{IH3}	V _{CC} = 5.5 V, V _{IN} = 2.7 V	01, 02 10	-	80	μA
High-level input current at input A	I _{IH4}	V _{CC} = 5.5 V, V _{IN} = 5.5 V	01, 02, 10	-	400	μA
High-level input current at input B	I _{IH5}	V _{CC} = 5.5 V, V _{IN} = 2.7 V	01	-	160	μA
			02, 10	-	80	
High-level input current at input B	I _{IH6}	V _{CC} = 5.5 V, V _{IN} = 5.5 V	01	-	800	μA
			02, 10	-	400	
High-level input current at load, clock, EnT	I _{IH9}	V _{CC} = 5.5 V, V _{IN} = 2.7 V	03, 04, 11, 12	-	40	μA
High-level input current at load, clock, EnT	I _{IH10}	V _{CC} = 5.5 V, V _{IN} = 5.5 V	03, 04, 11, 12	-	200	μA
High-level input current at data, EnP	I _{IH11}	V _{CC} = 5.5 V, V _{IN} = 2.7 V	03, 04, 11, 12	-	20	μA
High-level input current at data, EnP	I _{IH12}	V _{CC} = 5.5 V, V _{IN} = 5.5 V	03, 04, 11, 12	-	100	μA
High-level input current at clear	I _{IH13}	V _{CC} = 5.5 V, V _{IN} = 2.7 V	03, 04, 11, 12	-	20	μA
			11, 12	-	40	
High-level input current at clear	I _{IH14}	V _{CC} = 5.5 V, V _{IN} = 5.5 V	03, 04	-	100	μA
			11, 12	-	200	
High-level input current at EnG	I _{IH15}	V _{CC} = 5.5 V, V _{IN} = 2.7 V	09, 13	-	60	μA
High-level input current at EnG	I _{IH16}	V _{CC} = 5.5 V, V _{IN} = 5.5 V	09, 13	-	300	μA
High-level input current at data, load, clear, count up, count down, clock, down/up	I _{IH17}	V _{CC} = 5.5 V, V _{IN} = 2.7 V	05, 06 07, 08 09, 13	-	20	μA
High-level input current at data, load, clear, count up, count down, clock, down/up	I _{IH18}	V _{CC} = 5.5 V, V _{IN} = 5.5 V	05, 06 07, 08 09, 13	-	100	μA
High-level input current at ET	I _{IH19}	V _{CC} = 5.5 V, V _{IN} = 2.7 V	05, 06	-	40	μA

See footnotes at end of table.

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TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions -55°C ≤ T _C ≤ +125°C unless otherwise specified	Device types	Limits		Unit
				Min	Max	
High-level input current at ET	I _{IH20}	V _{CC} = 5.5 V, V _{IN} = 5.5 V	05, 06	-	200	μA
Short circuit output current	I _{OS}	V _{CC} = 5.5 V <u>2/</u>	All	-15	-130	mA
Supply current	I _{CC}	V _{CC} = 5.5 V	01,02,10		15	mA
			05,06,07,08		34	
			09, 13		35	
High-level supply current	I _{CCH}	V _{CC} = 5.5 V, <u>3/</u>	03, 04, 11, 12	-	31	mA
High-level supply current	I _{CCH}	V _{CC} = 5.5 V, <u>3/</u>	03, 04 11, 12	-	31	mA
Low-level supply current	I _{CCL}	V _{CC} = 5.5 V, <u>4/</u>	03, 04 11, 12	-	32	mA
Maximum input A, clock, or count up frequency	F _{MAX}	V _{CC} = 5.0 V, C _L = 50 pF, ±10% R _L = 2 kΩ	05, 06	25	-	MHz
			01, 02, 10	29		
			03, 04, 07, 08, 11, 12	22		
			09, 13	18	-	
Propagation delay time, high to low, A to Q _C	t _{PHL1}		01,02,10	3	81	ns
Propagation delay time, low to high, A to Q _C	t _{PLH1}		01, 10	3	74	ns
			02	3	74	
Propagation delay time, high to low, B to Q _D	t _{PHL2}		01, 10	3	56	ns
			02	3	78	
Propagation delay time, low to high, B to Q _D	t _{PLH2}		01, 10	3	52	ns
			02	3	78	
Propagation delay time, low to high, clock to carry	t _{PLH4}		03, 04, 11, 12	3	56	ns
Propagation delay time, high to low, clock to carry	t _{PHL4}		03, 04, 11, 12	3	56	ns

See footnotes at end of table.

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TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions -55°C ≤ T _C ≤ +125°C unless otherwise specified	Device types	Limits		Unit
				Min	Max	
Propagation delay time, low to high, clock to Q	t _{PLH5}	V _{CC} = 5.0 V, C _L = 50 pF, ±10% R _L = 2 kΩ	03, 04, 11, 12	3	41	ns
Propagation delay time, high to high, clock to Q	t _{PHL5}		03, 04, 11, 12	3	45	ns
Propagation delay time, low to high, clock to Q	t _{PLH5}		05, 06	3	26	ns
Propagation delay time, high to low, clock to Q	t _{PHL5}		05	3	26	ns
			06	3	36	
Propagation delay time, low to high, clock (data) to Q	t _{PLH6}		03, 04, 11, 12	3	42	ns
Propagation delay time, high to low, clock (data) to Q	t _{PHL6}		03, 04, 11, 12	3	48	ns
Propagation delay time, low to high, EnT to carry	t _{PLH7}		03, 04, 11, 12	3	28	ns
Propagation delay time, high to low, EnT to carry	t _{PHL7}		03, 04, 11, 12	3	28	ns
			05	3	18	
Propagation delay time, low to high, ET to RC	t _{PLH7}		06	3	28	ns
			05	3	28	
Propagation delay time, high to low, ET to RC	t _{PHL7}		06	3	32	ns
			03, 04, 11, 12	3	46	
Propagation delay time, high to low, clear to Q	t _{PHL8}		07, 08	3	63	ns
Propagation delay time, low to high, load to Q	t _{PLH8}		07, 08	3	63	ns
Propagation delay time, high to low, load to Q	t _{PHL10}	07, 08	3	63	ns	
		07, 08	3	60		
		05	3	26		
Propagation delay time, low to high, counts up and down to Q, U/ \bar{D} to RC	t _{PLH9}	06	3	32	ns	
		06	3	32		

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions -55°C ≤ T _C ≤ +125°C unless otherwise specified	Device types	Limits		Unit
				Min	Max	
Propagation delay time, high to low, counts up and down to Q, U/D to RC	t _{PHL11}	V _{CC} = 5.0 V, C _L = 50 pF, ±10% R _L = 2 kΩ	07, 08	3	73	ns
			05	3	33	
			06	3	37	
Propagation delay time, high to low, clear to Q	t _{PHL12}		07, 08	3	56	ns
Propagation delay time, low to high, load to Q	t _{PLH10}		09, 13	3	53	ns
Propagation delay time, high to low, load to Q	t _{PHL13}		09, 13	3	77	ns
Propagation delay time, low to high, clock to Q	t _{PLH11}		09, 13	3	41	ns
Propagation delay time, high to low, clock to Q	t _{PHL14}		09, 13	3	57	ns
Propagation delay time, low to high, clock to <u>Max</u> <u>Min</u>	t _{PLH12}		09, 13	3	66	ns
Propagation delay time, low to high, clock to ripple carry	t _{PLH12}	05	3	35	ns	
		06	3	38		
Propagation delay time, high to low, clock to <u>Max</u> <u>Min</u>	t _{PHL15}	09, 13	3	80	ns	
Propagation delay time, high to low, clock to ripple carry	t _{PHL15}	05	3	37	ns	
		06	3	40		

1/ Use I_{OL} + I_{IL3(Max)} for V_{OL} test on Q_A.

2/ Not more than one output should be shorted at a time.

3/ I_{CCH} is measured : (a) With the load input high; and (b) Then again with the load input low with all other inputs high and all outputs open.

4/ I_{CCL} is measured: (a) With the clock input high; and (b) Then again with the clock input low with all other inputs low and all outputs open.

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TABLE II. Electrical test requirements.

MIL-PRF-38535 test requirements	Subgroups (see table III)	
	Class S devices	Class B devices
Interim electrical parameters	1	1
Final electrical test parameters	1*, 2, 3, 7, 9, 10, 11	1*, 2, 3, 7, 9
Group A test requirements	1, 2, 3, 7, 8, 9, 10, 11	1, 2, 3, 7, 8, 9, 10, 11
Group B test when using the method 5005 QCI option	1, 2, 3, 7, 8, 9, 10, 11	N/A
Group C end-point electrical parameters	1, 2, 3, 7, 8, 9, 10, 11	1, 2, 3
Group D end-point electrical parameters	1, 2, 3	1, 2, 3

*PDA applies to subgroup 1.

4.3 Qualification inspection. Qualification inspection shall be in accordance with MIL-PRF-38535 .

4.4 Technology Conformance inspection (TCI). Technology conformance inspection shall be in accordance with MIL-PRF-38535 and herein for groups A, B, C, and D inspections (see 4.4.1 through 4.4.4).

4.4.1 Group A inspection. Group A inspection shall be in accordance with table III of MIL-PRF-38535 and as follows:

- a. Tests shall be as specified in table II herein.
- b. Subgroups 4, 5, and 6 shall be omitted.

4.4.2 Group B inspection. Group B inspection shall be in accordance with table II MIL-PRF-38535.

4.4.3 Group C inspection. Group C inspection shall be in accordance with table IV of MIL-PRF-38535 and as follows:

- a. End-point electrical parameters shall be as specified in table II herein.
- b. The steady-state life test duration, test condition, and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document control by the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.

4.4.4 Group D inspection. Group D inspection shall be in accordance with table V of MIL-PRF-38535. End-point electrical parameters shall be as specified in table II herein.

4.5 Methods of inspection. Methods of inspection shall be specified and as follows:

4.5.1 Voltage and current. All voltages given are referenced to the microcircuit ground terminal. Currents given are conventional and positive when flowing into the referenced terminal.

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Pin number	Device type 01		Device type 02		Device type 03		Device type 04	
	CASES							
	A, B, C, and D	2	A, B, C, and D	2	E,F	2	E,F	2
1	BD INPUT	N/C	INPUT B	N/C	CLEAR	N/C	CLEAR	N/C
2	R ₀ ⁽¹⁾	BD INPUT	R ₀₍₁₎	INPUT B	CLOCK	CLEAR	CLOCK	CLEAR
3	R ₀ ⁽²⁾	R ₀ ⁽¹⁾	R ₀₍₂₎	R ₀ ⁽¹⁾	INPUT A	CLOCK	INPUT A	CLOCK
4	NC	R ₀ ⁽²⁾	NC	R ₀ ⁽²⁾	INPUT B	INPUT A	INPUT B	INPUT A
5	V _{CC}	N/C	V _{CC}	N/C	INPUT C	INPUT B	INPUT C	INPUT B
6	R ₉₍₁₎	N/C	NC	N/C	INPUT D	N/C	INPUT D	N/C
7	R ₉₍₂₎	N/C	NC	N/C	ENABLE P	INPUT C	ENABLE P	INPUT C
8	OUTPUT C	V _{CC}	OUTPUT C	V _{CC}	GND	INPUT D	GND	INPUT D
9	OUTPUT B	R ₉ ⁽¹⁾	OUTPUT B	N/C	LOAD	ENABLE P	LOAD	ENABLE P
10	GND	R ₉ ⁽²⁾	GND	N/C	ENABLE T	GND	ENABLE T	GND
11	OUTPUT D	N/C	OUTPUT D	N/C	Q _D	N/C	Q _D	N/C
12	OUTPUT A	OUTPUT C	OUTPUT A	OUTPUT C	Q _C	LOAD	Q _C	LOAD
13	NC	OUTPUT B	NC	OUTPUT B	Q _B	T	Q _B	T
14	INPUT A	GND	INPUT A	GND	Q _A	Q _D	Q _A	Q _D
15		N/C		N/C	CARRY OUTPUT	Q _C	CARRY OUTPUT	Q _C
16		OUTPUT D		OUTPUT D	V _{CC}	N/C	V _{CC}	N/C
17		N/C		N/C		Q _B		Q _B
18		OUTPUT A		OUTPUT A		Q _A		Q _A
19		N/C		N/C	CARRY OUTPUT	CARRY OUTPUT		
20		INPUT A		INPUT A	V _{CC}	V _{CC}		

FIGURE 1. Terminal connections.

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Pin number	Device type 05		Device type 06		Device type 07		Device type 08	
	CASES							
	E, F	2	E, F	2	E, F	2	E, F	2
1	U/ \bar{D}	N/C	U/ \bar{D}	N/C	DATA B INPUT	N/C	DATA B INPUT	N/C
2	CK	U/ \bar{D}	CK	U/ \bar{D}	Q _B	DATA B INPUT	Q _B	DATA B INPUT
3	INPUT A	CK	INPUT A	CK	Q _A	Q _B	Q _A	Q _B
4	INPUT B	INPUT A	INPUT B	INPUT A	COUNT DOWN	Q _A	COUNT DOWN	Q _A
5	INPUT C	INPUT B	INPUT C	INPUT B	COUNT UP	COUNT DOWN	COUNT UP	COUNT DOWN
6	INPUT D	N/C	INPUT D	N/C	Q _C	N/C	Q _C	N/C
7	ENABLE P	INPUT C	ENABLE P	INPUT C	Q _D	COUNT UP	Q _D	COUNT UP
8	GND	INPUT D	GND	INPUT D	GND	Q _C	GND	Q _C
9	LOAD	ENABLE P	LOAD	ENABLE P	DATA D	Q _D	DATA D	Q _D
10	ENABLE T	GND	ENABLE T	GND	DATA C	GND	DATA C	GND
11	Q _D	N/C	Q _D	N/C	LOAD	N/C	LOAD	N/C
12	Q _C	LOAD	Q _C	LOAD	CARRY	DATA D	CARRY	DATA D
13	Q _B	ENABLE T	Q _B	ENABLE T	BORROW	DATA C	BORROW	DATA C
14	Q _A	Q _D	Q _A	Q _D	CLEAR	LOAD	CLEAR	LOAD
15	RIPPLE CARRY OUTPUT	Q _C	RIPPLE CARRY OUTPUT	Q _C	DATA A	CARRY	DATA A	CARRY
16	V _{CC}	N/C	V _{CC}	N/C	V _{CC}	N/C	V _{CC}	N/C
17		Q _B		Q _B		BORROW		BORROW
18		Q _A		Q _A		CLEAR		CLEAR
19		RC OUTPUT		RC OUTPUT		DATA A		DATA A
20		V _{CC}		V _{CC}		V _{CC}		V _{CC}

FIGURE 1. Terminal connections - Continued.

MIL-M-38510/315D

Pin number	Device type 09		Device type 10		Device type 11		Device type 12	
	CASES							
	E, F	2	A, B C, and D	2	E, F	2	E, F	2
1	DATA B	N/C	INPUT BC	N/C	CLEAR	N/C	CLEAR	N/C
2	Q _B	DATA B	NC	INPUT BC	CLOCK	CLEAR	CLOCK	CLEAR
3	Q _A	Q _B	NC	N/C	INPUT A	CLOCK	INPUT A	CLOCK
4	ENABLE G	Q _A	NC	N/C	INPUT B	INPUT A	INPUT B	INPUT A
5	DOWN UP	ENABLE G	V _{CC}	N/C	INPUT C	INPUT B	INPUT C	INPUT B
6	Q _C	N/C	R _{O(1)}	N/C	INPUT D	N/C	INPUT D	N/C
7	Q _D	DOWN UP	R _{O(2)}	N/C	ENABLE P	INPUT C	ENABLE P	INPUT C
8	GND	Q _C	OUTPUT D	V _{CC}	GND	INPUT D	GND	INPUT D
9	DATA D	Q _D	OUTPUT C	R _{O(1)}	LOAD	ENABLE P	LOAD	ENABLE P
10	DATA C	GND	GND	R _{O(2)}	ENABLE T	GND	ENABLE T	GND
11	LOAD	N/C	OUTPUT B	N/C	Q _D	N/C	Q _D	N/C
12	MAX/MIN	DATA D	OUTPUT A	OUTPUT D	Q _C	LOAD	Q _C	LOAD
13	RIPPLE CLOCK	DATA C	NC	OUTPUT C	Q _B	T	Q _B	T
14	CLOCK	LOAD	INPUT A	GND	Q _A	Q _D	Q _A	Q _D
15	DATA A	MAX/MIN		N/C	CARRY OUTPUT	Q _C	CARRY OUTPUT	Q _C
16	V _{CC}	N/C		OUTPUT B	V _{CC}	N/C	V _{CC}	N/C
17		R _C		N/C	Q _B		Q _B	Q _B
18		CLOCK		OUTPUT A	Q _A		Q _A	
19		DATA A		N/C	CARRY OUTPUT		CARRY OUTPUT	
20		V _{CC}		INPUT A	V _{CC}		V _{CC}	

FIGURE 1. Terminal connections - Continued.

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Pin number	Device type 13	
	CASES	
	E, F	2
1	DATA B	N/C
2	Q _B	DATA B
3	Q _A	Q _B
4	ENABLE G	Q _A
5	DOWN UP	ENABLE G
6	Q _C	N/C
7	Q _D	DOWN UP
8	GND	Q _C
9	DATA D	Q _D
10	DATA C	GND
11	LOAD	N/C
12	MAX/ MIN	DATA D
13	RIPPLE CLOCK	DATA C
14	CLOCK	LOAD
15	DATA A	MAX/ MIN
16	V _{CC}	N/C
17		R _C
18		CLOCK
19		DATA A
20		V _{CC}

FIGURE 1. Terminal connections - Continued

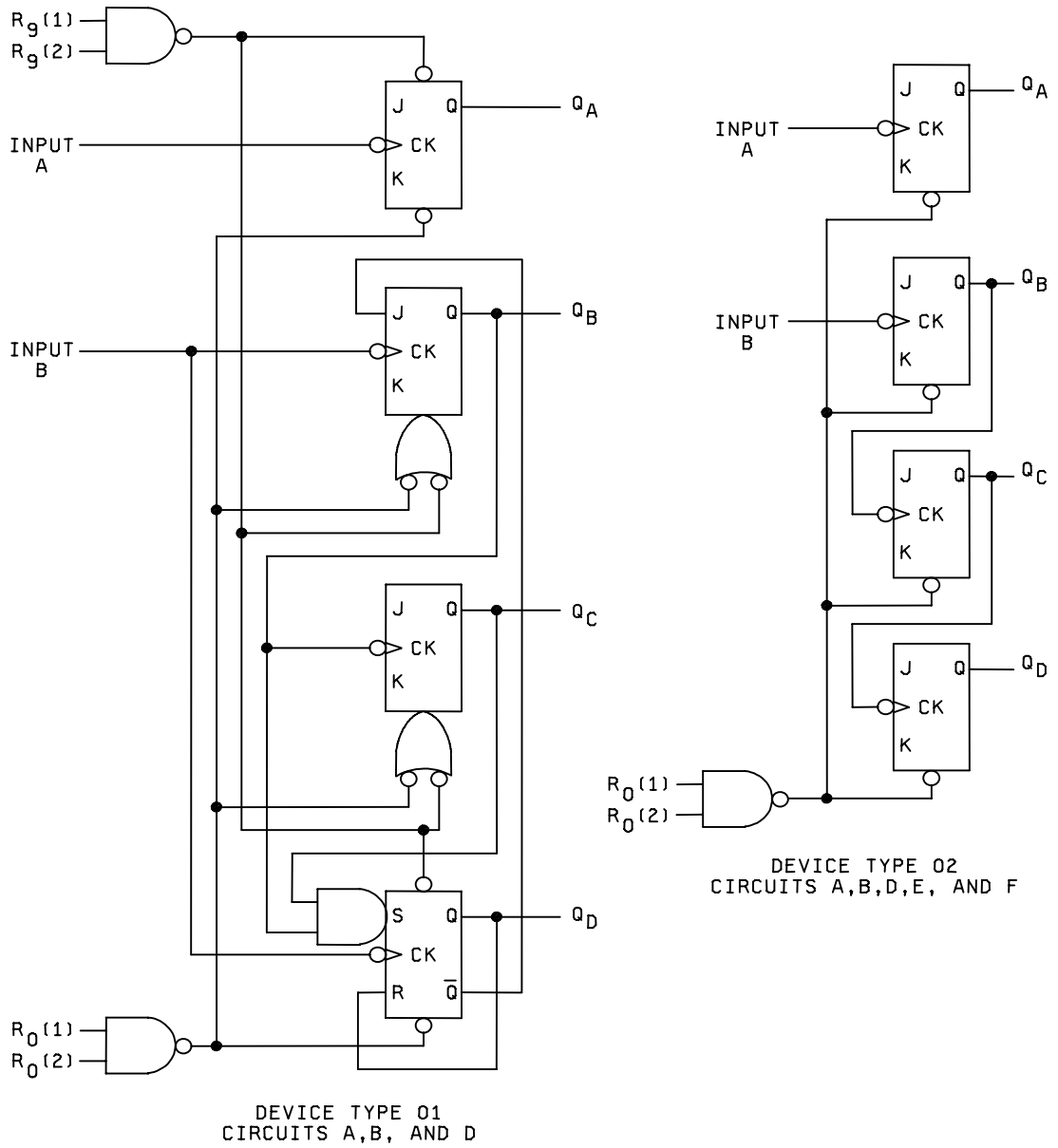
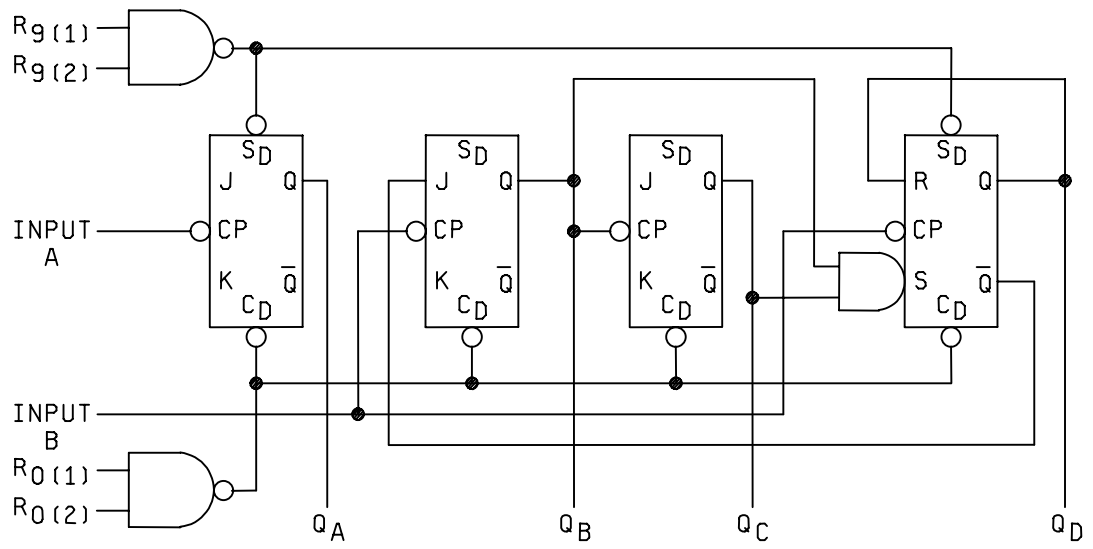
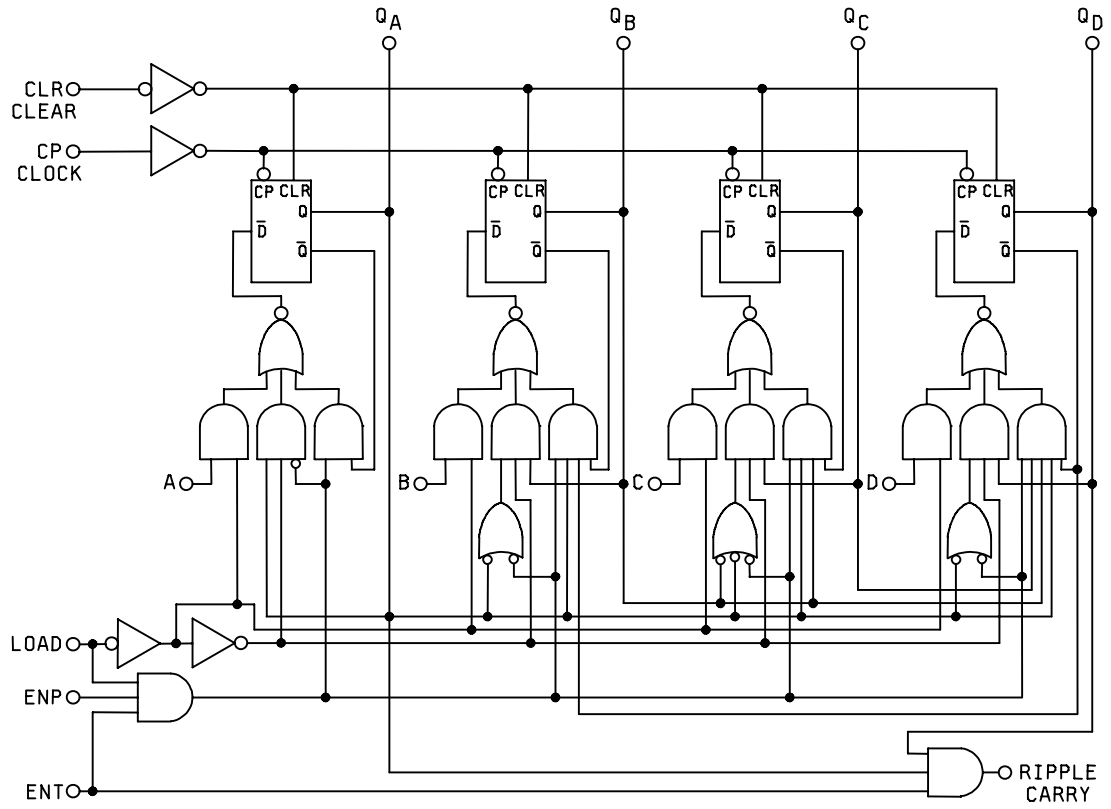


FIGURE 2. Logic diagrams



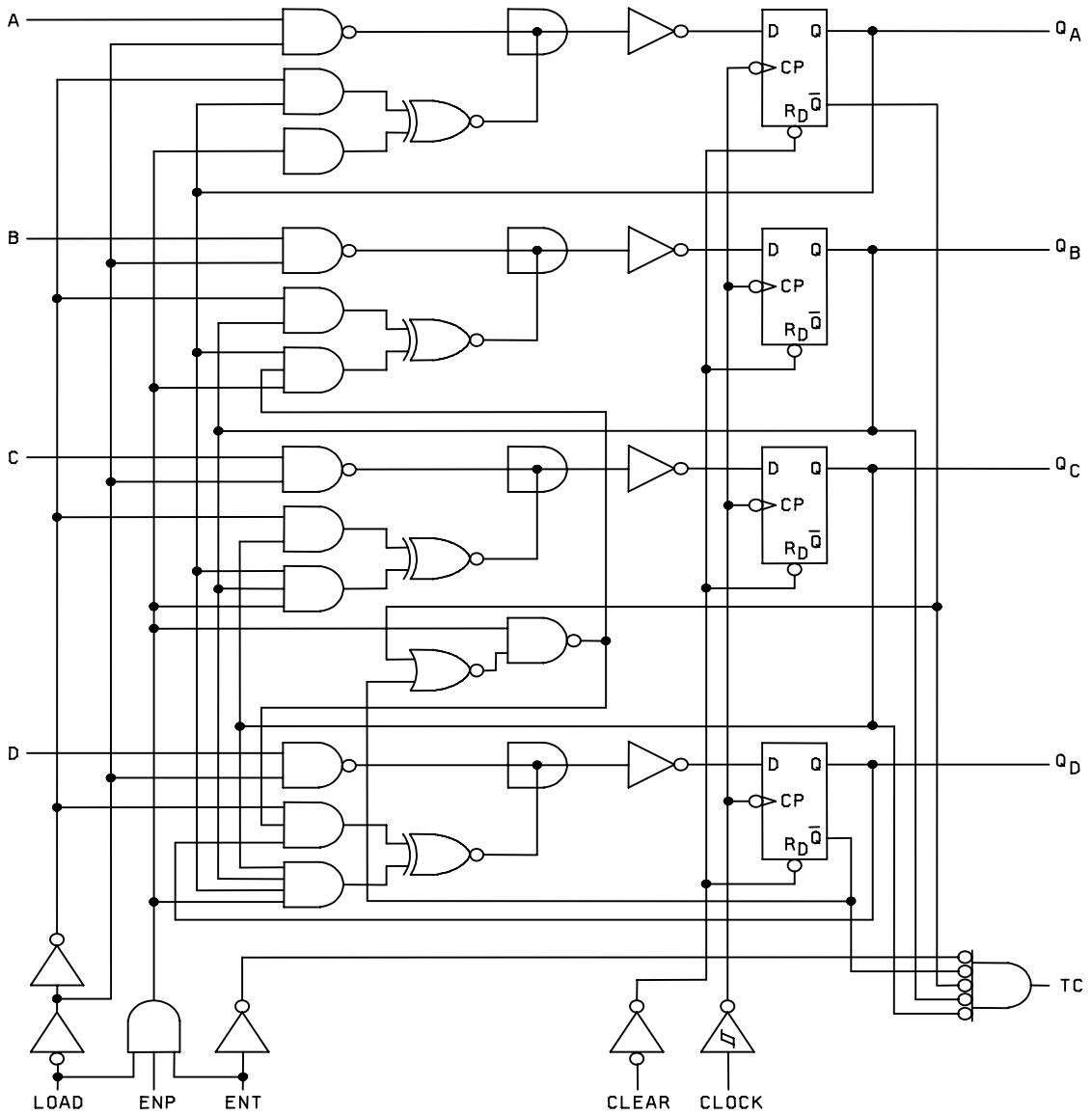
DEVICE TYPE 01
CIRCUITS E AND F

FIGURE 2. Logic diagrams – Continued.



DEVICE TYPE 03
CIRCUITS A,C,D, AND G

FIGURE 2. Logic diagrams – Continued.



DEVICE TYPE 03
CIRCUIT B

FIGURE 2. Logic diagrams – Continued.

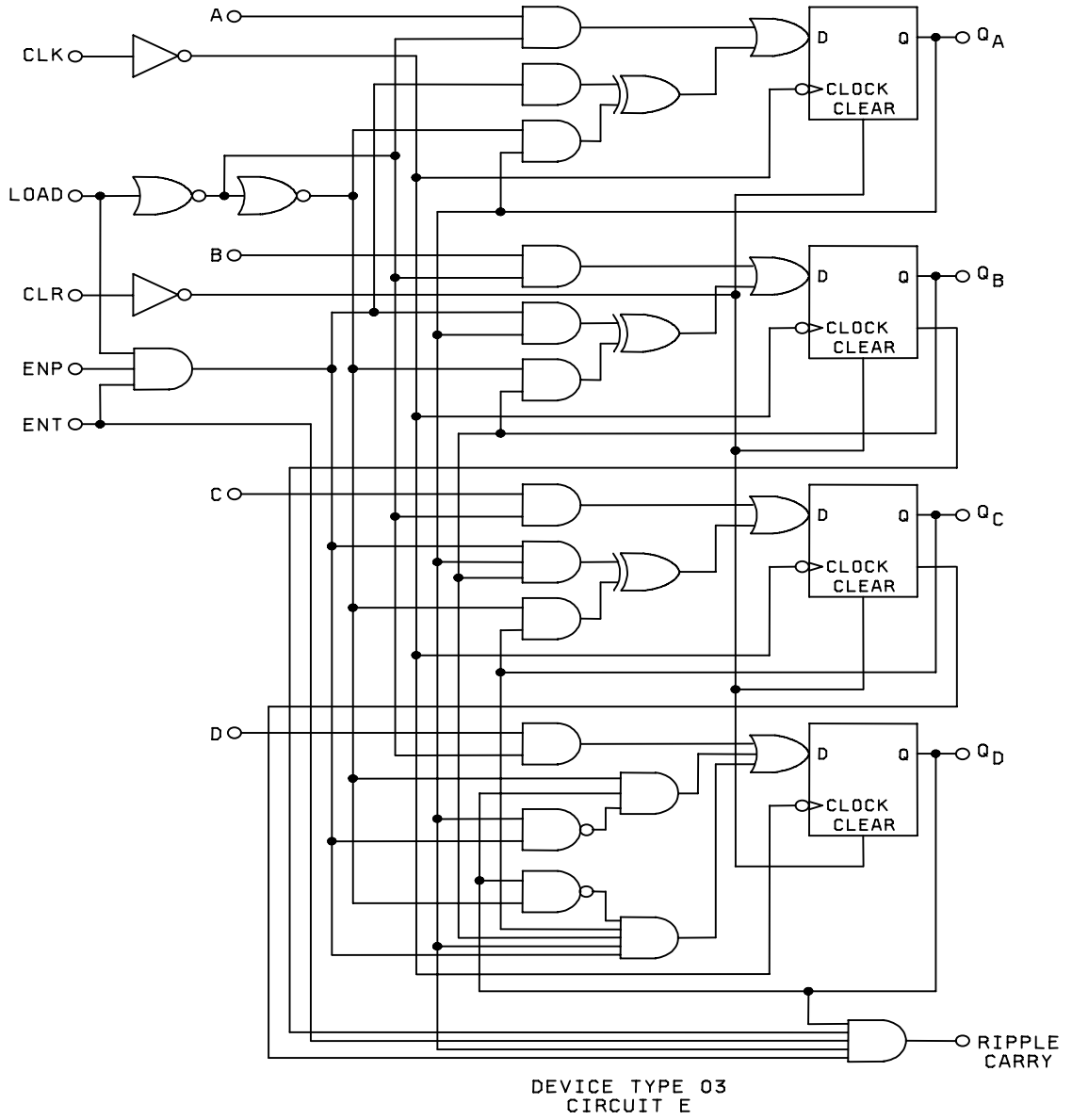


FIGURE 2. Logic diagrams – Continued.

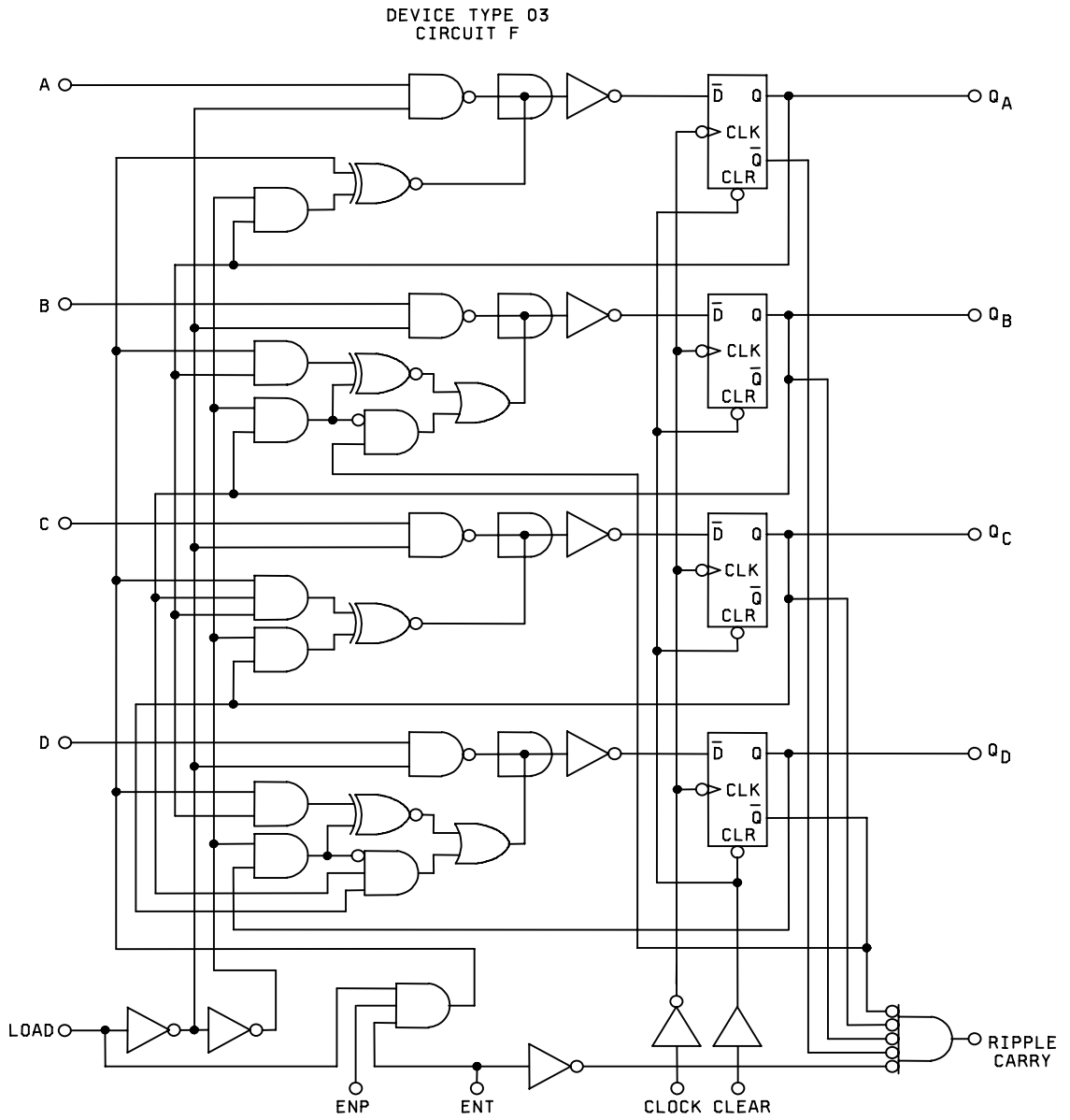


FIGURE 2. Logic diagrams – Continued.

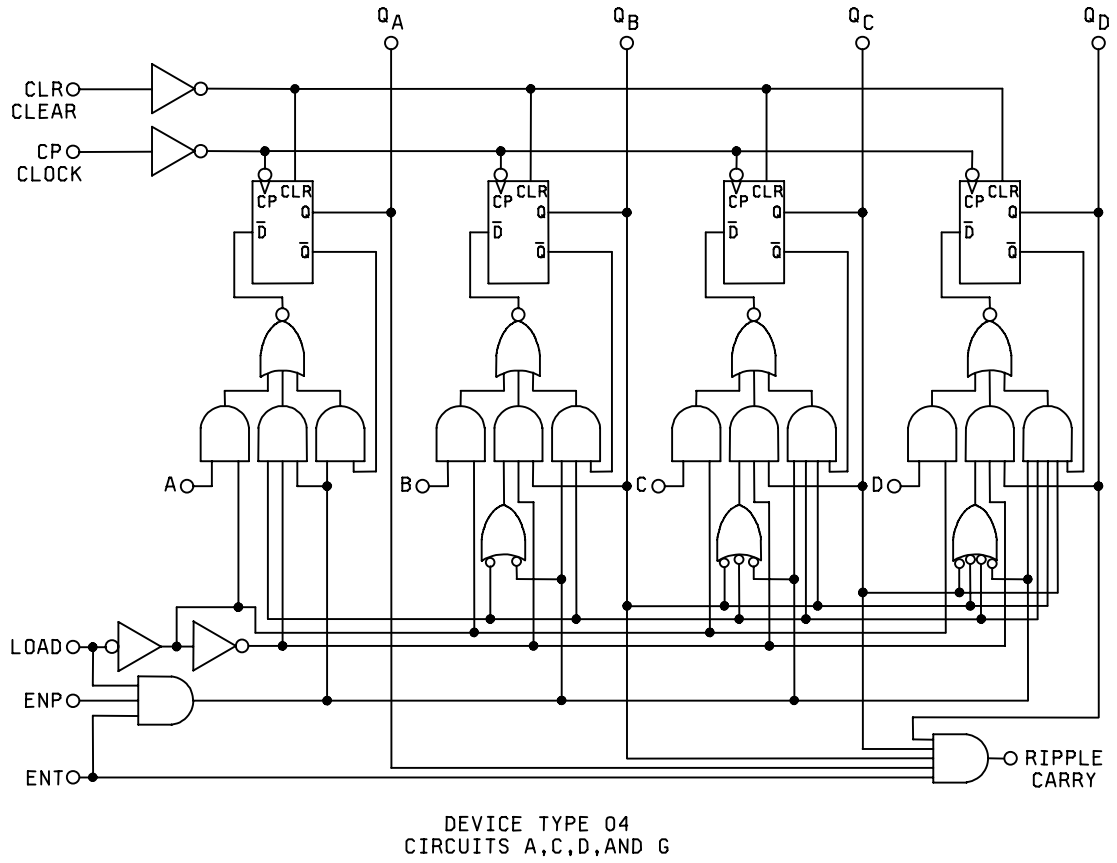


FIGURE 2. Logic diagrams – Continued.

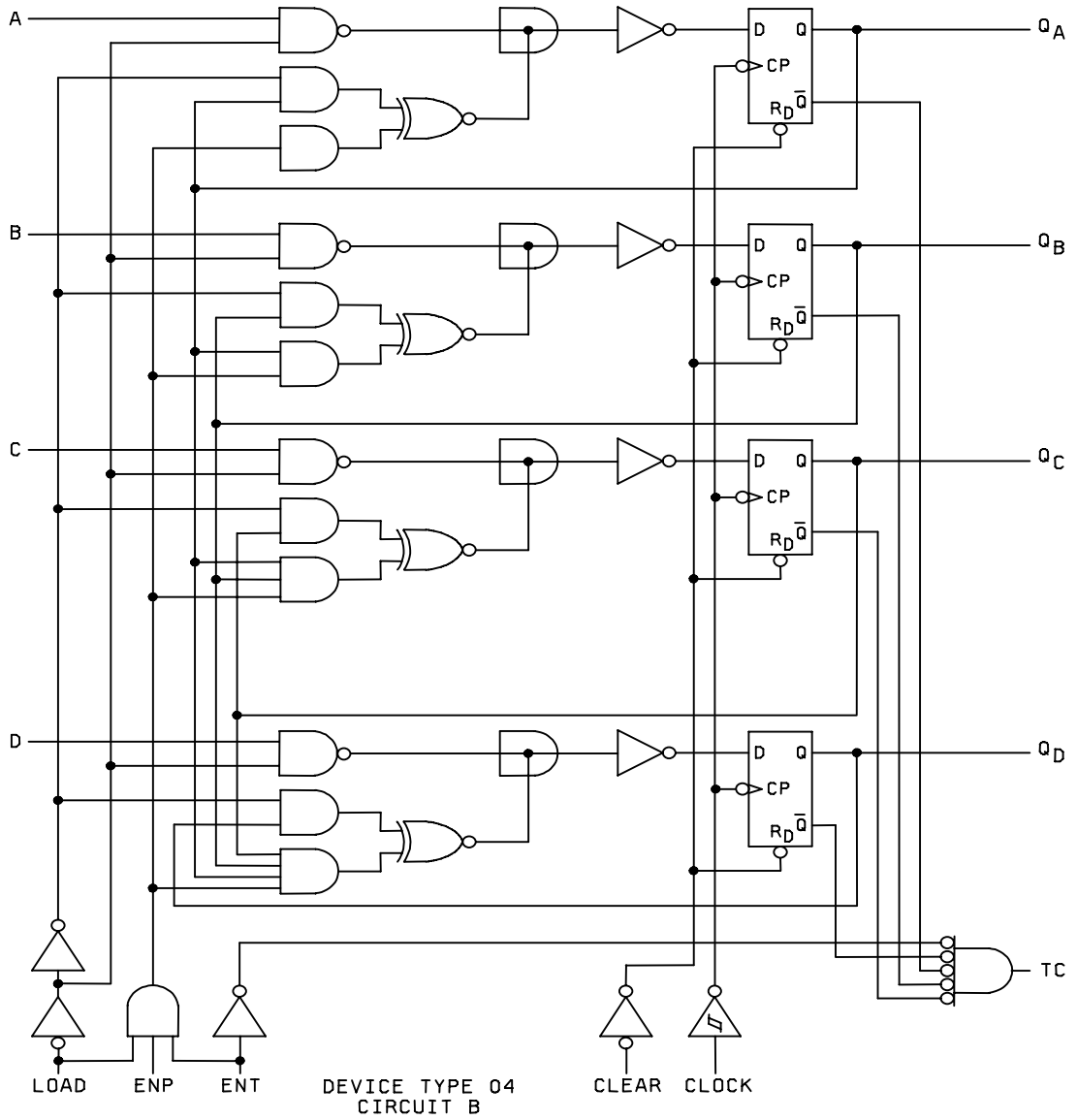


FIGURE 2. Logic diagrams – Continued.

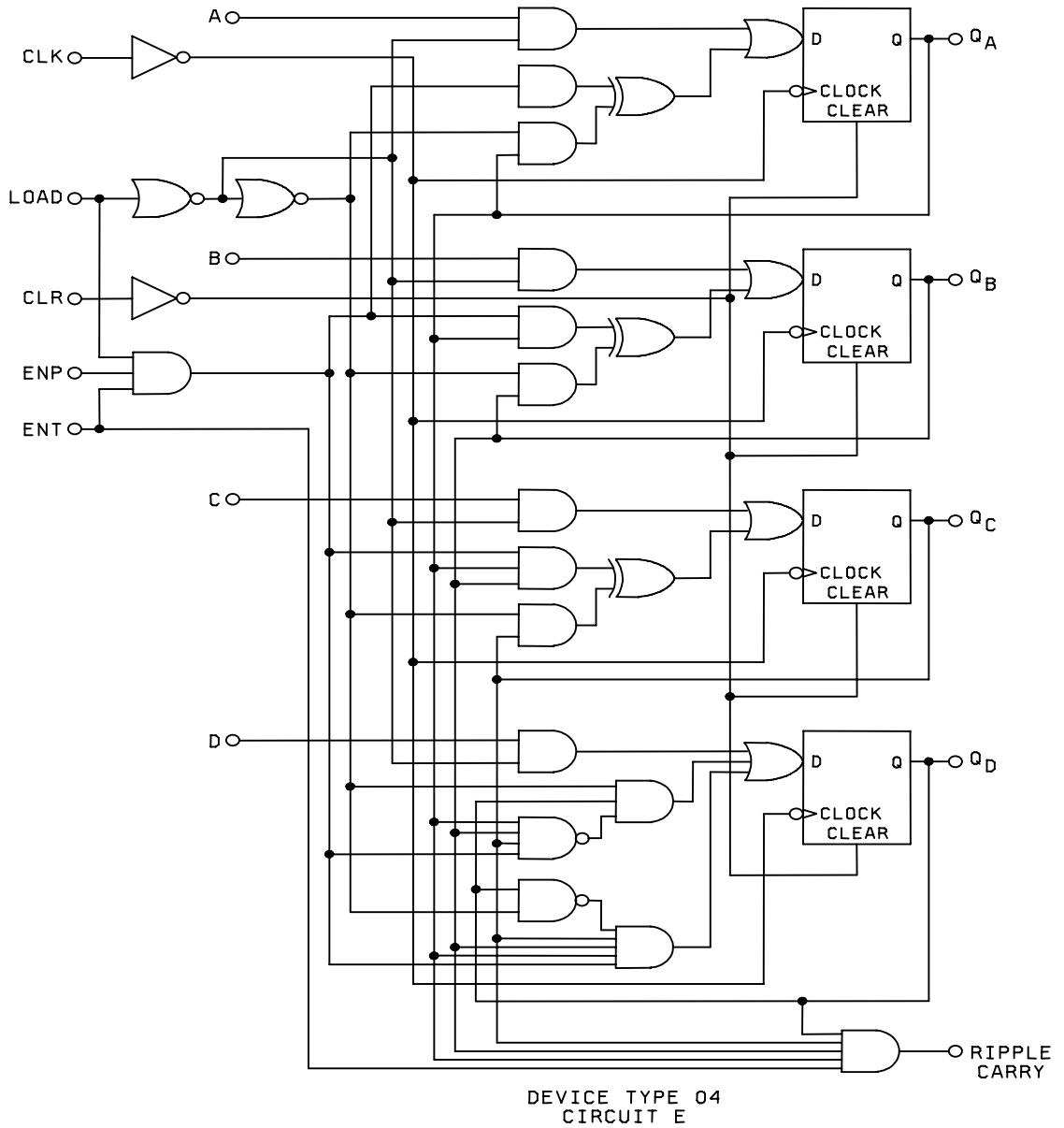


FIGURE 2. Logic diagrams – Continued.

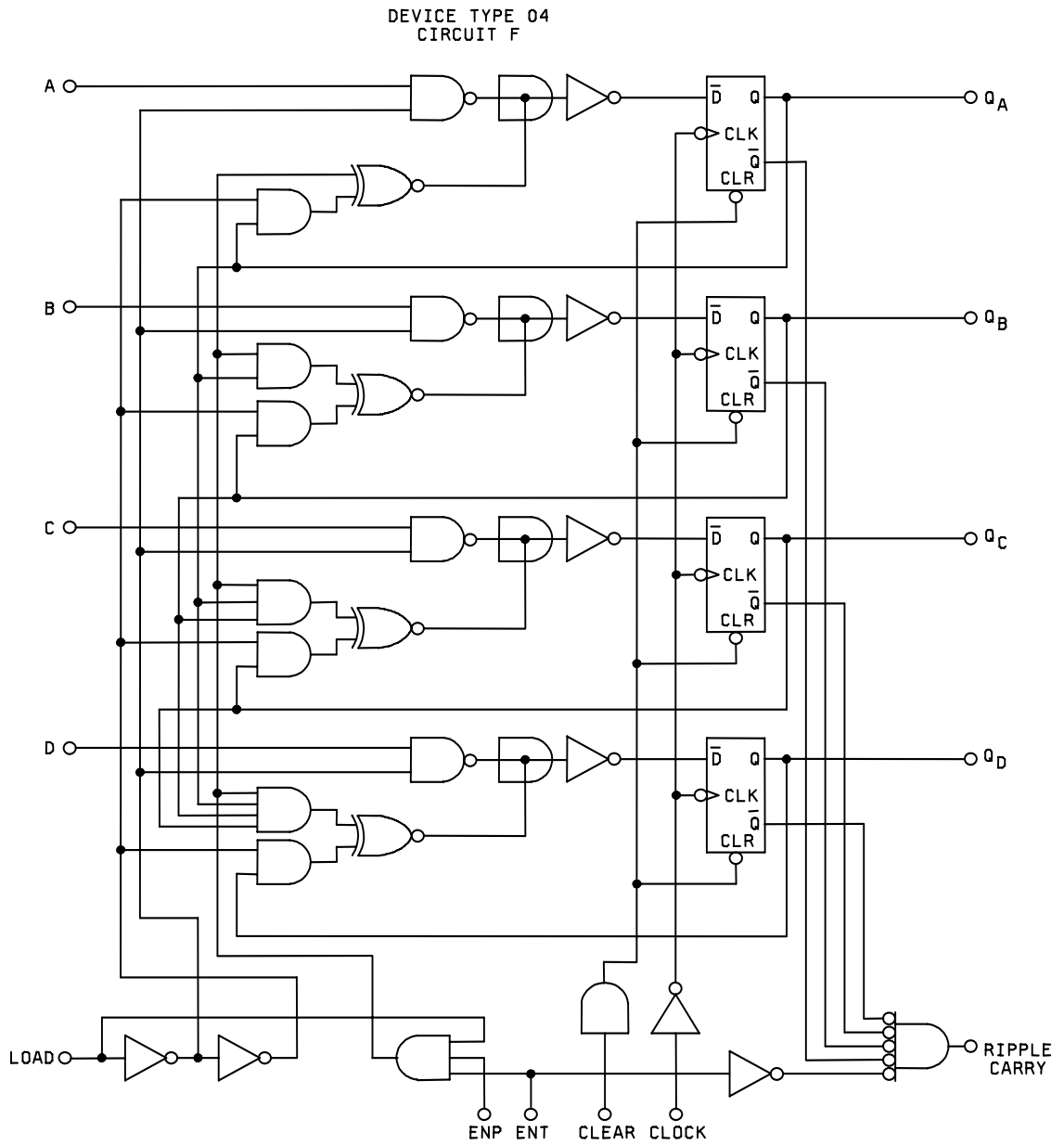


FIGURE 2. Logic diagrams – Continued.

DEVICE TYPE 05
CIRCUIT E

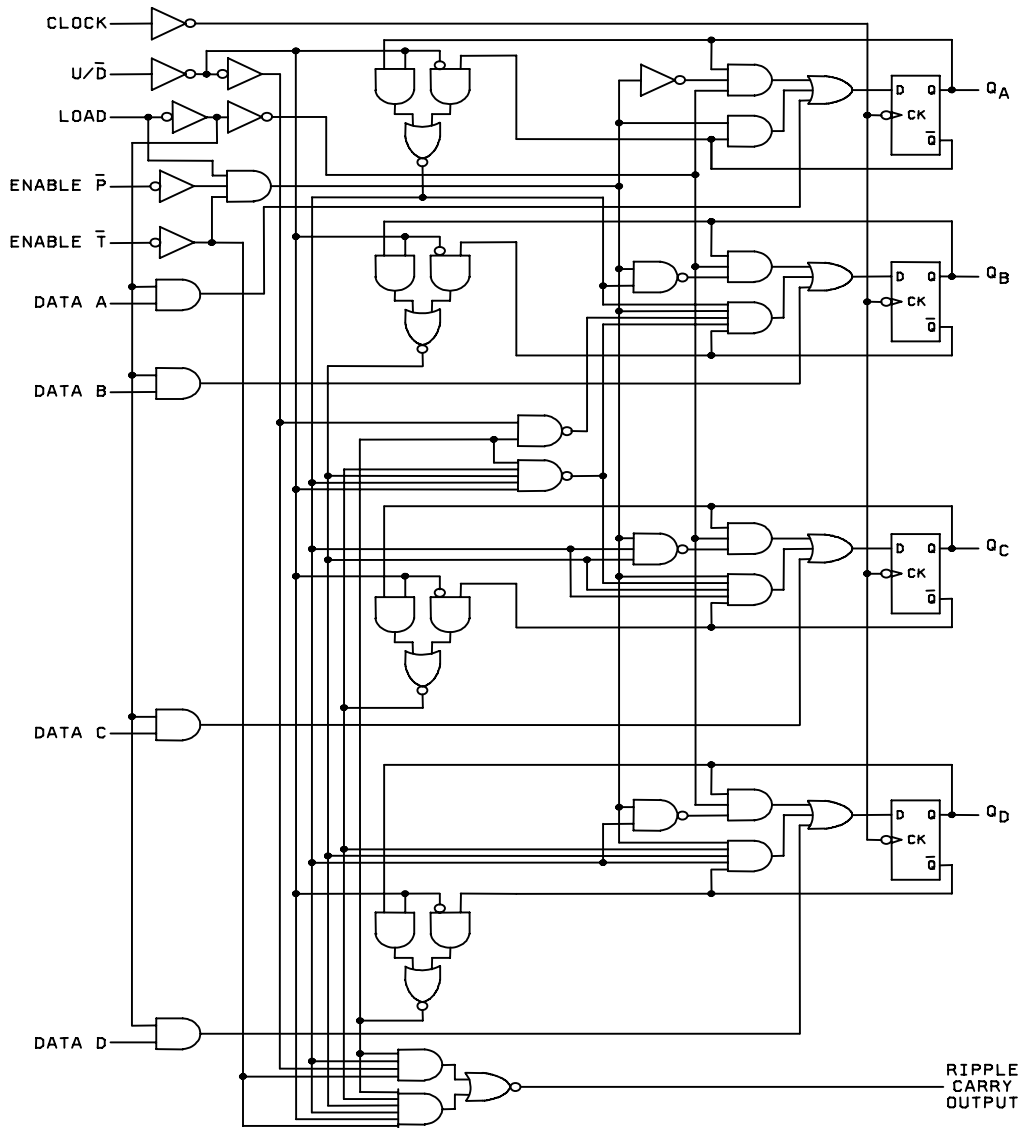


FIGURE 2. Logic diagrams – Continued.

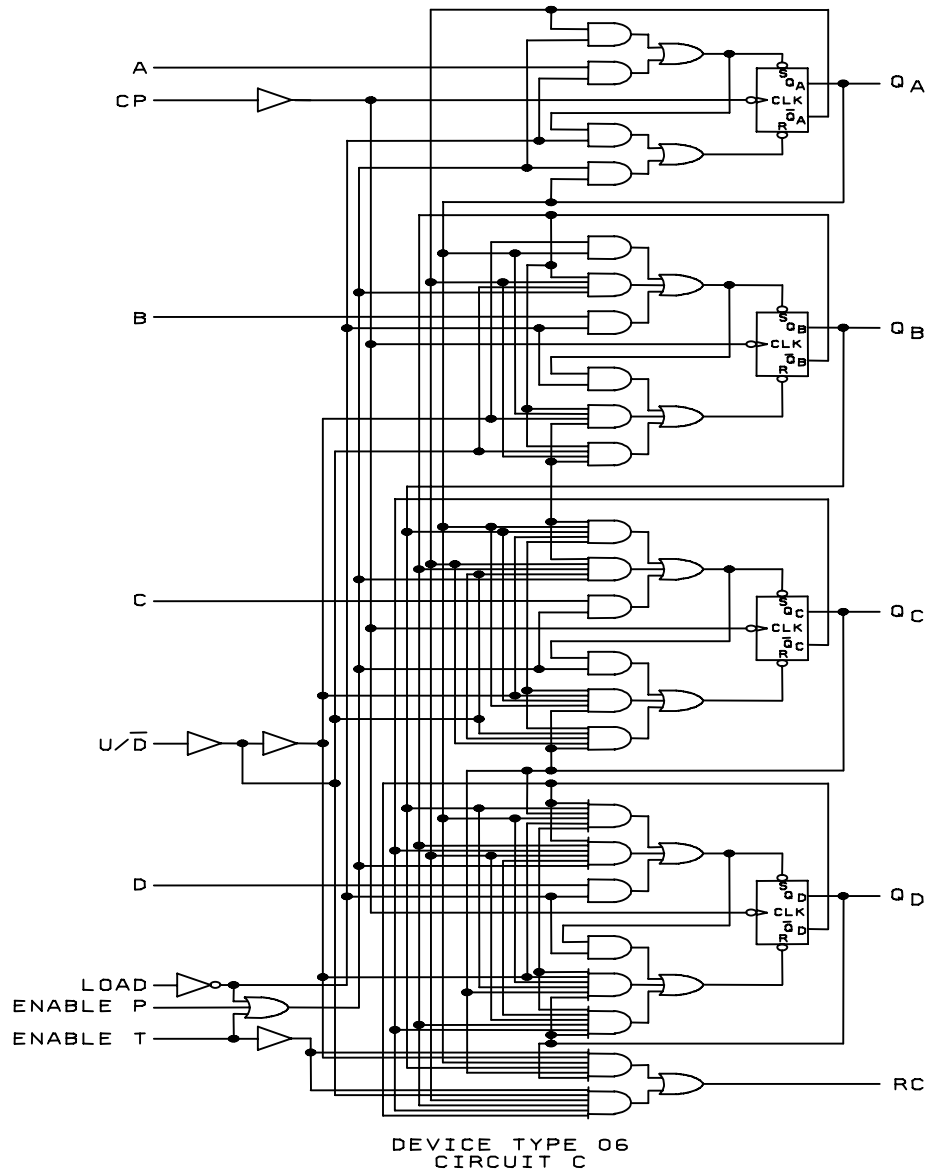


FIGURE 2. Logic diagrams – Continued.

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DEVICE TYPE 06
CIRCUIT E

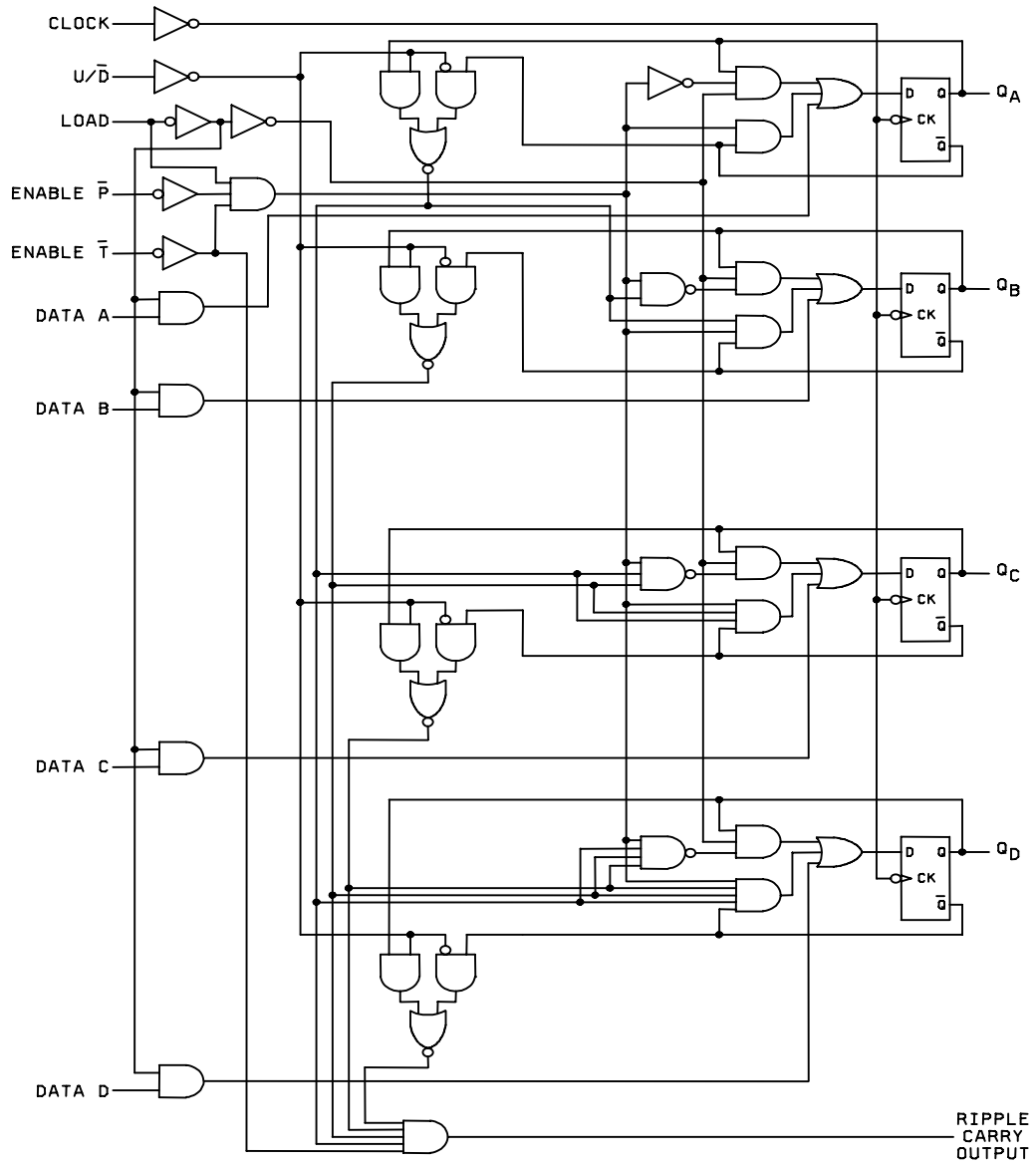


FIGURE 2. Logic diagrams – Continued.

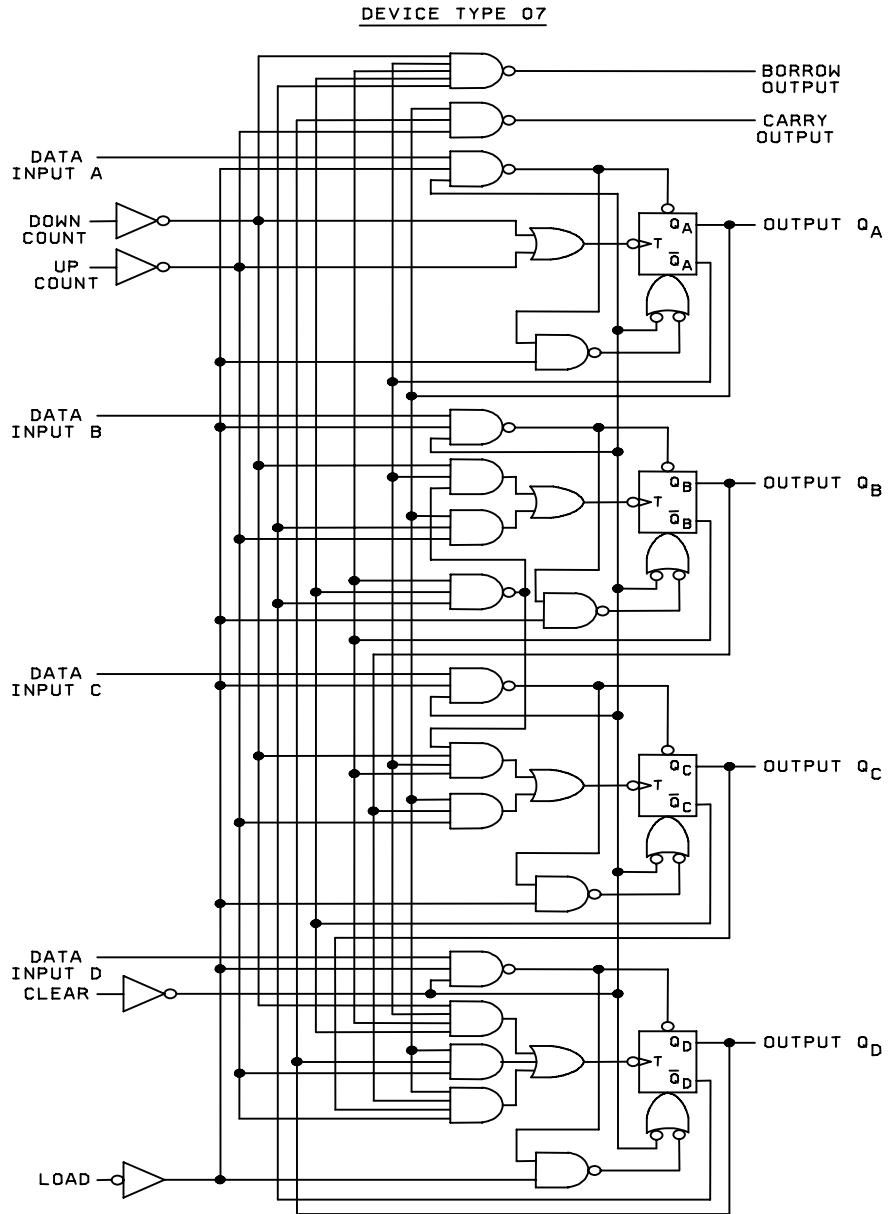


FIGURE 2. Logic diagrams – Continued.

DEVICE TYPE 08

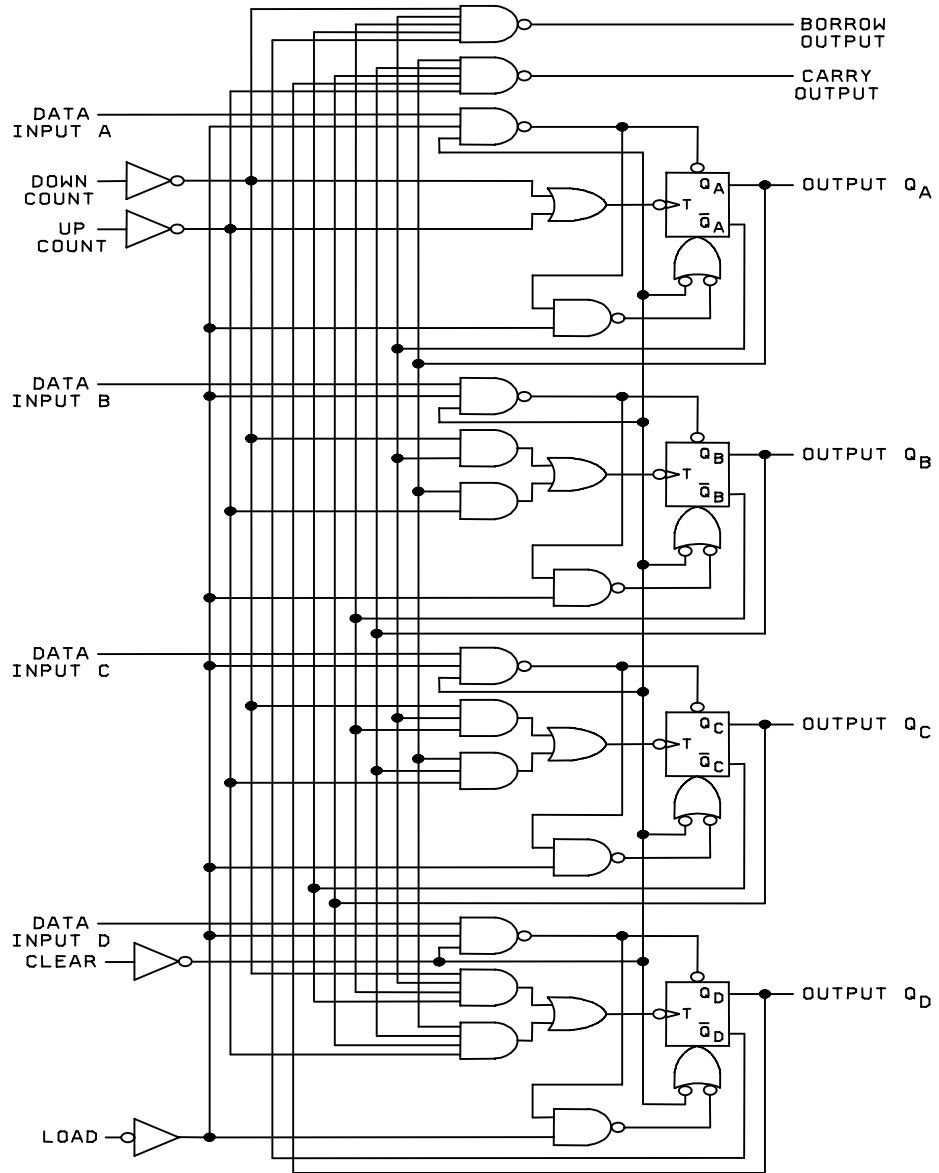


FIGURE 2. Logic diagrams – Continued.

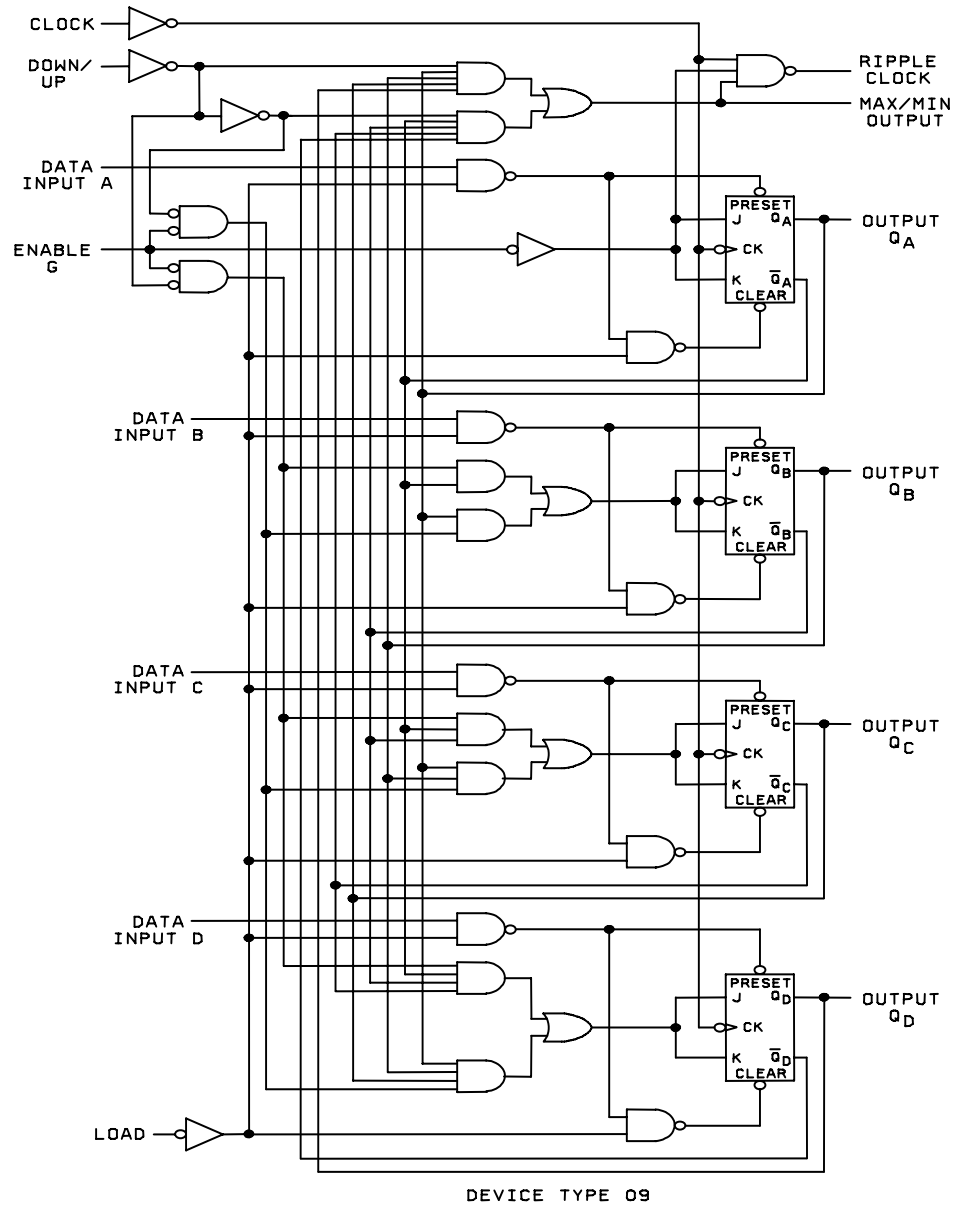
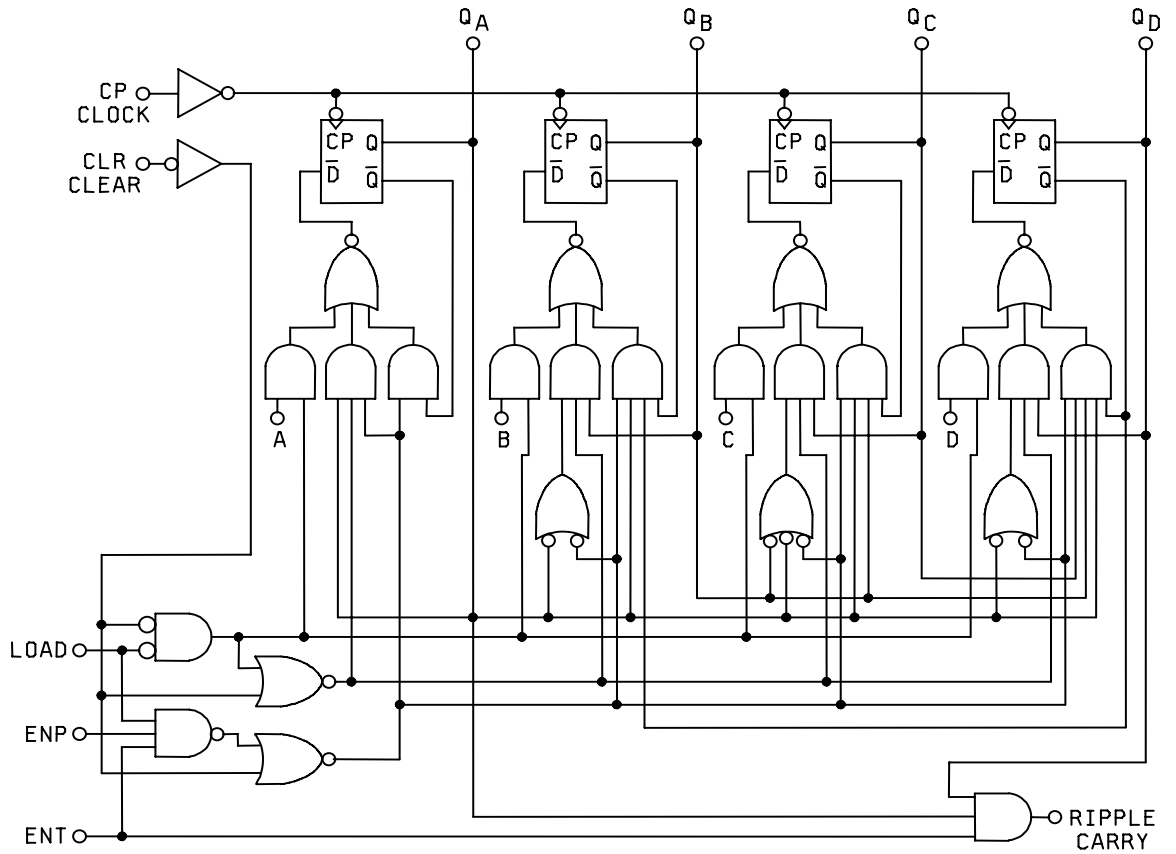


FIGURE 2. Logic diagrams – Continued.



DEVICE TYPE 11
CIRCUITS A,C,D, AND G

FIGURE 2. Logic diagrams – Continued.

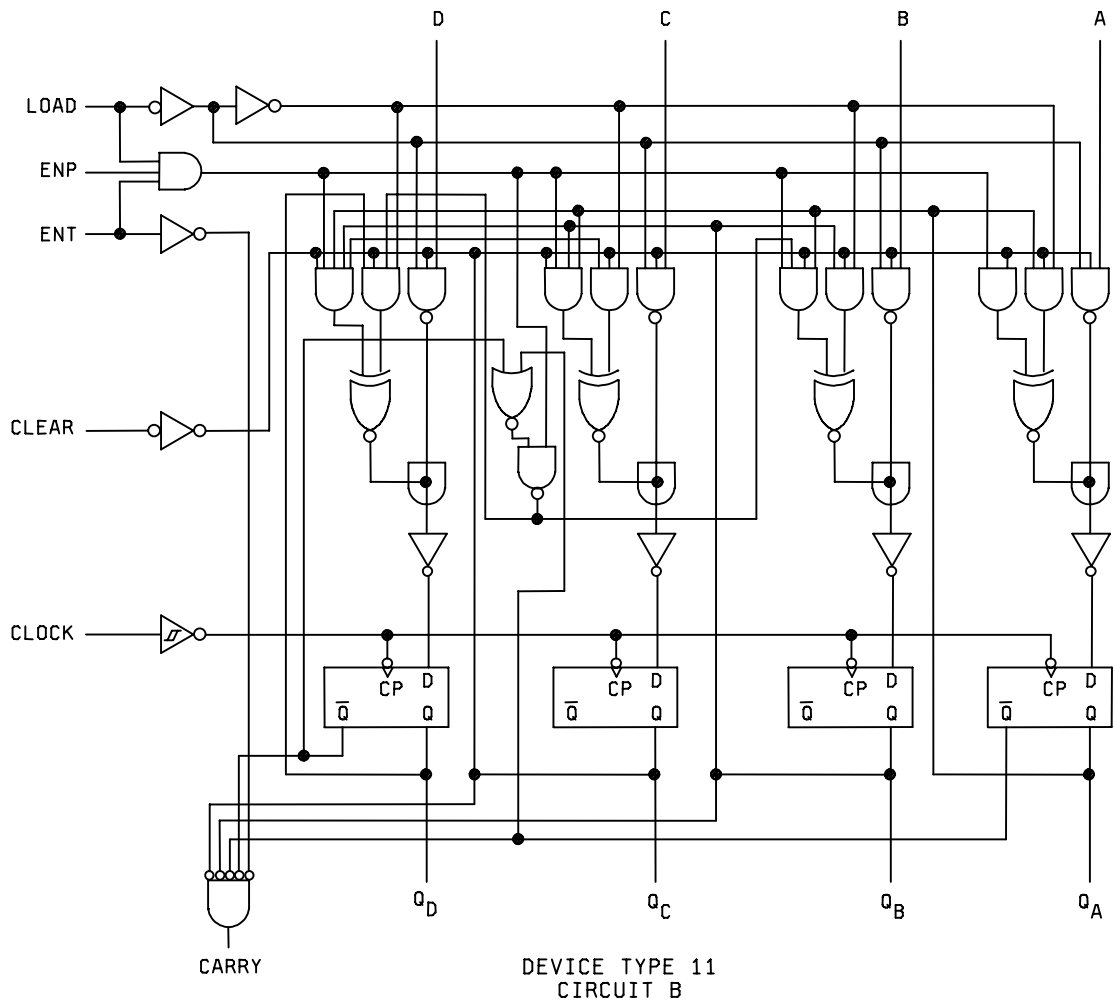


FIGURE 2. Logic diagrams – Continued.

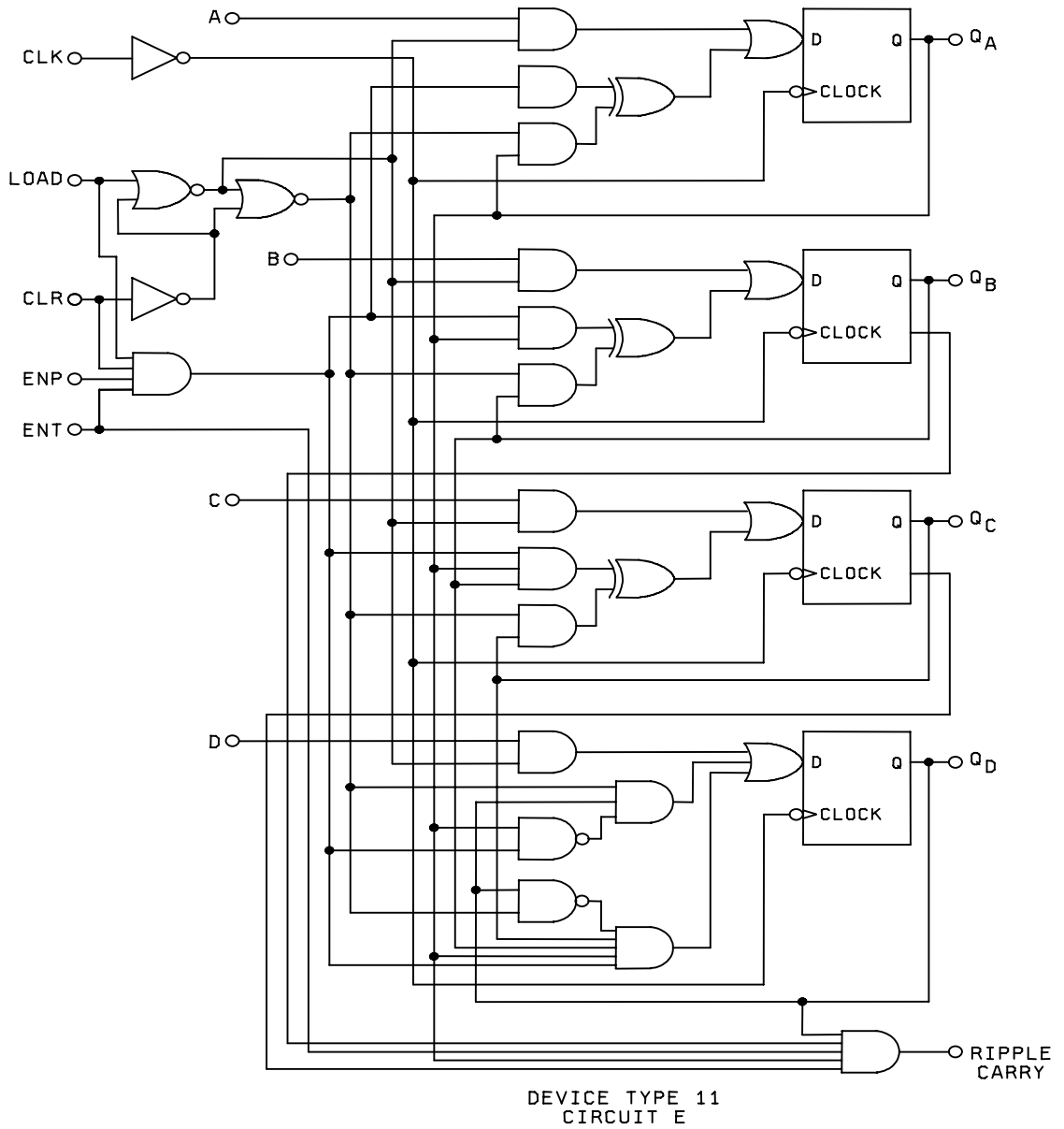


FIGURE 2. Logic diagrams – Continued.

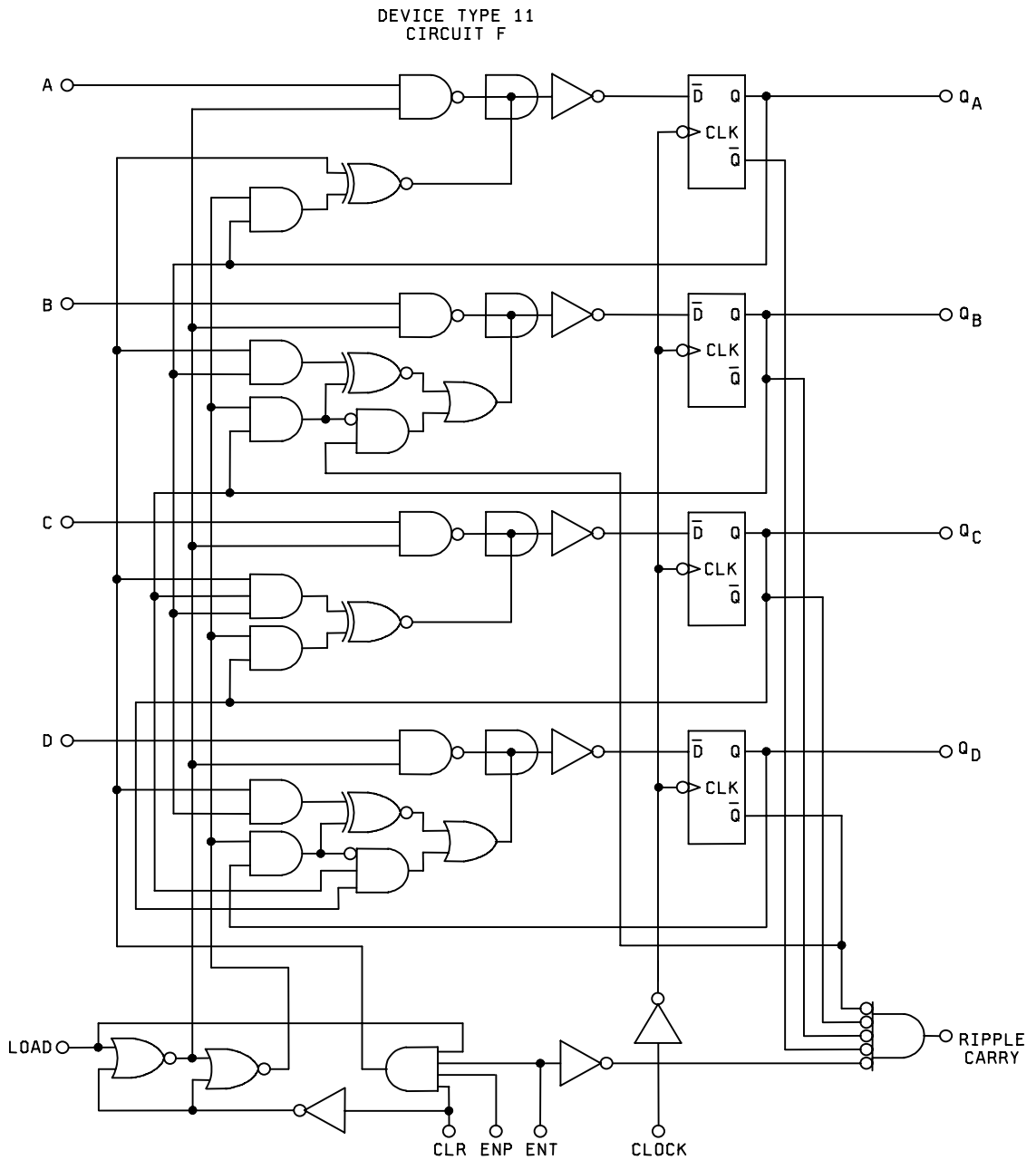
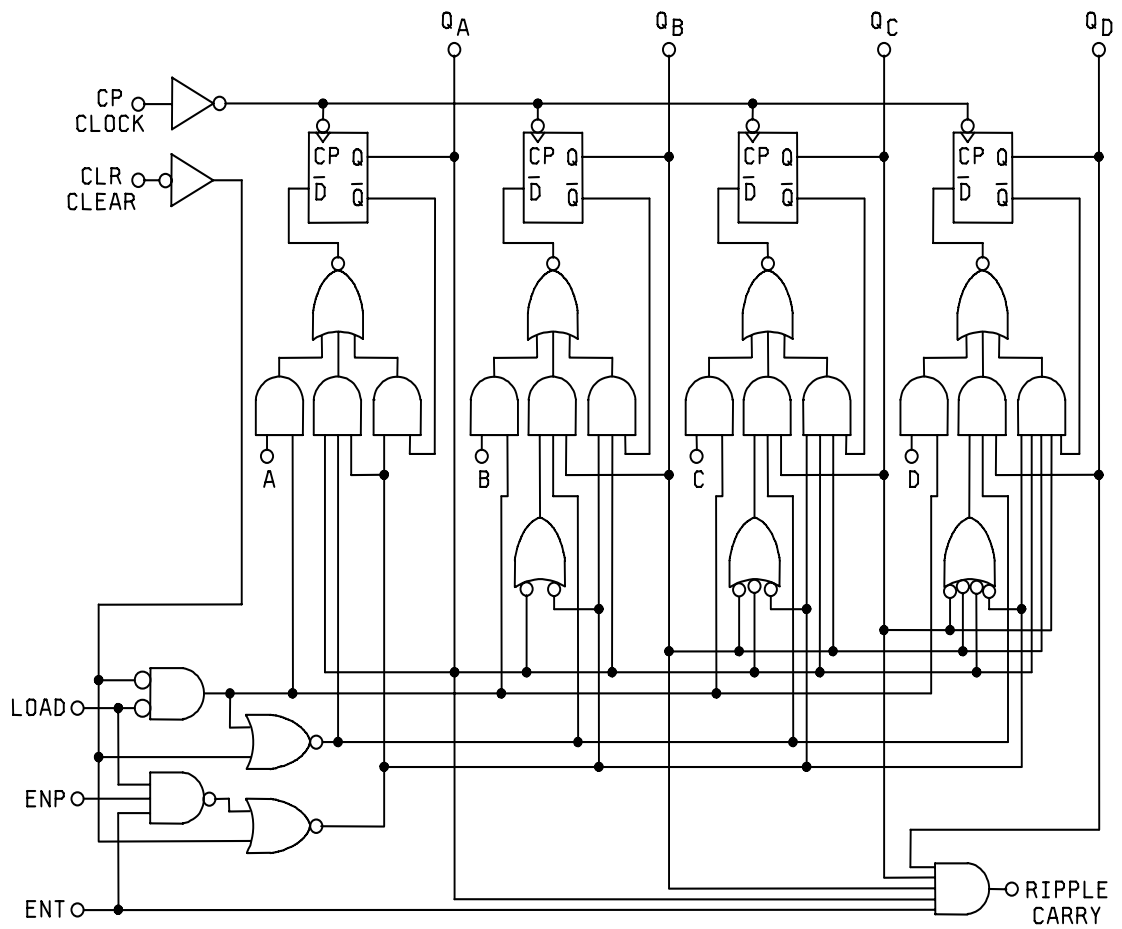


FIGURE 2. Logic diagrams – Continued.



DEVICE TYPE 12
CIRCUITS A,C,D, AND G

FIGURE 2. Logic diagrams – Continued.

DEVICE TYPE 12
CIRCUIT B

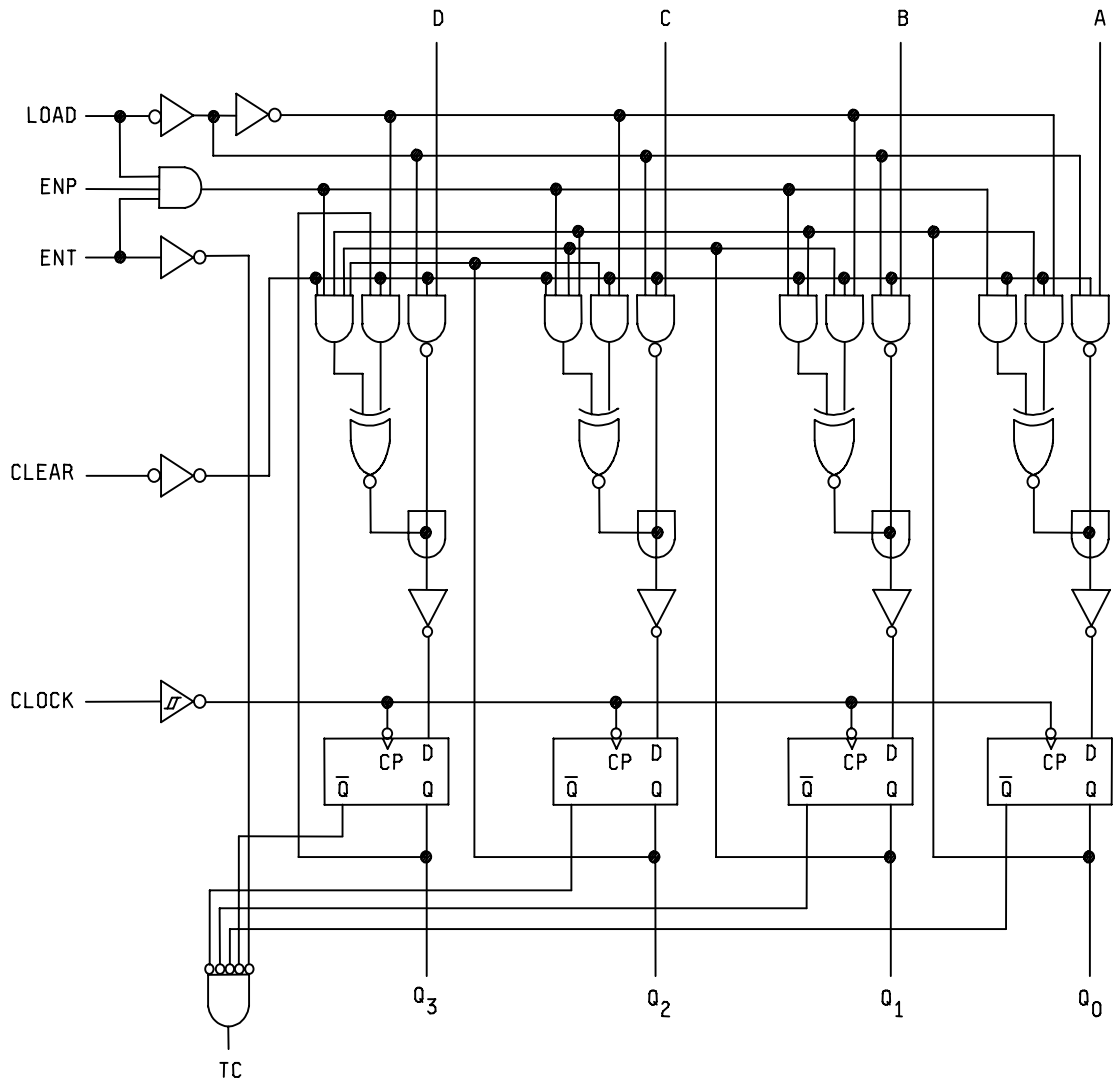


FIGURE 2. Logic diagrams – Continued.

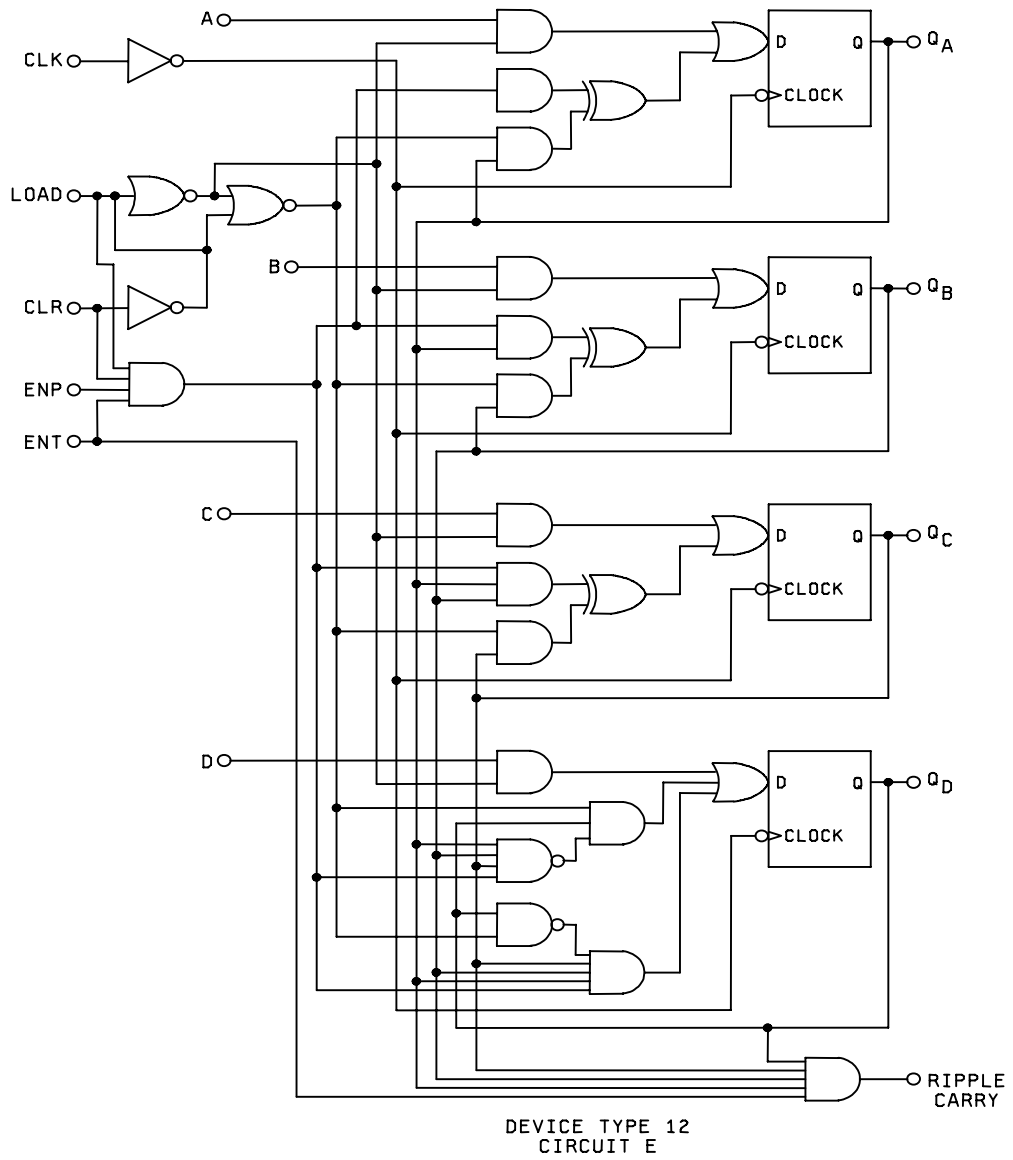


FIGURE 2. Logic diagrams – Continued.

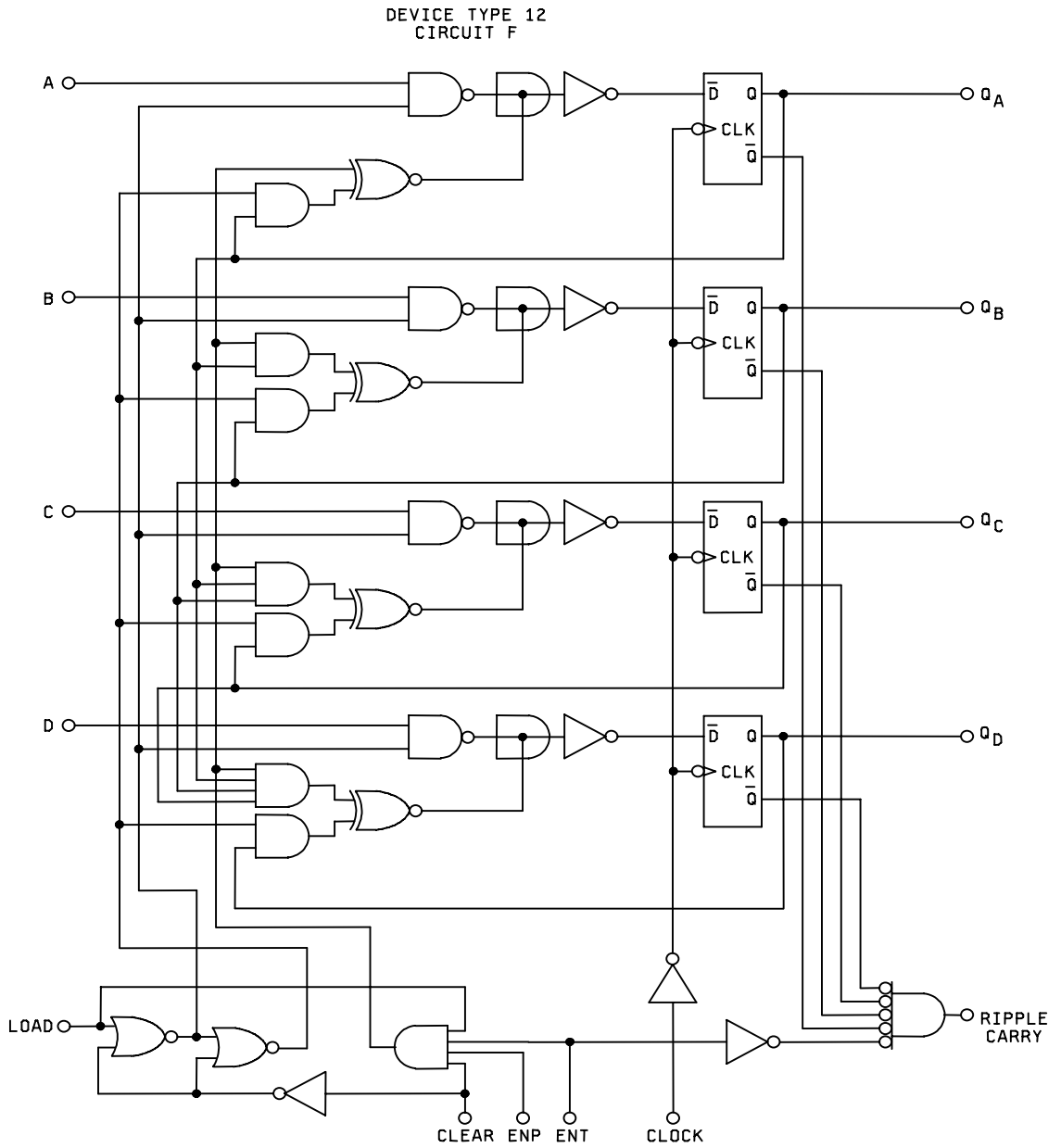


FIGURE 2. Logic diagrams – Continued.

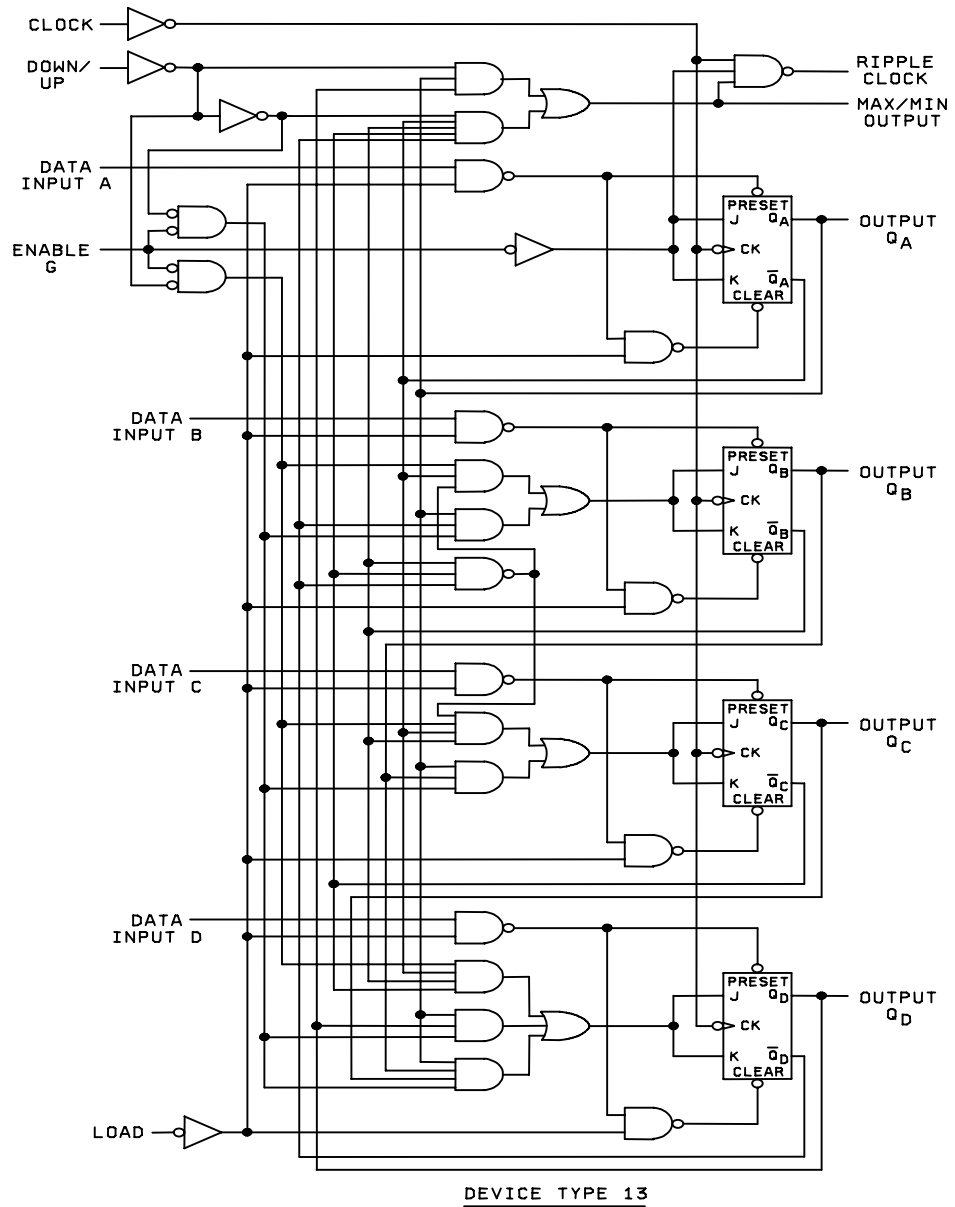


FIGURE 2. Logic diagrams – Continued.

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DEVICE TYPE 01

BCD COUNT SEQUENCE
(See Note A)

COUNT	OUTPUT			
	Q _D	Q _C	Q _B	Q _A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	L	H	H	L
7	L	H	H	H
8	H	L	L	L
9	H	L	L	H

BI-QUINARY (5-2)
(See Note B)

COUNT	OUTPUT			
	Q _A	Q _D	Q _C	Q _B
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	H	L	L	L
6	H	L	L	H
7	H	L	H	L
8	H	L	H	H
9	H	H	L	L

RESET/COUNT FUNCTION TABLE

RESET INPUTS				OUTPUT			
R ₀₍₁₎	R ₀₍₂₎	R ₉₍₁₎	R ₉₍₂₎	Q _D	Q _C	Q _B	Q _A
H	H	L	X	L	L	L	L
H	H	X	L	L	L	L	L
X	X	H	H	H	L	L	H
X	L	X	L	COUNT			
L	X	L	X	COUNT			
L	X	X	L	COUNT			
X	L	L	X	COUNT			

NOTES: A. Output Q_A is connected to input B for BCD count.
B. Output Q_D is connected to input A for bi-quinary count.

FIGURE 3. Truth tables.

DEVICE TYE 02

COUNT SEQUENCE
(See Note)

COUNT	OUTPUT			
	Q _D	Q _C	Q _B	Q _A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	L	H	H	L
7	L	H	H	H
8	H	L	L	L
9	H	L	L	H
10	H	L	H	L
11	H	L	H	H
12	H	H	L	L
13	H	H	L	H
14	H	H	H	L
15	H	H	H	H

DEVICE TYPE 10

COUNT SEQUENCE
(See Note)

COUNT	OUTPUT			
	Q _D	Q _C	Q _B	Q _A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	H	L	L	L
7	H	L	L	H
8	H	L	H	L
9	H	L	H	H
10	H	H	L	L
11	H	H	L	H

RESET/COUNT FUNCTION TABLE

RESET INPUTS		OUTPUT			
R ₀₍₁₎	R ₀₍₂₎	Q _D	Q _C	Q _B	Q _A
H	H	L	L	L	L
L	X	COUNT			
X	L	COUNT			

NOTE: Output Q_A is connected to input B.

RESET/COUNT FUNCTION TABLE

RESET INPUTS		OUTPUT			
R ₀₍₁₎	R ₀₍₂₎	Q _D	Q _C	Q _B	Q _A
H	H	L	L	L	L
L	X	COUNT			
X	L	COUNT			

NOTE: Output Q_A is connected to input B.

FIGURE 3. Truth tables.

SYNCHRONOUS TRUTH TABLE, DEVICE TYPES 3 AND 11

Input at time t_n									Outputs at time t_{n+1}				
Clock	Enable P	Enable T	Load	A	B	C	D	Clear	Q_A	Q_B	Q_C	Q_D	Carry output
CP	L	X	H	X	X	X	X	H	NC	NC	NC	NC	NC
CP	X	L	H	X	X	X	X	H	NC	NC	NC	NC	L
CP	H	H	H	X	X	X	X	H	Previous count plus 1 (note 1)				H if count = 9 L if count < 9
CP	X	H	L	X	X	X	X	H	A	B	C	D	H if count = 9 L if count < 9
CP	X	L	L	X	X	X	X	H	A	B	C	D	L
CP	X	X	X	X	X	X	X	L	L	L	L	L	L

ASYNCHRONOUS TRUTH TABLE, DEVICE TYPE 3

Inputs at time t_n									Outputs at time t_{n+1}				
Clock	Enable P	Enable T	Load	A	B	C	D	Clear	Q_A	Q_B	Q_C	Q_D	Carry output
X	X	X	X	X	X	X	X	L	L	L	L	L	L

NOTES:

1. See up count sequence table.
2. L = V_{IL} for inputs, V_{OL} for outputs.
3. H = V_{IH} for inputs, V_{OH} for outputs.
4. X = V_{IH} or V_{IL} .
5. CP = Clock pulse.
6. NC = No change.

UP COUNT SEQUENCE TABLE

Q_A (LSB)	Q_B	Q_C	Q_D (MSB)
L	L	L	L
H	L	L	L
L	H	L	L
H	H	L	L
L	L	H	L
H	L	H	L
L	H	H	L
H	H	H	L
L	L	L	H
H	L	L	H

FIGURE 3. Truth tables – Continued.

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SYNCHRONOUS TRUTH TABLE, DEVICE TYPES 4 AND 12

Input at time t_n									Outputs at time t_{n+1}				
Clock	Enable P	Enable T	Load	A	B	C	D	Clear	Q _A	Q _B	Q _C	Q _D	Carry output
CP	L	X	H	X	X	X	X	H	NC	NC	NC	NC	NC
CP	X	L	H	X	X	X	X	H	NC	NC	NC	NC	L
CP	H	H	H	X	X	X	X	H	Previous count plus 1 (note 1)				H if count = 15 L if count < 15
CP	X	H	L	X	X	X	X	H	A	B	C	D	H if count = 15 L if count < 15
CP	X	L	L	X	X	X	X	H	A	B	C	D	L
CP	X	X	X	X	X	X	X	L	L	L	L	L	L

ASYNCHRONOUS TRUTH TABLE, DEVICE TYPE 4

Inputs at time t_n									Outputs at time t_{n+1}				
Clock	Enable P	Enable T	Load	A	B	C	D	Clear	Q _A	Q _B	Q _C	Q _D	Carry output
X	X	X	X	X	X	X	X	L	L	L	L	L	L

NOTES:

1. See up count sequence table.
2. L = V_{IL} for inputs, V_{OL} for outputs.
3. H = V_{IH} for inputs, V_{OH} for outputs.
4. X = V_{IH} or V_{IL} .
5. CP = Clock pulse.
6. NC = No change.

UP COUNT SEQUENCE TABLE

Q _A (LSB)	Q _B	Q _C	Q _D (MSB)
L	L	L	L
H	L	L	L
L	H	L	L
H	H	L	L
L	L	H	L
H	L	H	L
L	H	H	L
H	H	H	L
L	L	L	H
H	L	L	H
L	H	L	H
H	H	L	H
L	L	H	H
H	L	H	H
L	H	H	H
H	H	H	H

FIGURE 3. Truth tables – Continued.

Device type 05

UP COUNT SEQUENCE TABLE

Q _A (LSB)	Q _B	Q _C	Q _D (MSB)
L	L	L	L
H	L	L	L
L	H	L	L
H	H	L	L
L	L	H	L
H	L	H	L
L	H	H	L
H	H	H	L
L	L	L	H
H	L	L	H

Device type 06

UP COUNT SEQUENCE TABLE

Q _A (LSB)	Q _B	Q _C	Q _D (MSB)
L	L	L	L
H	L	L	L
L	H	L	L
H	H	L	L
L	L	H	L
H	L	H	L
L	H	H	L
H	H	H	L
L	L	L	H
H	L	L	H
L	H	L	H
H	H	L	H
L	L	H	H
H	L	H	H
L	H	H	H
H	H	H	H

Device types 05 and 06

MODE SELECT TABLE

L	EP	ET	U/D	Action on Rising Clock Edge
L	X	X	X	Load (D _n → Q _n)
H	L	L	H	Count Up (increment)
H	L	L	L	Count Down (decrement)
H	H	X	X	No Change (Hold)
H	X	H	X	No Change (Hold)

H = High voltage level
 L = Low voltage
 X = Don't care

FIGURE 3. Truth tables – Continued.

DEVICE TYPE 7 TRUTH TABLE

Inputs at time t_n								Outputs at time t_{n+1}					
Count Up	Count Down	Load	A	B	C	D	Clear	Q_A	Q_B	Q_C	Q_D	Carry	Borrow
H	H	H	X	X	X	X	L	NC	NC	NC	NC	H	H
H	H	H	X	X	X	X	H	L	L	L	L	H	H
H	H	L	X	X	X	X	L	A	B	C	D	H	H
P	H	H	X	X	X	X	L	Previous count plus 1 (note 1)				H	H
H	P	H	X	X	X	X	L	Previous count minus 1 (note 2)				H	H
N	H	H	X	X	X	X	L	NC	NC	NC	NC	N if count = 9 H if count \neq 9	H
H	N	H	X	X	X	X	L	NC	NC	NC	NC	H	N if count = 0 H if count \neq 0

NOTES:

1. See up count sequence table.
2. See down count sequence table.
3. L = V_{IL} for inputs, V_{OL} for outputs.
4. H = V_{IH} for inputs, V_{OH} for outputs.
5. X = V_{IH} or V_{IL} .
6. NC = No change.
7. NA = Not applicable.
8. P = Positive going pulse.
9. N = Negative going pulse.

FIGURE 3. Truth tables – Continued.

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DEVICE TYPE 07

UP COUNT SEQUENCE TABLE

Q _A (LSB)	Q _B	Q _C	Q _D (MSB)	Carry
L	L	L	L	H
H	L	L	L	H
L	H	L	L	H
H	H	L	L	H
L	L	H	L	H
H	L	H	L	H
L	H	H	L	H
H	H	H	L	H
L	L	L	H	H
H	L	L	H	L

DOWN COUNT SEQUENCE TABLE

Q _A (LSB)	Q _B	Q _C	Q _D (MSB)	Borrow
H	L	L	H	H
L	L	L	H	H
H	H	H	L	H
L	H	H	L	H
H	L	H	L	H
L	L	H	L	H
H	H	L	L	H
L	H	L	L	H
H	L	L	L	H
L	L	L	L	L

DEVICE TYPE 8 TRUTH TABLE

Input at time t _n								Outputs at time t _{n+1}					
Count up	Count down	Load	A	B	C	D	Clear	Q _A	Q _B	Q _C	Q _D	Carry	Borrow
H	H	H	X	X	X	X	L	NC	NC	NC	NC	H	H
H	H	H	X	X	X	X	H	L	L	L	L	H	H
H	H	L	X	X	X	X	L	A	B	C	D	H	H
P	H	H	X	X	X	X	L	Previous count plus 1 (note)				H	H
H	P	H	X	X	X	X	L	Previous count minus 1 (note 2)				H	H
N	H	H	X	X	X	X	L	NC	NC	NC	NC	N if count = 15 H if count ≠ 15	H
H	N	H	X	X	X	X	L	NC	NC	NC	NC	H	N if count = 0 H if count ≠ 0

NOTES:

1. See up count sequence table.
2. See down count sequence table.
3. L = V_{IL} for inputs, V_{OL} for outputs.
4. H = V_{IH} for inputs, V_{OH} for outputs.
5. X = V_{IH} or V_{IL}.
6. NC = No change.
7. NA = Not applicable.
8. P = Positive going pulse.
9. N = Negative going pulse.

FIGURE 3. Truth tables – Continued.

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DEVICE TYPE 08

UP COUNT SEQUENCE TABLE



Q _A (LSB)	Q _B	Q _C	Q _D (MSB)	Carry
L	L	L	L	H
H	L	L	L	H
L	H	L	L	H
H	H	L	L	H
L	L	H	L	H
H	L	H	L	H
L	H	H	L	H
H	H	H	L	H
L	L	L	H	H
H	L	L	H	H
L	H	L	H	H
H	H	L	H	H
L	L	H	H	H
H	L	H	H	H
L	H	H	H	H
H	H	H	H	L

DOWN COUNT SEQUENCE TABLE



Q _A (LSB)	Q _B	Q _C	Q _D (MSB)	Borrow
H	H	H	H	H
L	H	H	H	H
H	L	H	H	H
L	L	H	H	H
H	H	L	H	H
L	H	L	H	H
H	L	L	H	H
L	L	L	H	H
H	H	H	L	H
L	H	H	L	H
H	L	H	L	H
L	L	H	L	H
H	H	L	L	H
L	H	L	L	H
H	L	L	L	H
L	L	L	L	L



DEVICE TYPES 09 AND 13

Mode select table

Inputs				Mode
Load	Enable G	U/D	CLK	
H	L	L		Count up
H	L	H		Count down
L	X	X	X	Preset (Asyn)
H	H	X	X	No change (Hold)

Ripple carry truth table

Inputs		Outputs	
Enable G	CLK	Max/Min	RC output
L		H	
H	X	X	H
X	X	L	H

L = Low voltage level
 H = High voltage level
 X = Don't care
 = Low-to-high clock transition
 = Negative going clock pulse

NOTE: The up count and down count sequence for device type 09 is identical as that for device type 08.

The up count and down count sequence for device type 13 is identical as that for device type 07.

FIGURE 3. Truth tables – Continued.

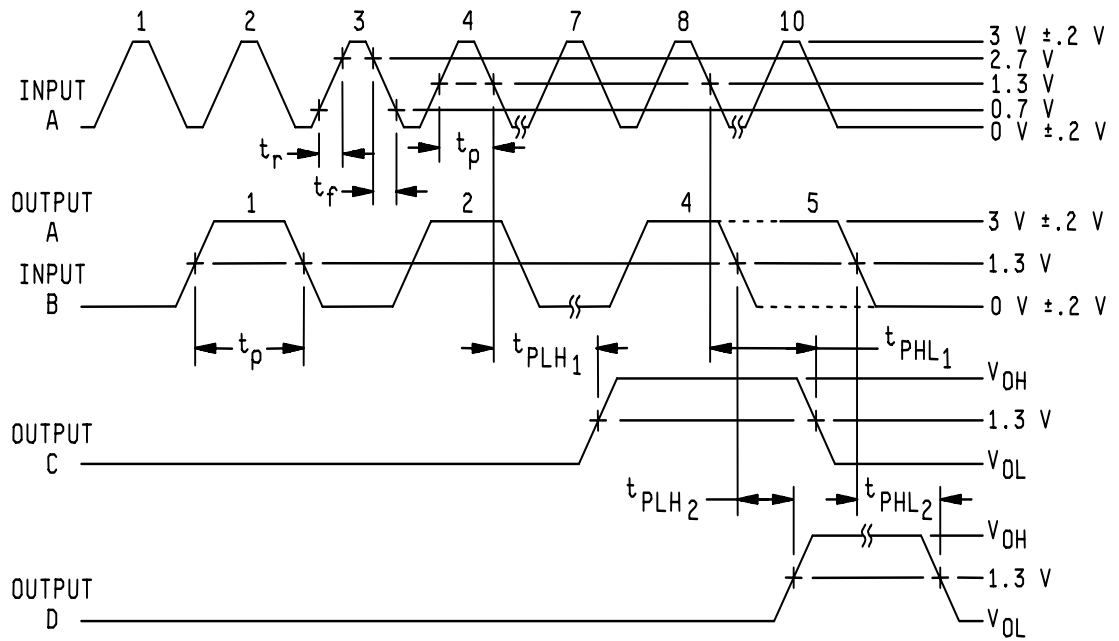
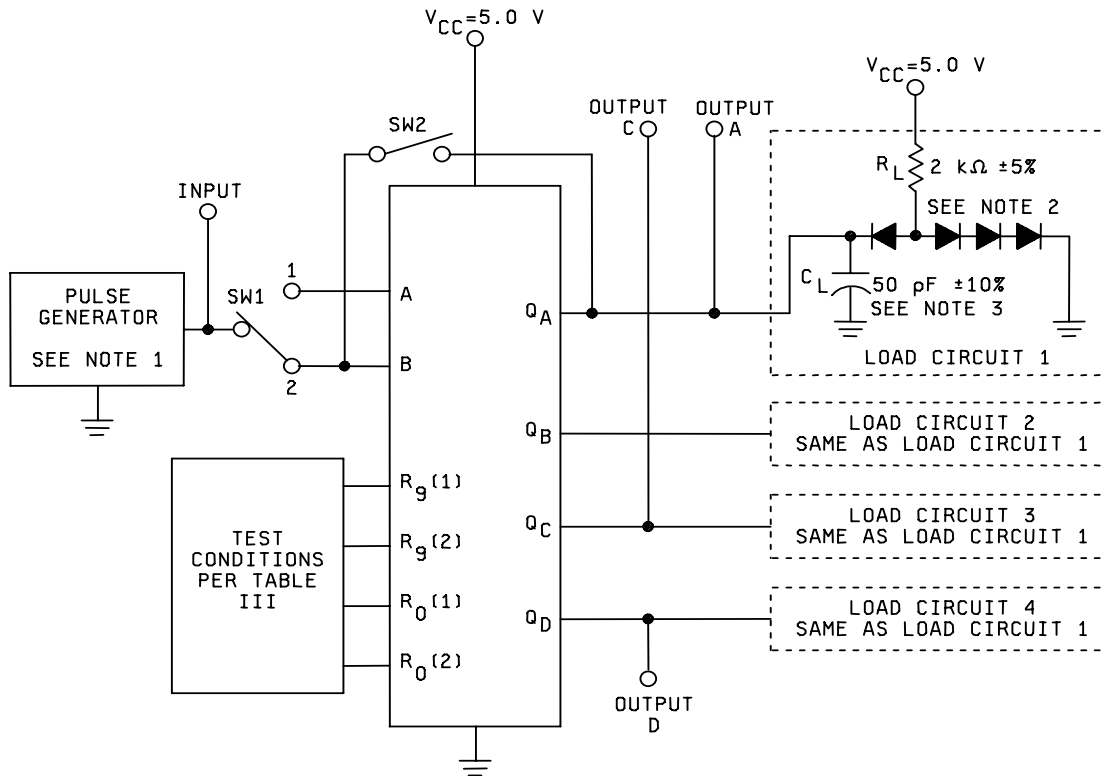


FIGURE 4. Switching time test circuit and waveforms for device type 01.



TEST	SWITCH POSITION	
	SW1	SW2
F MAX	1	CLOSED
A TO Q _C	1	CLOSED
B TO Q _D	2	OPEN

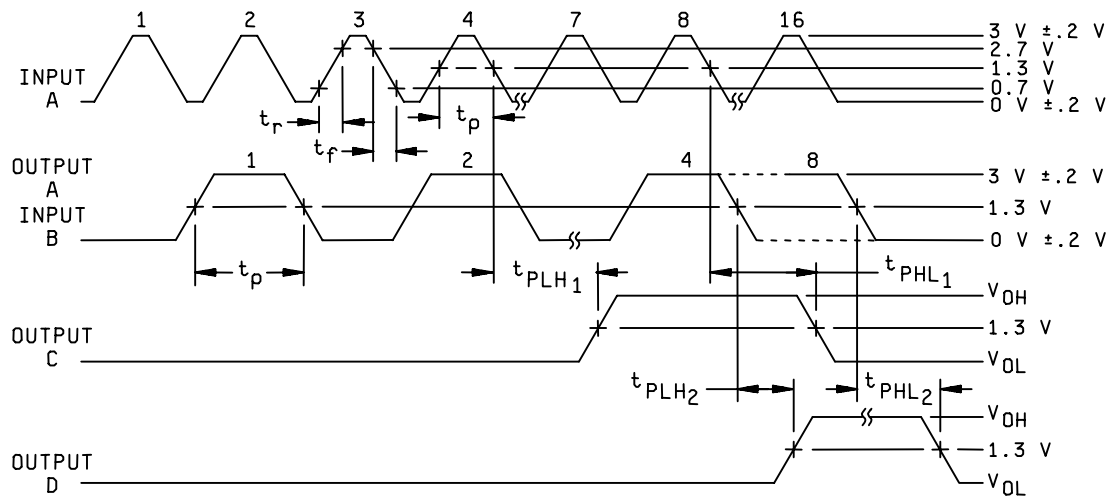
TEST CIRCUIT

NOTES:

1. The pulse generator has the following characteristics: $V_{gen} = 3\text{ V}$, $t_r \leq 15\text{ ns}$, $t_f \leq 6\text{ ns}$, $t_p = .5\text{ }\mu\text{s}$, $PRR \leq 1\text{ MHz}$, $Z_{out} \approx 50\Omega$.
2. All diodes are 1N3064 or equivalent.
3. C_L includes probe and jig capacitance.
4. Voltage values are with respect to ground terminal.
5. F_{MAX} : $t_r = t_f \leq 6\text{ ns}$.

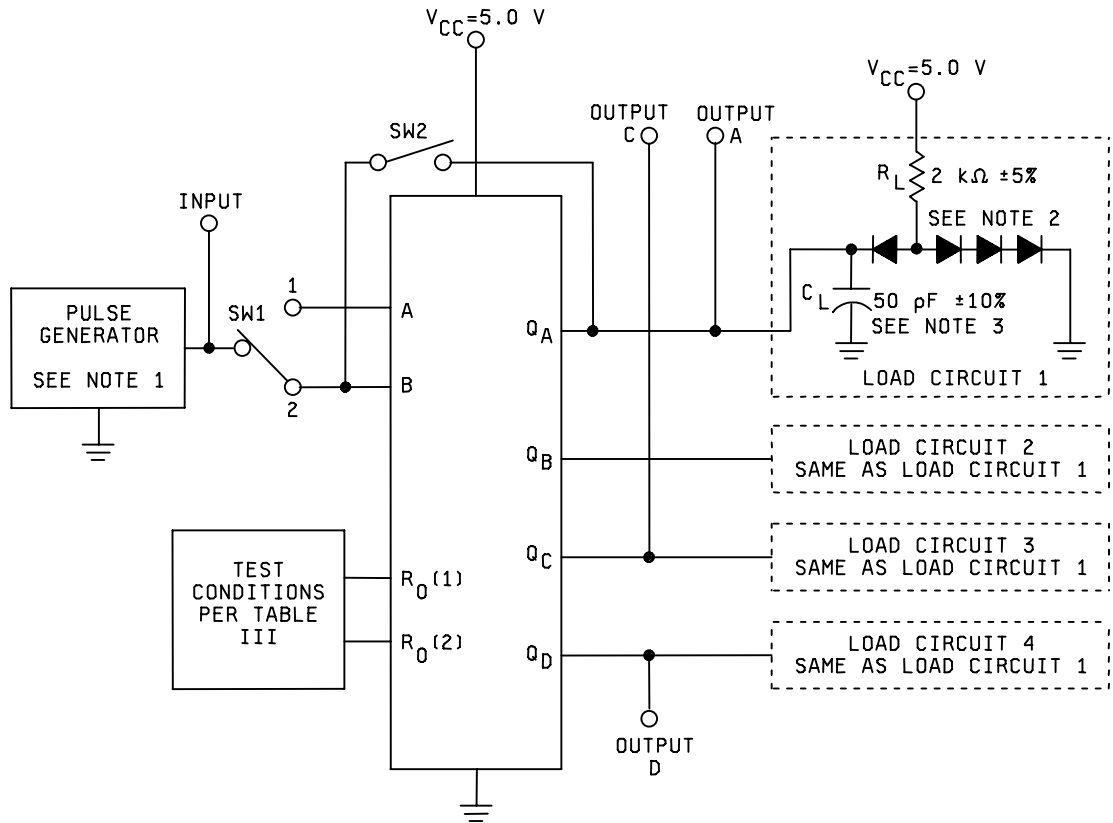
FIGURE 4. Switching time test circuit and waveforms for device type 01 – Continued.

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VOLTAGE WAVEFORMS

FIGURE 5. Switching time test circuit and waveforms for device type 02.



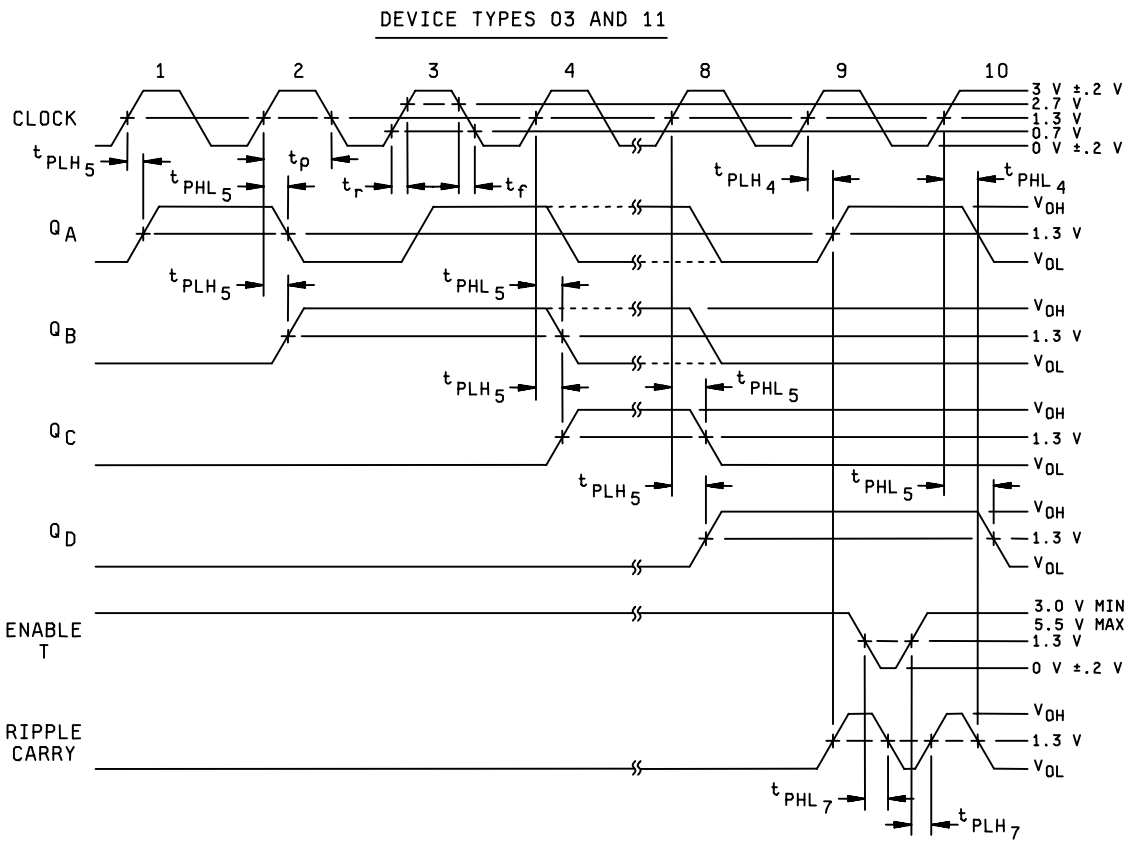
TEST	SWITCH POSITION	
	SW1	SW2
F MAX	1	CLOSED
A TO Q _C	1	CLOSED
B TO Q _D	2	OPEN

TEST CIRCUIT

NOTES:

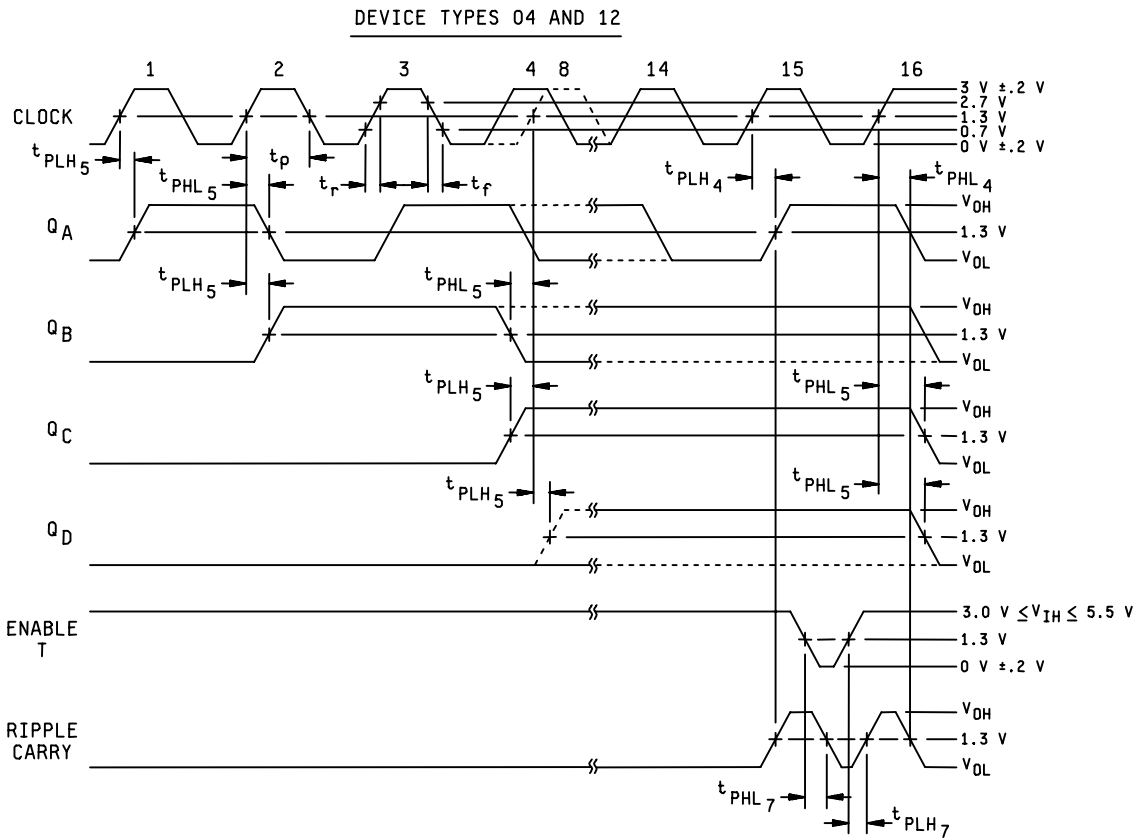
1. The pulse generator has the following characteristics: $V_{gen} = 3\text{ V}$, $t_r \leq 15\text{ ns}$, $t_f \leq 6\text{ ns}$, $t_p = .5\text{ }\mu\text{s}$, $PRR \leq 1\text{ MHz}$, $Z_{out} \approx 50\Omega$.
2. All diodes are 1N3064 or equivalent.
3. C_L includes probe and jig capacitance.
4. Voltage values are with respect to ground terminal.
5. F_{MAX} : $t_r = t_f \leq 6\text{ ns}$.

FIGURE 5. Switching time test circuit and waveforms for device type 02 – Continued.



VOLTAGE WAVEFORMS

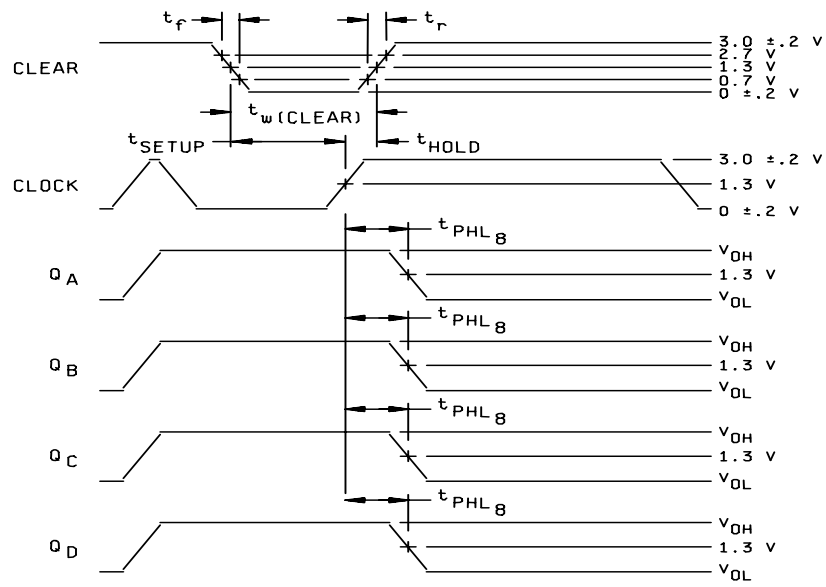
FIGURE 6. Switching time test circuit and waveforms for device types 03, 04, 11, and 12.



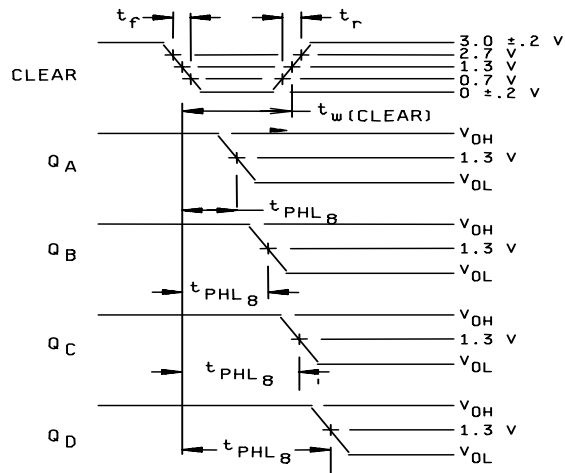
VOLTAGE WAVEFORMS

FIGURE 6. Switching time test circuit and waveforms for device types 03, 04, 11, and 12 – Continued.

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DEVICE TYPES 11 AND 12

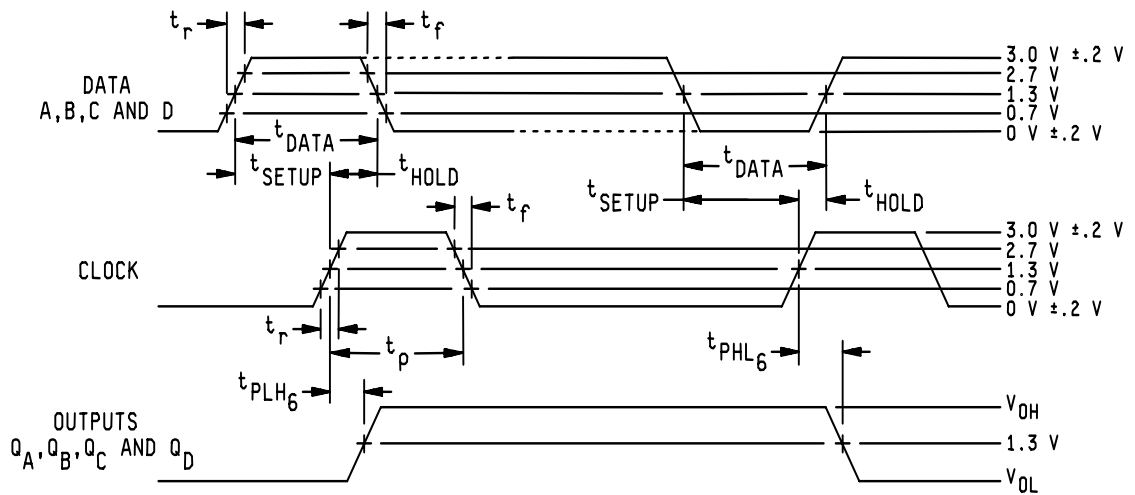


DEVICE TYPES 03 AND 04

NOTE: The clear pulse generator has the following characteristics:

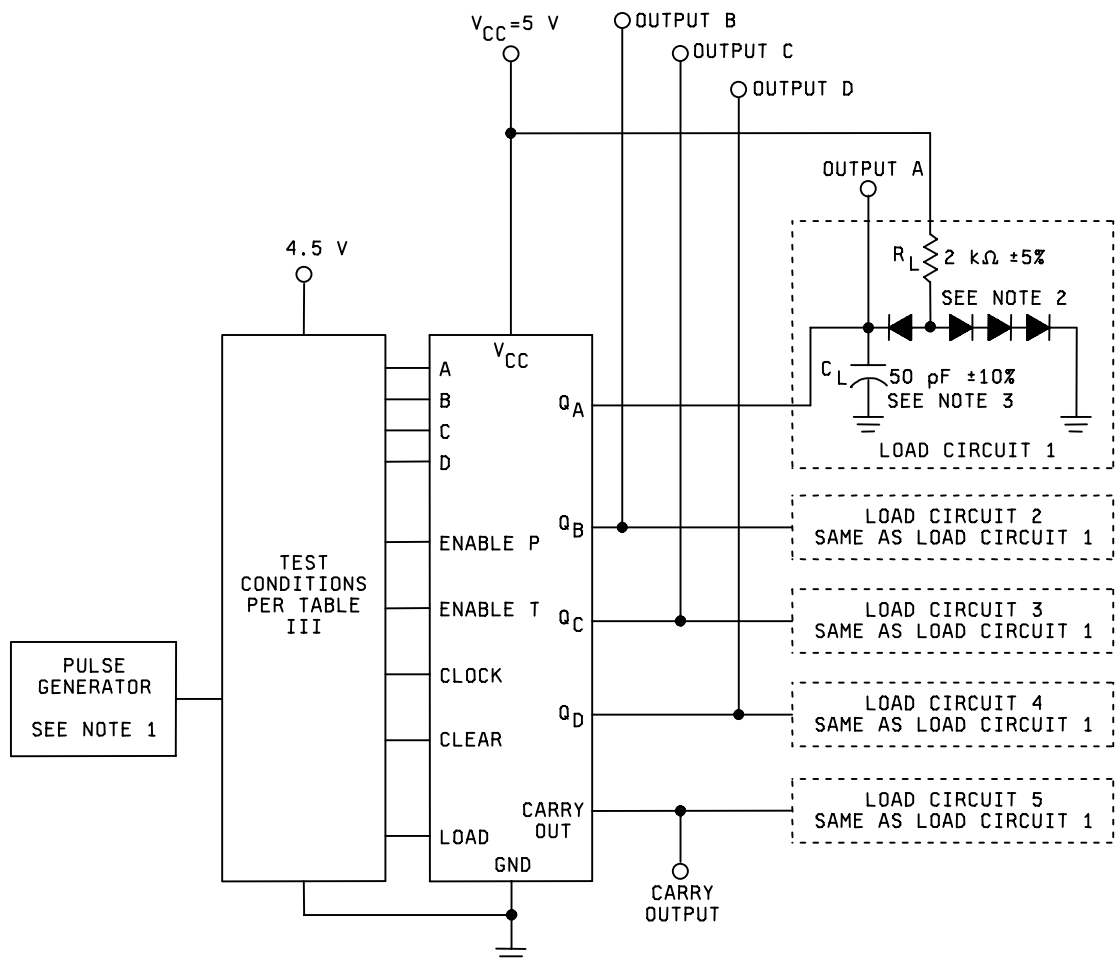
$V_{\text{gen}} = 3.0$ V, $t_r \leq 15$ ns, $t_f \leq 6$ ns, 20 ns $\leq t_w(\text{clear}) \leq 25$ ns for types 11 and 12, 20 ns $\leq t_{\text{setup}} \leq 25$ ns, $t_{\text{hold}} = 0$ ns.

FIGURE 6. Switching time test circuit and waveforms for device types 03, 04, 11, and 12 – Continued.



NOTE: The data pulse generator has the following characteristics: $V_{gem} = 3.0 V$,
 $t_r \leq 15 ns$, $t_f \leq 6 ns$, $t_{DATA} = 30 ns$, $t_{setup} = 20 ns$, $t_{HOLD} = 10 ns$.

FIGURE 6. Switching time test circuit and waveforms for device types 03, 04, 11, and 12 – Continued.



NOTES:

1. The pulse generator has the following characteristics: $V_{gen} = 3\text{ V}$, $t_r \leq 15\text{ ns}$, $t_f \leq 6\text{ ns}$, $t_p = .5\text{ }\mu\text{s}$, $\text{PRR} \leq 1\text{ MHz}$, $Z_{out} \approx 50\Omega$.
2. All diodes are 1N3064 or equivalent.
3. C_L includes probe and jig capacitance.
4. Voltage values are with respect to ground terminal.
5. F_{MAX} : $t_r = t_f \leq 6\text{ ns}$.

FIGURE 6. Switching time test circuit and waveforms for device type 03, 04, 11, and 12 – Continued.

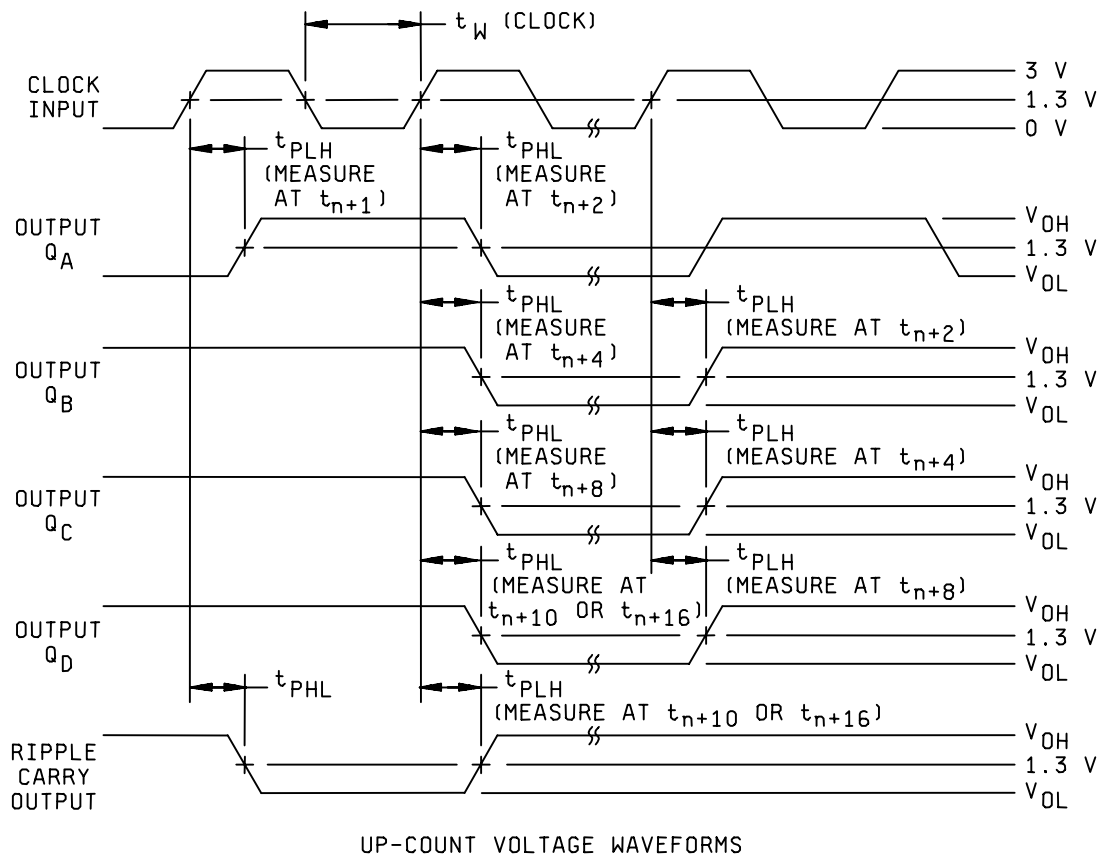


FIGURE 7. Switching time test circuit and waveforms for device types 05 and 06.

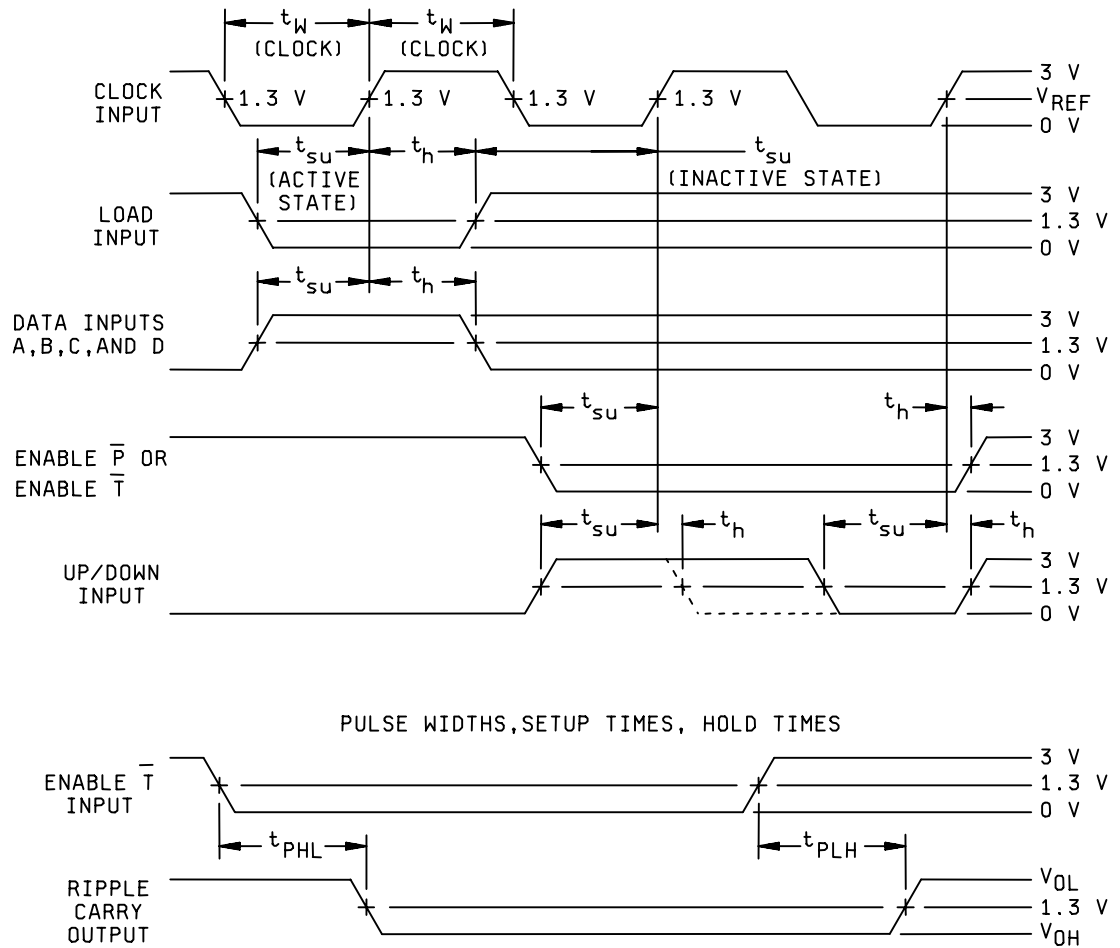
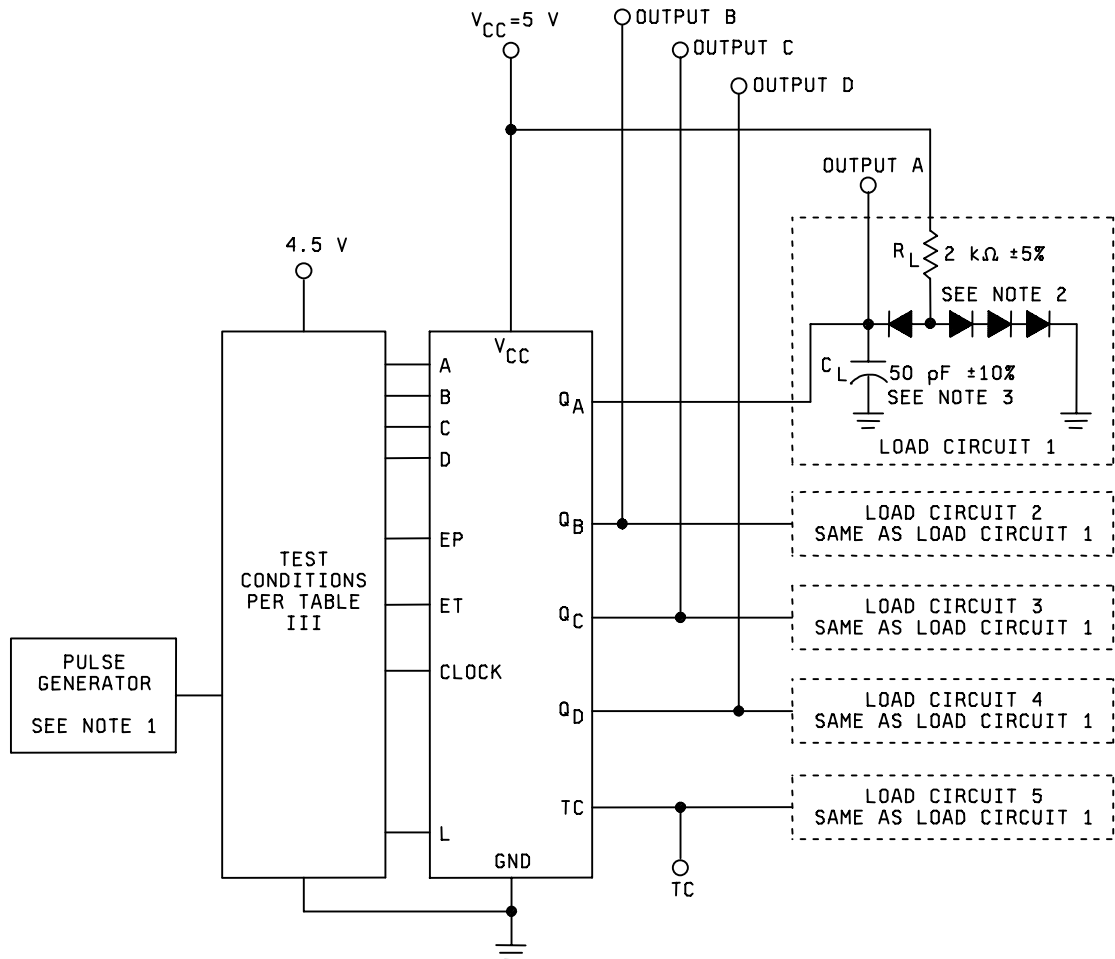


FIGURE 7. Switching time test circuit and waveforms for device types 05 and 06 – Continued.



NOTES:

1. The pulse generator has the following characteristics: $V_{gen} = 3\text{ V}$, $t_r \leq 15\text{ ns}$, $t_f \leq 6\text{ ns}$, $t_p = .5\text{ }\mu\text{s}$, $PRR \leq 1\text{ MHz}$, $Z_{out} \approx 50\text{ }\Omega$.
2. All diodes are 1N3064 or equivalent.
3. C_L includes probe and jig capacitance.
4. Voltage values are with respect to ground terminal.
5. F_{MAX} : $t_r = t_f \leq 6\text{ ns}$.
6. The clear pulse generator has the following characteristics: $V_{gen} = 3.0\text{ V}$, $t_r \leq 15\text{ ns}$, $t_f \leq 6\text{ ns}$, $t_w(\text{CLEAR}) = 20\text{ ns}$.

FIGURE 7. Switching time test circuit and waveforms for device types 05 and 06 – Continued.

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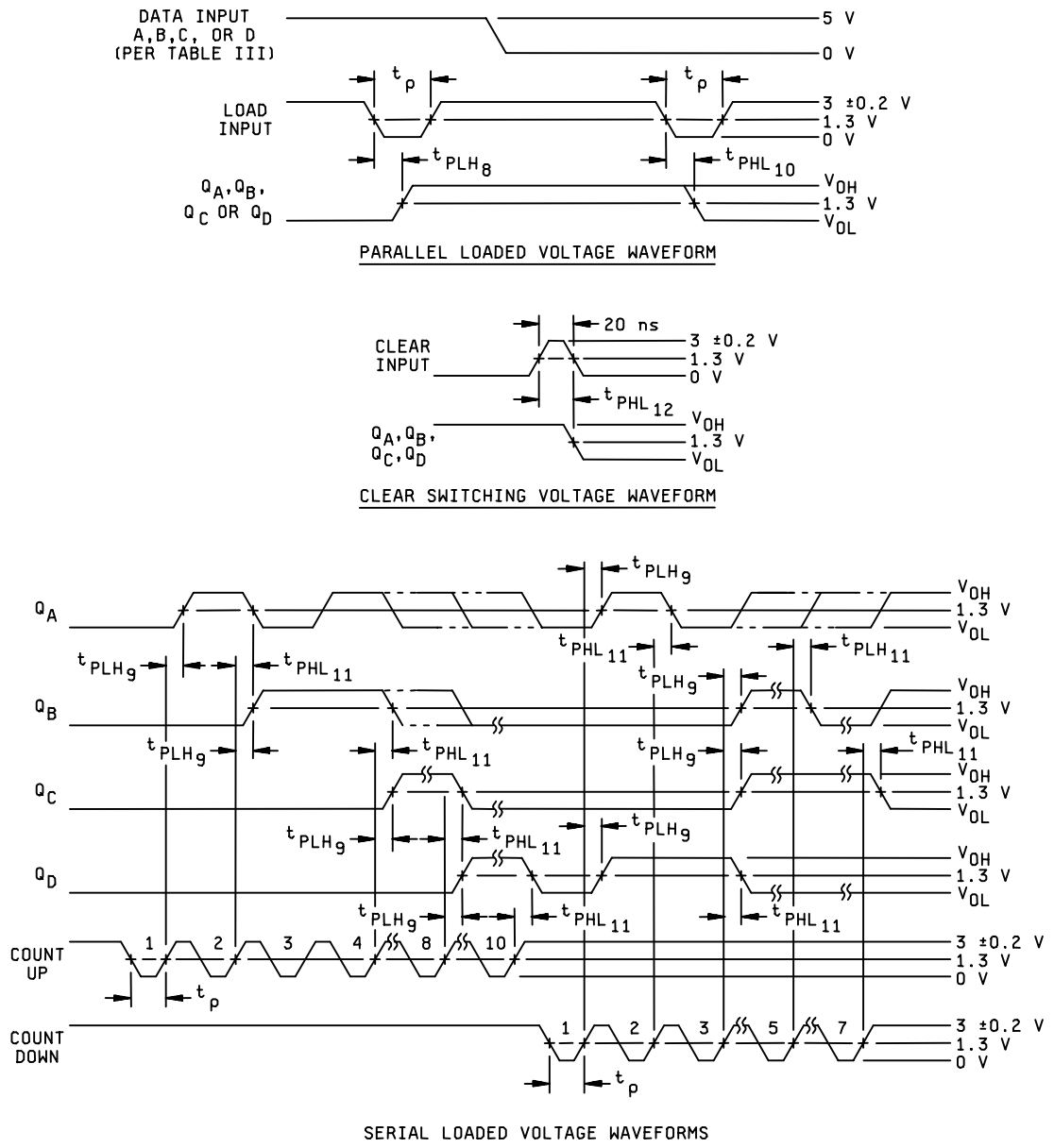
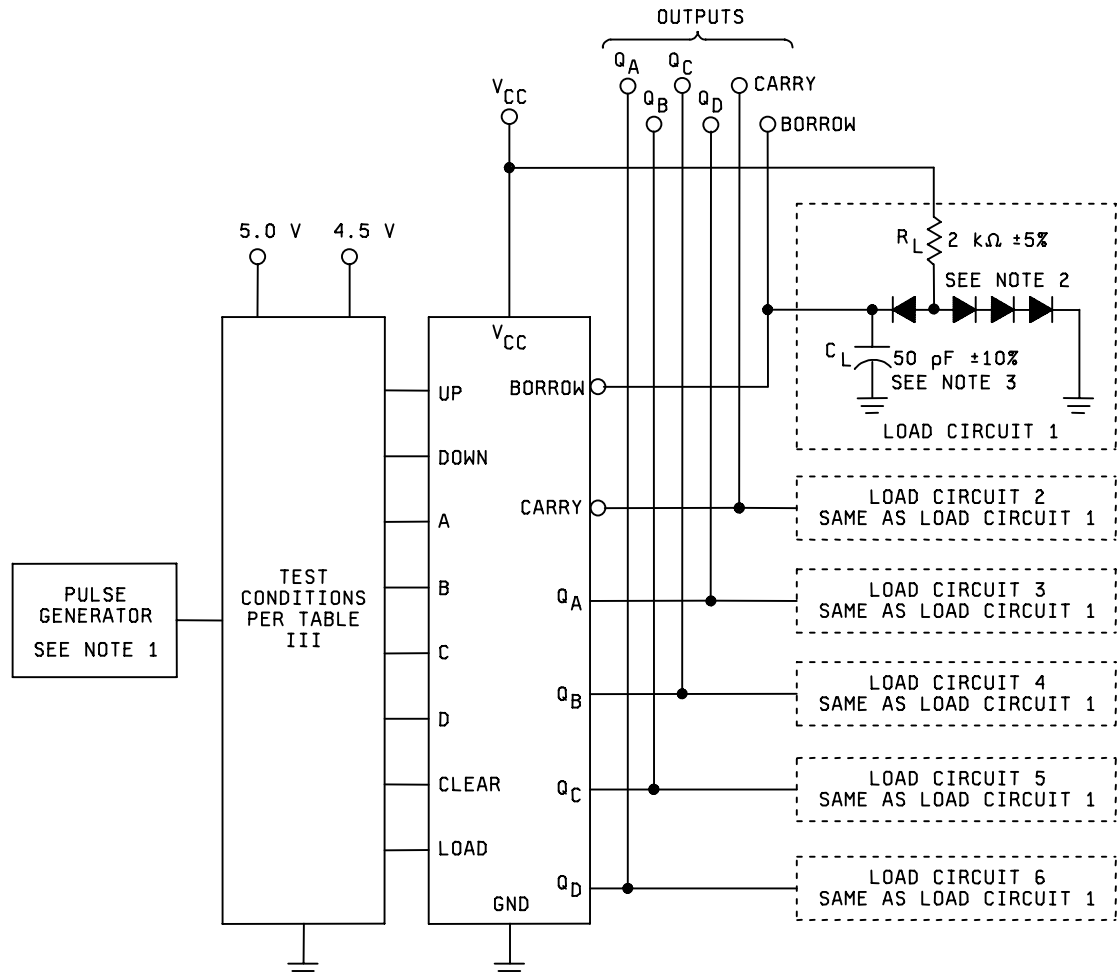


FIGURE 8. Switching time test circuit and waveforms for device types 07.



NOTES:

1. The pulse generator has the following characteristics: $V_{\text{gen}} = 3 \text{ V}$, $t_p = .5 \mu\text{s}$, $\text{PRR} \leq 1 \text{ MHz}$, $Z_{\text{out}} \approx 50 \Omega$, $t_r \leq 15 \text{ ns}$, $t_f \leq 6 \text{ ns}$ between 0.7 V and 2.7 V.
2. All diodes are 1N3064 or equivalent.
3. C_L includes probe and jig capacitance.
4. Voltage values are with respect to ground terminal.
5. F_{MAX} : $t_r = t_f \leq 6 \text{ ns}$.
6. The clear pulse generator has the following characteristics: $V_{\text{gen}} = 3.0 \text{ V}$, $t_r \leq 15 \text{ ns}$, $t_f \leq 6 \text{ ns}$, between 0.7 V and 2.7 V, $t_{w(\text{CLEAR})} = 20 \text{ ns}$.

FIGURE 8. Switching time test circuit and waveforms for device types 07 and Continued.

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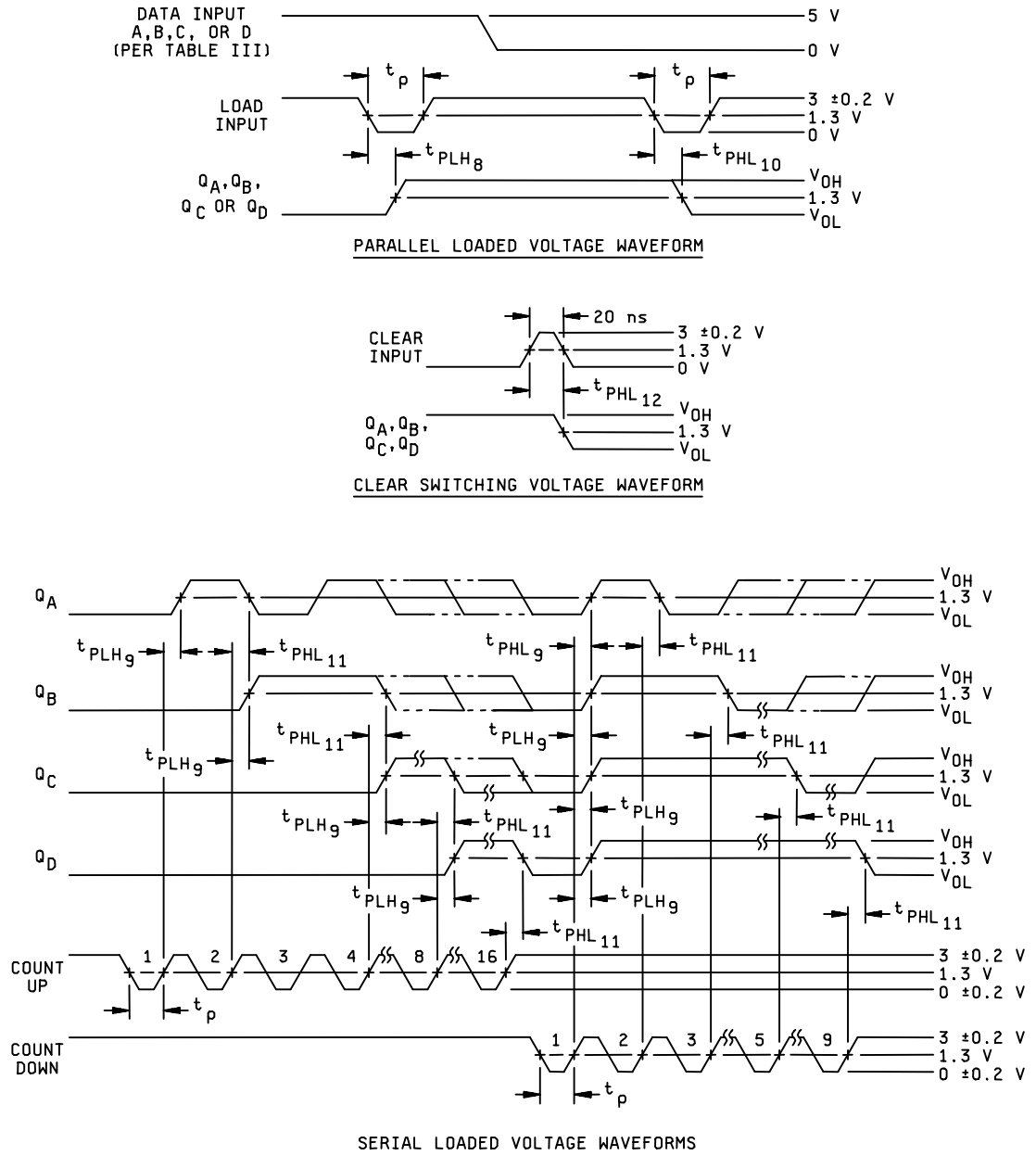
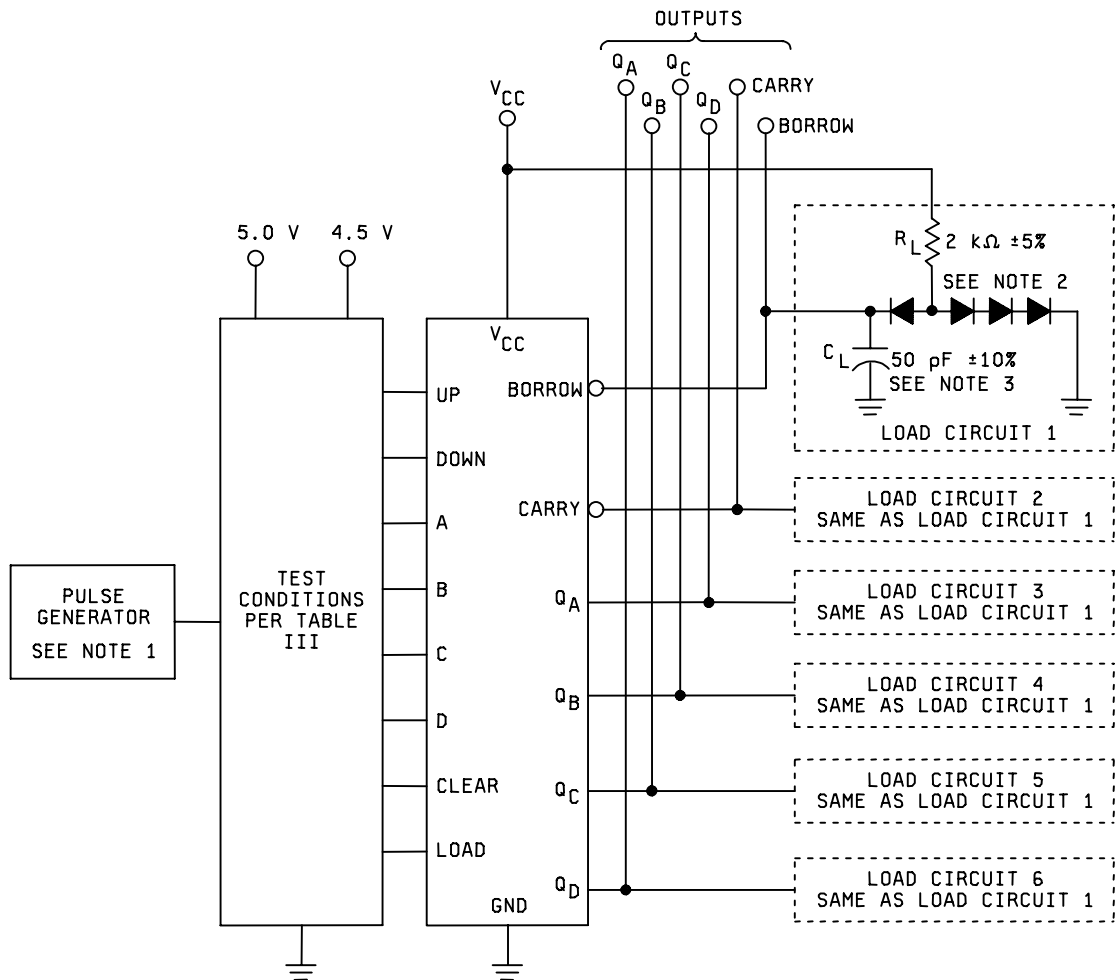


FIGURE 9. Switching time test circuit and waveforms for device type 08.



NOTES:

1. The load and count pulse generators have the following characteristics: $V_{gen} = 3\text{ V}$, $t_p = .5\ \mu\text{s}$, $PRR \leq 1\text{ MHz}$, $Z_{out} \approx 50\ \Omega$, $t_r \leq 15\text{ ns}$, $t_f \leq 6\text{ ns}$ between 0.7 V and 2.7 V.
2. All diodes are 1N3064 or equivalent.
3. C_L includes probe and jig capacitance.
4. Voltage values are with respect to ground terminal.
5. F_{MAX} : $t_r = t_f \leq 6\text{ ns}$.
6. The clear pulse generator has the following characteristics: $V_{gen} = 3.0\text{ V}$, $t_r \leq 15\text{ ns}$, $t_f \leq 6\text{ ns}$, between 0.7 V and 2.7 V, $t_w(CLEAR) = 20\text{ ns}$.

FIGURE 9. Switching time test circuit and waveforms for device type 08 – Continued.

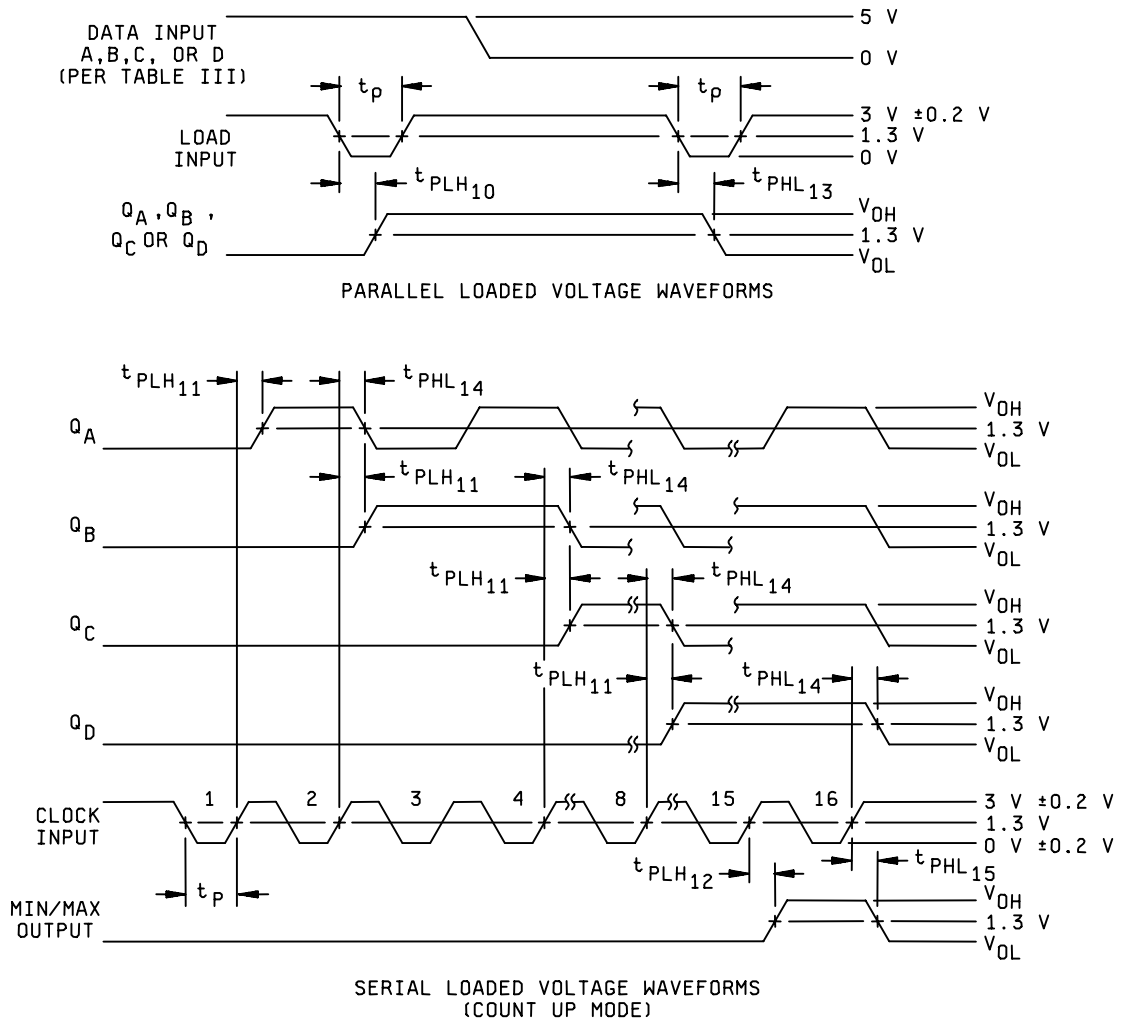
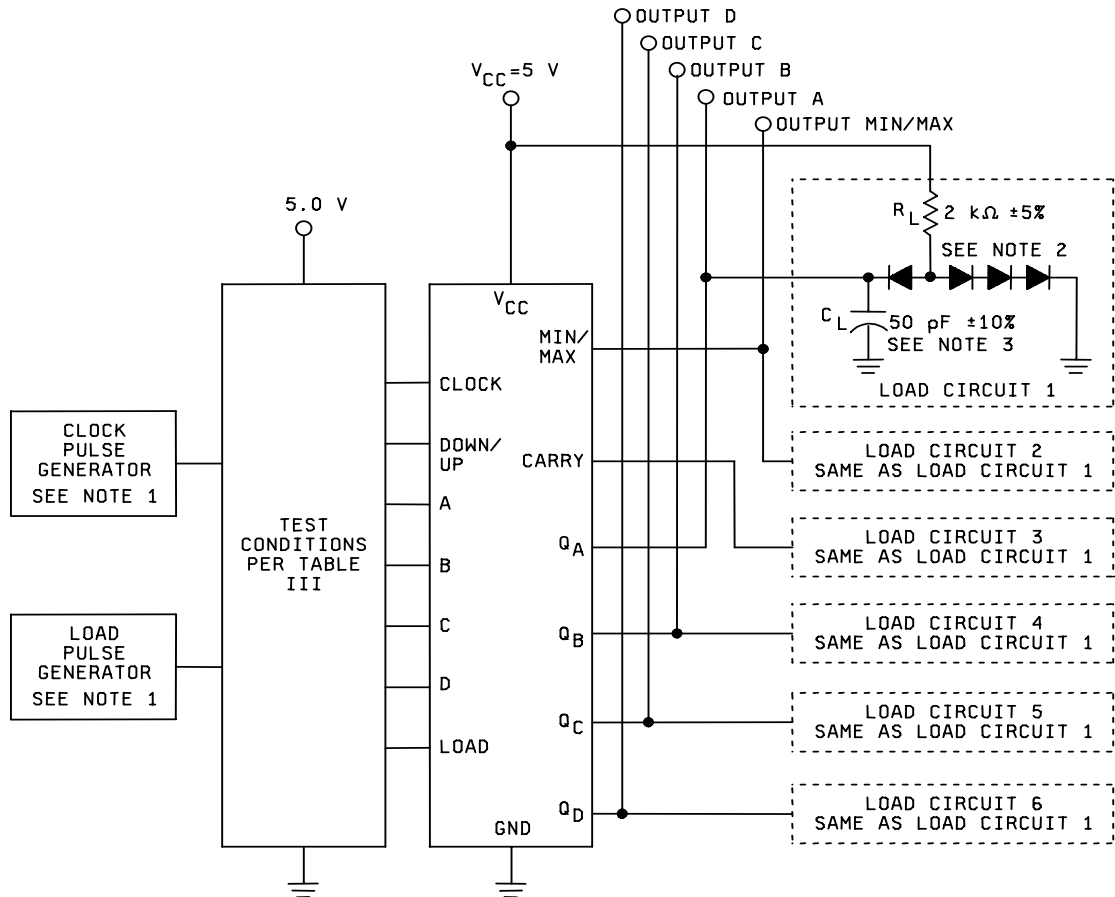


FIGURE 10. Switching time test circuit and waveforms for device type 09.



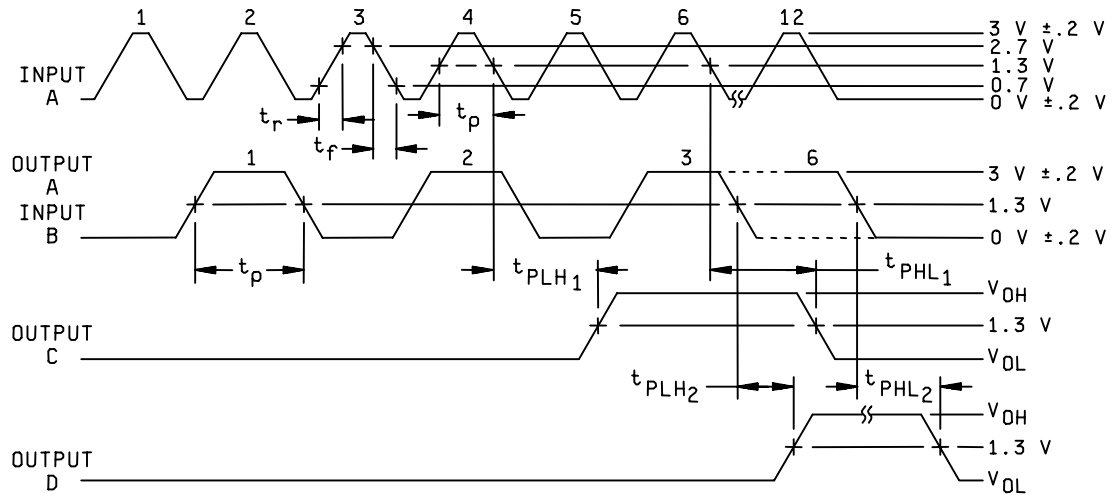
TEST CIRCUIT

NOTES:

1. The pulse generator has the following characteristics: $V_{gen} = 3 V$, $t_p = .5 \mu s$, $PRR \leq 1 MHz$, $Z_{out} \approx 50 \Omega$, $t_r \leq 15 ns$, $t_f \leq 6 ns$ between 0.7 V and 2.7 V.
2. All diodes are 1N3064 or equivalent.
3. C_L includes probe and jig capacitance.
4. Voltage values are with respect to ground terminal.
5. F_{MAX} : $t_r = t_f \leq 6 ns$.

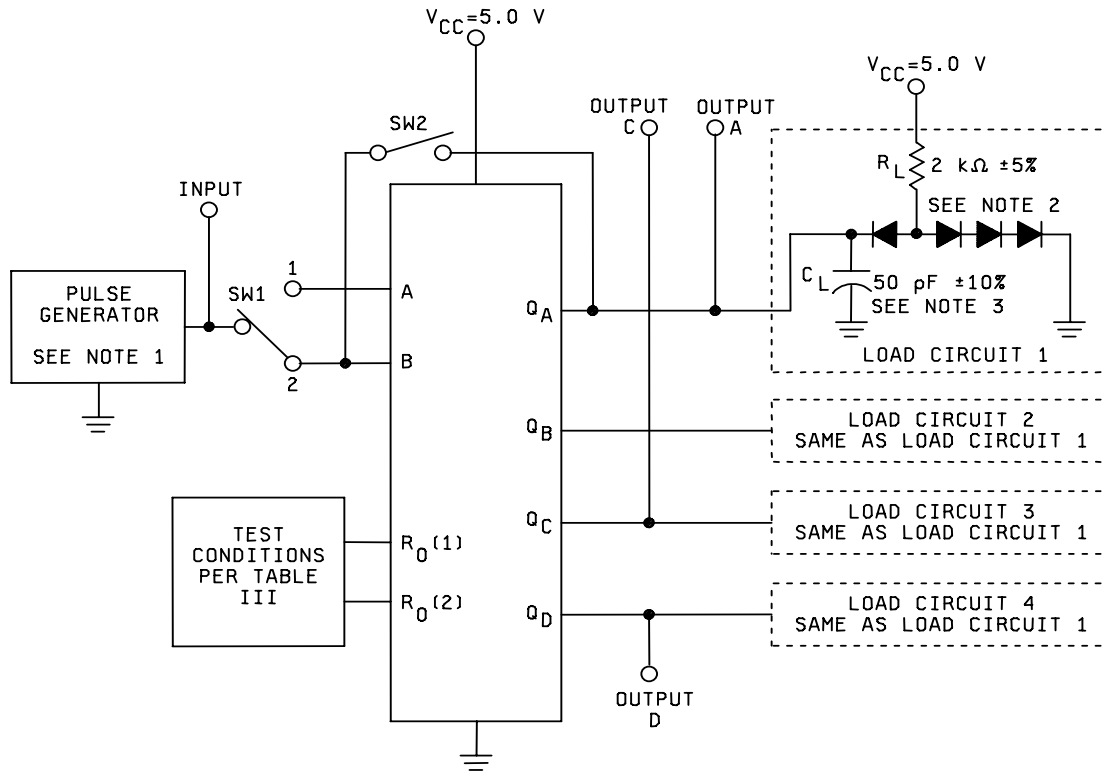
FIGURE 10. Switching time test circuit and waveforms for device type 09 – Continued.

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VOLTAGE WAVEFORMS

FIGURE 11. Switching time test circuit and waveforms for device type 10.



TEST	SWITCH POSITION	
	SW1	SW2
F MAX	1	CLOSED
A TO Q _C	1	CLOSED
B TO Q _D	2	OPEN

TEST CIRCUIT

NOTES:

1. The pulse generator has the following characteristics: $V_{gen} = 3 \text{ V}$, $t_r \leq 15 \text{ ns}$, $t_f \leq 6 \text{ ns}$, $t_p = .5 \mu\text{s}$, $PRR \leq 1 \text{ MHz}$, $Z_{out} \approx 50\Omega$.
2. All diodes are 1N3064 or equivalent.
3. C_L includes probe and jig capacitance.
4. Voltage values are with respect to ground terminal.
5. F_{MAX} : $t_r = t_f \leq 6 \text{ ns}$.

FIGURE 11. Switching time test circuit and waveforms for device type 10 – Continued.

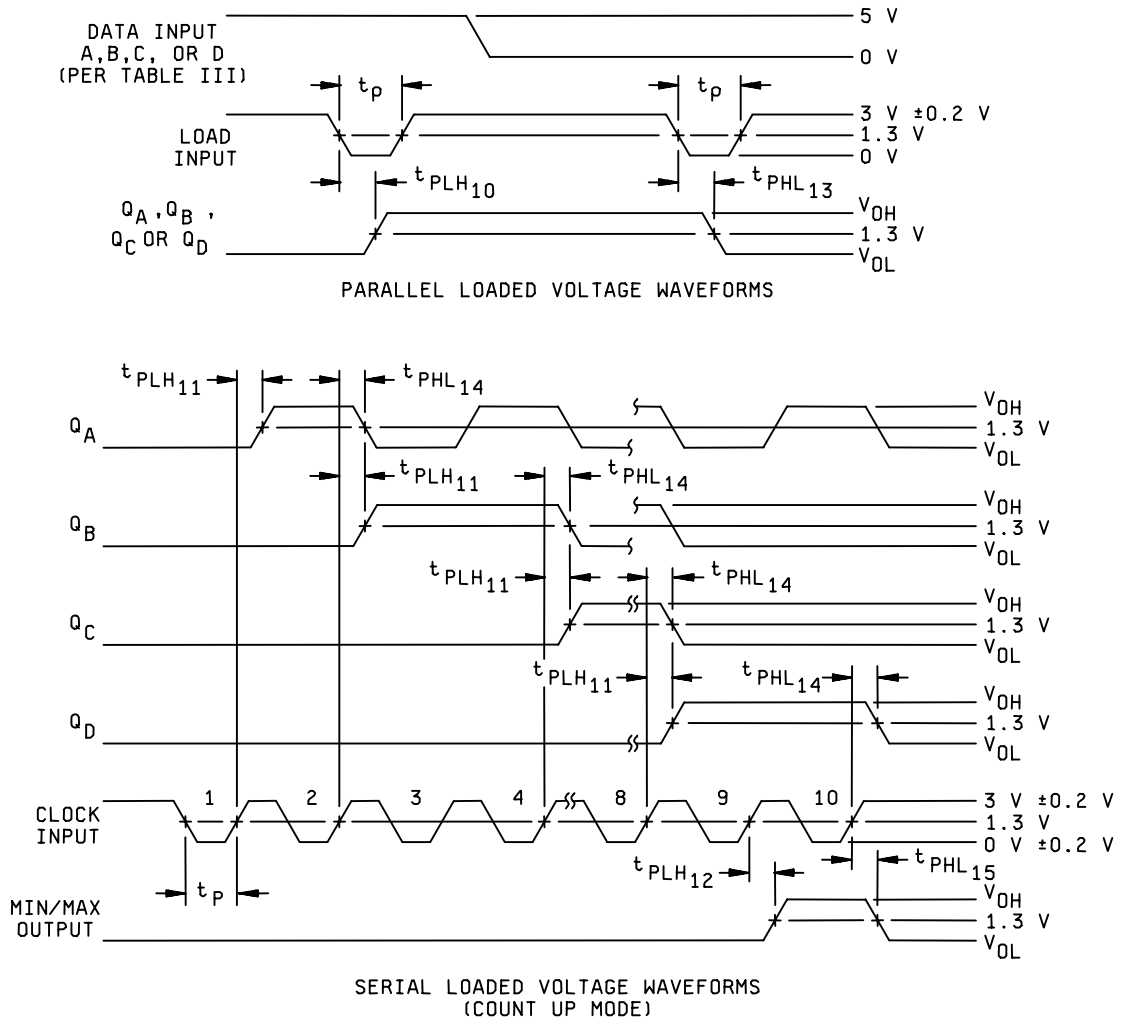
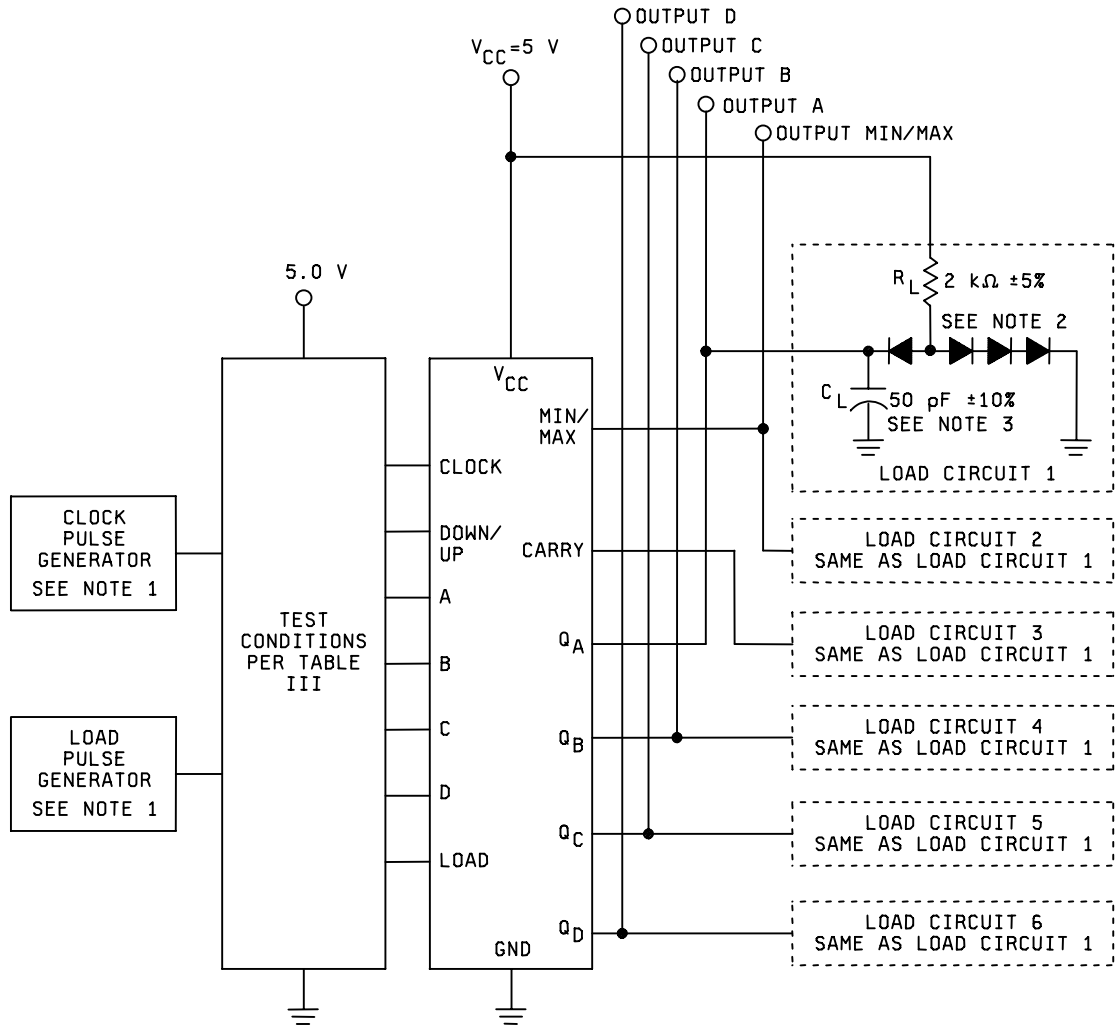


FIGURE 12. Switching time test circuit and waveforms for device type 13.



NOTES:

1. The pulse generator have the following characteristics: $V_{gen} = 3 V$,
 $t_p = .5 \mu s$, $PRR \leq 1 \text{ MHz}$, $Z_{out} \approx 50 \Omega$, $t_r \leq 15 \text{ ns}$, $t_f \leq 6 \text{ ns}$, between 0.7 V and 2.7 V.
2. All diodes are 1N3064 or equivalent.
3. C_L includes probe and jig capacitance.
4. Voltage values are with respect to ground terminal.
5. F_{MAX} : $t_r = t_f \leq 6 \text{ ns}$.

Figure 12. Switching time test circuit and waveforms for device type 13 - Continued.

TABLE III. Group A inspection for device type 01.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases A,B,C,D Cases 1/2	1	2	3	4	5	6	7	8	9	10	11	12	13	14	Measured		Limits		Unit		
																		terminal	terminal	Min	Max			
1 Tc = 25°C	V _{OL}	3007	Test no. 1	2.0 V	R _O (1) 2.0 V	R _O (2) 2.0 V	NC	V _{CC} 4.5 V	R9(1) GND	R9(2) GND	GND	Q _B 4 mA	Q _B 4 mA	GND	Q _A	Q _A	A	Q _C	Q _C	0.4		V		
		"	2	"	"	"	"	"	GND	GND	"	"	"	"	"	"	"	"	Q _B	Q _B	"		"	
		"	3	"	"	"	"	"	"	2.0 V	0.7 V	"	"	4 mA	"	"	"	"	Q _D	Q _D	"		"	
		"	4	GND	"	"	"	"	"	0.7 V	2.0 V	"	"	"	"	"	"	"	Q _A	Q _A	"		"	
		"	5	2.0 V	"	"	"	"	"	2.0 V	"	"	4 mA	"	"	"	"	"	Q _C	Q _C	"		"	
		"	6	2.0 V	"	0.7 V	2.0 V	"	"	"	"	"	"	4 mA	"	"	"	"	Q _B	Q _B	"		"	
		"	7	2.0 V	"	0.7 V	2.0 V	"	"	"	"	"	"	"	-0.4 mA	"	"	"	Q _B	Q _B	2.5		"	
		"	8	GND	"	0.7 V	2.0 V	"	"	"	"	"	"	"	"	-0.4 mA	"	"	Q _A	Q _A	"		"	
		"	9	2.0 V	"	0.7 V	2.0 V	"	"	"	"	"	"	"	"	-0.4 mA	"	"	GND	Q _B	"		"	
		"	10	GND	"	0.7 V	2.0 V	"	"	"	"	"	"	"	"	-0.4 mA	"	"	2.0 V	Q _A	"		"	
I _{IL1}	I _{IL1}	"	11	3/ 4/ 5/	3/ 3/	3/ 3/	"	"	0.7 V	0.7 V	-0.4 mA	"	"	"	"	"	"	GND	Q _C	"		"		
		"	12	3/ 5/	3/ 3/	3/ 3/	"	"	0.7 V	0.7 V	"	-0.4 mA	"	"	"	"	"	GND	Q _B	"		"		
		"	13	"	0.4 V	5.5 V	"	"	5.5 V	"	"	"	"	"	"	"	"	"	R _O (1)	6/	6/		mA	
		"	14	"	5.5 V	0.4 V	"	"	"	"	"	"	"	"	"	"	"	"	"	R _O (2)	"	"		"
		"	15	"	"	"	"	"	"	0.4 V	5.5 V	"	"	"	"	"	"	"	"	R _O (1)	"	"		"
		"	16	"	"	"	"	"	"	5.5 V	0.4 V	"	"	"	"	"	"	"	"	R _O (2)	"	"		"
		"	17	"	"	GND	GND	"	"	"	3/ 3/	3/ 3/	"	"	"	"	"	"	0.4 V	A	"	"		"
		"	18	0.4 V	GND	GND	"	"	"	"	3/ 3/	3/ 3/	"	"	"	"	"	"	"	B	"	"		"
		"	19	"	"	"	"	"	4.5 V	-18 mA	"	"	"	"	"	"	"	"	"	R _O (1)	"	-1.5		V
		"	20	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	R _O (2)	"	"		"
I _{IH1}	I _{IH1}	"	21	"	"	"	"	"	"	"	"	"	"	"	"	"	"	-18 mA	A	"	"		"	
		"	22	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	B	"	"		"	
		"	23	"	-18 mA	"	"	"	"	"	"	"	"	"	"	"	"	"	"	R _O (1)	"	"		"
		"	24	"	"	-18 mA	"	"	"	"	"	"	"	"	"	"	"	"	"	R _O (2)	"	"		"
		"	25	3010	"	"	"	"	5.5 V	2.7 V	"	"	"	"	"	"	"	"	"	R _O (1)	"	20		μA
		"	26	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	R _O (2)	"	"		"
		"	27	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	R _O (1)	"	"		"
		"	28	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	R _O (2)	"	"		"
		"	29	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	R _O (1)	"	100		"
		"	30	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	R _O (2)	"	"		"
I _{IH2}	I _{IH2}	"	31	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	R _O (1)	"	"		"	
		"	32	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	R _O (2)	"	"		"	
		"	33	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	R _O (1)	"	80		"	
		"	34	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	R _O (2)	"	400		"	
		"	35	"	2.7 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	A	"	160		"
		"	36	"	5.5 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	B	"	800		"

See footnotes at end of device types 01.

TABLE III. Group A inspection for device type 01 - Continued
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases A,B,C,D	1	2	3	4	5	6	7	8	9	10	11	12	13	14	Measured terminal	Limits	Unit											
1 T _c = 25°C	I _{OS}	3011	2	B	R _O (1)	R _O (2)	NC	V _{CC}	R9(1)	R9(2)	Q _C	Q _B	GND	Q _B	Q _A	NC	A	Q _B	Min	-15	mA										
				37	GND	GND	5.5 V	5.5 V	5.5 V	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	Q _A	Max	-100	mA								
				38	GND	GND	5.5 V	5.5 V	5.5 V	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	Q _B	"	"	"							
				39	3/ 5/	3/ 4/	"	"	"	"	"	"	"	"	"	"	"	"	"	"	Q _C	"	"	"							
				40	3/ 4/	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	Q _C	"	"	"							
41	GND	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	V _{CC}	"	15	"											
2	Same tests, terminal conditions, and limits as for subgroup 1, except T _c = 125°C and V _{IC} tests are omitted.																														
3	Same tests, terminal conditions, and limits as for subgroup 1, except T _c = -55°C and V _{IC} tests are omitted.																														
7 T _c = +25°C	Functional tests Z/	3014	A, B/	A, B/	A, B/	A, B/	A, B/	A, B/	A, B/	A, B/	A, B/	A, B/	A, B/	A, B/	A, B/	A, B/	A, B/	A, B/	A, B/	A, B/	A, B/										
				B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B							
				B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B					
				B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B				
				B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B				
				B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B			
				B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B		
				B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	
				B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	
				B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	
				B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	
				B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	
				B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	
				B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B
				B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B
				B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B
				B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B
				B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B
				B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B

See footnotes at end of device type 01.

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TABLE III. Group A inspection for device type 01 - Continued
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases A,B,C,D	Cases 1/2	1	2	3	4	5	6	7	8	9	10	11	12	13	14	Limits		Unit																																																				
																			Measured terminal	Min		Max																																																			
7 T _c = +25°C	Functional tests Z/	3014	A,B,C,D	2	B	R _O (1) B 8/	R _O (2) A	NC	V _{CC} 4.5 V	R9(1) A	R9(2) B	Q _c H	Q _b H	GND GND	Q _b L	Q _a L	Q _a L	NC	A																																																						
																							See 9/																																																		
																								8 T _c = +25°C	F _{MAX} f _{PLH1} f _{PLH1} f _{PLH2} f _{PLH2}	3003 (Fig. 4)				GND	A B/	5.0 V	GND	GND	GND	GND	GND	GND	GND	OUT	OUT	OUT	OUT	OUT	OUT	OUT	OUT	OUT																									
10 T _c = +125°C	F _{MAX} f _{PLH1} f _{PLH1} f _{PLH2}					GND	A			A	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND																																																	
11																																																																									

See footnotes at end of device type 01.

- 1/ Case 2 pins not referenced are N/C.
- 2/ Test 4, Pin 12; 4 mA + I_{L3(MAX)}.
- 3/ Apply 4.5 V pulse then ground prior to taking measurements to set device in the desired state.
- 4/ Apply two pulses after R_O (reset) pulse.
- 5/ Apply one pulse after R_O (reset) pulse.
- 6/ I_L limits (mA) min/max values for circuits shown:

Parameter	Terminals	Circuits						
		A	B	C	D	E	F	G
I _{L1}	R _O (1)	-12/-36	-03/-40		-03/-40	-12/-36	-12/-36	
	R _O (2)	"	"		"	"	"	
	R9(1)	"	"		"	"	"	
	R9(2)	"	"		"	"	"	
I _{L2}	A	-0.5/-2.0	-1.0/-2.4		-1.0/-2.4	-1.0/-2.4	-0.5/-2.0	
I _{L3}	B	-0.4/-1.6	-1.3/-3.2		-1.3/-3.2	-1.3/-3.2	-1.0/-2.4	

- 7/ Only a summary of attributes data is required.
- 8/ A = 3.0 V minimum, B = 0.0 V or GND.
- 9/ H > 1.5 V; L < 1.5 V.
- 10/ F_{MAX} minimum limit specified is the frequency of the input pulse. The output pulse shall be one-half of the input frequency.
- 11/ Momentary 3.0 V (min), then ground. Maintain ground for measurement.

TABLE III. Group A inspection for device type 02.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases A,B,C,D	1	2	3	4	5	6	7	8	9	10	11	12	13	14	Measured terminal	Limits	Unit		
1 Tc = 25°C	VOL	3007	1	B	R0(1)	R0(2)	NC	VCC	NC	NC	QC	QB	GND	QB	QA	NC	20	QA	Min	0.4 V		
		"	2	"	"	"	"	"	"	"	"	4mA	4 mA	"	"	"	"	QB	Max	"		
		"	3	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	QC	"	"	
		"	4	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	Qb	"	"	
	VOH	3006	5	GND	3/	3/	"	"	"	"	"	"	"	"	"	"	"	"	QA	2.5	"	
		"	6	3/ 4/	3/	"	"	"	"	"	"	"	"	"	"	"	"	"	QB	"	"	
		"	7	3/ 5/	"	"	"	"	"	"	"	"	"	"	"	"	"	"	QC	"	"	
		"	8	3/ 6/	"	"	"	"	"	"	"	"	"	"	"	"	"	"	Qb	"	"	
	VIC	"	9	"	"	"	"	"	"	"	"	"	"	"	"	"	"	-18 mA	A	-1.5 mA	"	
		"	10	-18 mA	"	"	"	"	"	"	"	"	"	"	"	"	"	"	B	"	"	
		"	11	"	"	-18 mA	"	"	"	"	"	"	"	"	"	"	"	"	R0(1)	"	"	
		"	12	"	"	"	-18 mA	"	"	"	"	"	"	"	"	"	"	"	R0(2)	"	"	
		"	13	3009	13	0.4 V	5.5 V	5.5 V	"	"	"	"	"	"	"	"	"	"	R0(1)	7/	7/	mA
		"	14	"	14	5.5 V	0.4 V	"	"	"	"	"	"	"	"	"	"	"	R0(2)	"	"	
	IIL2	"	15	"	3/	3/	"	"	"	"	"	"	"	"	"	"	0.4 V	A	"	"		
	IIL3	"	16	0.4 V	3/	3/	"	"	"	"	"	"	"	"	"	"	"	B	"	"		
	IHH1	"	17	"	2.7 V	GND	"	"	"	"	"	"	"	"	"	"	"	R0(1)	"	20	µA	
	IHH2	"	18	"	GND	2.7 V	"	"	"	"	"	"	"	"	"	"	"	R0(2)	"	20		
IHH3	"	19	"	5.5 V	GND	"	"	"	"	"	"	"	"	"	"	"	R0(1)	"	100			
IHH4	"	20	"	GND	5.5 V	"	"	"	"	"	"	"	"	"	"	"	R0(2)	"	100			
IHH5	"	21	"	5.5 V	"	"	"	"	"	"	"	"	"	"	"	"	A	"	80			
IHH6	"	22	"	"	"	"	"	"	"	"	"	"	"	"	"	"	A	"	400			
IHH7	"	23	"	2.7 V	"	"	"	"	"	"	"	"	"	"	"	"	"	B	"	80		
IHH8	"	24	"	5.5 V	"	"	"	"	"	"	"	"	"	"	"	"	"	B	"	400		
Ios	"	25	"	GND	3/	3/	"	"	"	"	"	"	"	"	GND	"	3/ 4/	QA	-15	-100 mA		
"	"	26	"	3/ 4/	"	"	"	"	"	"	"	"	"	"	"	"	GND	QB	"	"		
"	"	27	"	3/ 5/	"	"	"	"	"	"	"	"	"	"	"	"	"	QC	"	"		
"	"	28	"	3/ 6/	"	"	"	"	"	"	"	"	"	"	"	"	"	Qb	"	"		
Icc	"	29	"	GND	GND	"	"	"	"	"	"	"	"	"	GND	"	"	VCC	"	15		
2	Same tests, terminal conditions, and limits as for subgroup 1, except Tc = 125°C and VIC tests are omitted.																					
3	Same tests, terminal conditions, and limits as for subgroup 1, except Tc = -55°C and VIC tests are omitted.																					

See footnotes at end of device types 02.

TABLE III. Group A inspection for device type 02 - Continued
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases A,B,C,D Cases 1/2	Test no.	1	2	3	4	5	6	7	8	9	10	11	12	13	14	Measured terminal	Limits		Unit				
																				Min	Max					
7 Tc = 25°C	Functional tests &/g/	3014	30	A	A	A/g/	A	NC	4.5 V	NC	NC	Qc	Qb	GND	Qb	Qa	NC	A	See 10/							
																							31	B	B	B
																							32	B	B	B
																							33	B	B	B
																							34	A	A	A
																							35	B	B	B
																							36	A	B	A
																							37	A	B	B
																							38	A	B	B
																							39	A	B	B
																							40	B	B	B
																							41	A	A	A
																							42	B	B	B
																							43	A	A	A
																							44	B	B	B
																							45	A	A	A
																							46	B	B	B
																							47	A	A	A
																							48	B	B	B
																							49	A	A	A
																							50	B	B	B
																							51	A	A	A
																							52	B	B	B
																							53	A	A	A
																							54	B	B	B
																							55	A	A	A
																							56	B	B	B
																							57	A	A	A
																							58	B	B	B
																							59	A	A	A
																							60	B	B	B
																							61	A	A	A
																							62	B	B	B
																							63	A	A	A
																							64	B	B	B
																							65	A	B	A
																							66	B	B	B
																							67	A	B	B
																							68	B	B	B
																							69	A	B	B
																							70	A	B	B
																							71	A	A	A
																							72	B	B	B
																							73	A	B	B
																							74	B	B	B
																							75	A	B	B
																							76	B	B	B

Subgroup	Symbol	MIL-STD-883 method	Cases A,B,C,D Cases 1/2	Test no.	1	2	3	4	5	6	7	8	9	10	11	12	13	14	Measured terminal	Limits		Unit																						
																				Min	Max																							
8 Tc = +25°C	Fmax	3003 (Fig. 5)	77	GND	GND	GND	GND	5.0 V												A to Oa	29	MHz																						
																							FpHL	12/	A/g/	OUT	OUT														A to Qc	3	53	ns
																							FpHL	12/	A	OUT	OUT															B to Qb	56	"
FpHL	12/	A	OUT	OUT																B to Qb	56	"																						

See footnotes at end of device type 02.

TABLE III. Group A Inspection for device type 02 - Continued
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases A,B,C,D	1	2	3	4	5	6	7	8	9	10	11	12	13	14	Limits		Unit	
																		Measured terminal	Min		Max
10 T _C = +125°C	F _{MAX}	3003 (Fig. 5)	Test no. 82	B	R _O (1) GND	R _O (2)	NC	V _{CC} 5.0 V	NC	NC	Q _C	Q _B	GND	Q _D	Q _A OUT	NC	IN ^{1/}	A to Q _A	29	MHz	
	t _{PLH1}	"	83		12/ A	A		"			OUT		"				IN	A to Q _C	3	ns	
	t _{PHL1}	"	84			GND		"			OUT		"				IN	A to Q _C	"	81	"
	t _{PLH2}	"	85		IN	12/ A	A		"				"	OUT				B to Q _B	"	78	"
	t _{PHL2}	"	86		IN	GND		"					"	OUT				B to Q _D	"	78	"
11	Same tests, terminal conditions, and limits as for subgroup 10 except, T _C = 55°C																				

- 1/ Case 2 pins not referenced are N/C.
- 2/ For test 1, 4 mA +I_{L3} (max).
- 3/ Apply 4.5 V pulse, then ground prior to taking measurements to set device in the desired state. Maintain ground for measurement.
- 4/ Input pulse must be applied one time after R_O pulse.
- 5/ Input pulse must be applied twice after R_O pulse.
- 6/ Input pulse must be applied four times after R_O pulse.
- 7/ I_L limits (mA) min/max values for circuits shown:

Parameter	Terminals	Circuits						
		A	B	C	D	E	F	G
I _{L1}	R _O (1)	-12/-36	-03/-40	-12/-36	-03/-40	-12/-36	-12/-36	
	R _O (2)	"	"	"	"	"	"	
I _{L2}	A	-0.5/-2.0	-1.0/-2.4	-0.5/-2.0	-1.0/-2.4	-1.0/-2.4	-0.5/-2.0	
I _{L3}	B	-0.4/-1.6	-0.4/-1.6	-0.4/-1.6	-0.4/-1.6	-0.4/-1.6	-0.4/-1.6	

- 8/ Only a summary of attributes data is required.
- 9/ A = 3.0 V minimum; B = 0.0 V or GND.
- 10/ H > 1.5 V; L < 1.5 V.
- 11/ F_{MAX} min limit specified is the frequency of the input pulse. The output frequency shall be one-half the input frequency.
- 12/ Momentary 3.0 V (min), then ground. Maintain ground for measurement.

TABLE III. Group A inspection for device types 03, 04, 11, and 12. Terminal conditions (pins not designated may be H ≥ 2.0 V, or L ≤ 0.7 V, or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F		1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Measured terminal	Limits		Unit		
			2	1																		Min	Max			
		Test no.	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _b	Q _c	Q _a	Q _b	Ripple carry	V _{cc}						
1 T _c = +25°C	V _{OL}	3007	4.5 V	2/				0.7 V							4 mA	4 mA					4.5 V	Q _b		0.4	V	
		"	"	"																		Q _c		"	"	
		"	"	"			0.7 V										4 mA		4 mA				Q _b		"	"
		"	"	"																			Q _a		"	"
		"	"	"										0.7 V										Ripple carry		"
V _{OH}		3006		2/			2.0 V								-4 mA							Q _b		"	"	
		"	"	"			2.0 V									-4 mA						Q _c		"	"	
		"	"	"			2.0 V															Q _b	2.5	"	"	
		"	"	"			2.0 V	3/	2.0 V				2.0 V										Q _a	"	"	"
V _{IC}		11	-18 mA																						"	
		12		-18 mA																						"
		13			-18 mA																					"
		14				-18 mA																				"
		15						-18 mA																		"
		16							-18 mA																	"
		17								-18 mA																"
		18									-18 mA															"
		19										-18 mA														"
I _{IL4}	3009	20	0.4 V																			Clear		4/	μA	
		21		0.4 V																			Clock		"	"
		22			0.4 V							GND											A		"	"
		23				0.4 V																	B		"	"
		24						0.4 V															C		"	"
		25							0.4 V														D		"	"
		26								0.4 V													ENP		"	"
		27									0.4 V												Load		"	"
		28, 5/									4.5 V												ENP		"	"
		29, 13/	3010	2.7 V																			Clear		20	"
I _{HH9}		30		2.7 V																		Clock		40	"	
		31			2.7 V																		A		20	"
		32				2.7 V																	B		"	"
		33						2.7 V															C		"	"
		34							2.7 V														D		"	"
		35								2.7 V													ENP		"	"
I _{HH8}		36								GND												Load		40	"	
		37									GND											ENP		40	"	

See footnotes at end of device types 03, 04, 11, and 12.

TABLE III. Group A inspection for device types 03, 04, 11, and 12 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F Cases 1/ 2	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Limits		Unit		
																				Measured terminal	Min		Max	
1	I _{H14}	3010	38 13/	5.5 V															5.5 V	Clear		100	µA	
	I _{H10}	"	39	5.5 V																"	Clock		200	"
	I _{H12}	"	40	5.5 V																"	A		100	"
	"	"	41	5.5 V																"	B		"	"
	"	"	42				5.5 V													"	C		"	"
	"	"	43					5.5 V												"	D		"	"
	"	"	44						5.5 V											"	ENP		"	"
	I _{H10}	"	45							5.5 V										"	Load		200	"
	I _{H10}	"	46								5.5 V									"	EnT		200	"
	I _{OS}	3011		47	4.5 V	2/			4.5 V											"	EnT		-100	mA
	"	"		48	"	"			4.5 V											"	Q _b		"	"
	"	"		49	"	"			4.5 V											"	Q _c		"	"
	"	"		50	"	"			4.5 V											"	Q _a		"	"
	"	"		51	"	"			4.5 V	5/	4.5 V									"	Q _a		"	"
	I _{CC1}	3005		52	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V									"	Ripple carry		31	"
I _{CC1}	"		53	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V									"	V _{CC}		31	"	
I _{CC1}	"		54	GND	GND	GND	GND	GND	GND	GND									"	"		32	"	
I _{CC1}	"		55	GND	GND	GND	GND	GND	GND	GND									"	"		32	"	
2	Same tests, terminal conditions, and limits as for subgroup 1, except T _C = 125°C and V _{IC} tests are omitted.																							
3	Same tests, terminal conditions, and limits as for subgroup 1, except T _C = -55°C and V _{IC} tests are omitted.																							

See footnotes at end of device types 03, 04, 11, and 12.

TABLE III. Group A inspection for device type 03 - Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	Clear	Clock	Test no.	Terminal conditions											Limits		Measured terminal	Unit													
							Cases E, F	Cases I/J	2	3	4	5	6	7	8	9	10	11	12			13	14	15	16	17	18	19	20	V _{cc}	Limits			
																															Mfn	Max		
7 T _c = +25°C	Functional tests Z/	3014	56	B g/	A g/	A g/	3	A	B	C	D	ENP	GND	Load	EN↑	Q _b	Q _c	Q _b	Q _a	Ripple carry	16	20	V _{cc}											
							4	A	B	A	A	A	A	GND	A	A	L	L	L	L	L	L	L	"	"	"	"	"	"					
							5	B	A g/	A	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
							6	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A		
							7	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	
							8	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	
							9	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	
							10	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A
							11	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A
							12	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A
							13	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A
							14	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A
							15	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A

See 9/

See footnotes at end of device types 03, 04, 11, and 12.
 TABLE III. Group A inspection for device type 03 - Continued.
 Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F		Clear	Clock	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Limits		Unit			
			1	2																	3	4		Min	Max	
7 Tc = +25°C	Functional tests Z/	3014	Test no.	115	A g/	A g/	A	B	C	D	ENP	GND	Load	EnT	Qb	Qc	Qd	Qa	Ripple carry	Vcc						
			116	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"		
			117	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
			118	"	A	B	"	"	"	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	
			119	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
			120	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
			121	"	"	"	"	"	"	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
			122	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			123	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			124	"	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			125	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			126	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			127	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			128	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			129	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
130	"	"	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"			
131	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
132	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
133	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
134	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
135	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
136	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
137	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
138	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
139	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
140	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
141	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
142	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
143	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
144	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
145	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
146	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
147	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
148	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
149	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
150	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
8	Repeat subgroup 7 at Tc = +125°C and Tc = -55°C.																									

See footnotes at end of device types 03, 04, 11, and 12.

See footnotes at end of device types 03, 04, 11, and 12.

TABLE III. Group A inspection for device type 04 – Continued.
Terminal conditions (pins not designated may be H \geq 2.0 V or L \leq 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F Cases 1/ 2 Test no.	1	2	3	4	5	6	7	8	9	Terminal conditions				16	Limits		Unit															
													Clear	Clock	A	B		C	D		ENP	GND	Load	ENT	Qb	Qc	Qb	QA	Ripple carry	Vcc	Min	Max			
																																	A, B/	A	B
7	Func- tional tests Z/	3014	115	A, B/	A, B/	A	A	A	B	A	GND	B	B	L	H	H	H	H	L	4.5V															
			116			A						A																							
			117			B																													
			118			A																													
			119			B		B	A				B																						
			120			A		B	B	A																									
			121		B	A		A	A	A					H	L	L	L	L	L	L	L													
			122		A	A																													
			123		B	A																													
			124			A									H	H	H	H	H	H	H	H													
			125		B	A																													
			126		B	A							A		L	L	L	L	L	L	L	L													
			127		A	A		B					B																						
			128			B																													
			129			A									H	H	H	H	H	H	H	H													
			130			A		B																											
			131			B																													
			132			A									L	L	L	L	L	L	L	L													
			133			A		A																											
			134			B																													
			135			A																													
			136			A		B	A																										
			137			B																													
			138			A																													
			139			A		A																											
			140			B																													
			141			A																													
			142			A		B	A																										
			143			B																													
			144			A																													
			145			A				B	A																								
			146			B																													
			147			A																													
		148			A		A																												
		149			B																														
		150			A																														
		151			A		B	A																											
		152			B																														
		153			A																														
		154			A		A																												
		155			B																														
		156			A																														
8																																			
		Repeat subgroup 7 at Tc = +125 and Tc = -55°C.																																	

See footnotes at end of device types 03, 04, 11, and 12.

TABLE III. Group A inspection for device type 11 - Continued.
Terminal conditions (pins not designated may be $H \geq 2.0 V$ or $L \leq 0.7 V$ or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F Cases 1/2 Test no.	Clear	Clock	Terminal conditions (pins not designated may be $H \geq 2.0 V$ or $L \leq 0.7 V$ or open)												Measured terminal	Limits		Unit							
						3	4	5	6	7	8	9	10	11	12	13	14		15	16		Min	Max					
7 $T_c = +25^\circ C$	Functional tests Z_I	3014	115	A g/	B g/	A	B	C	D	ENP	GND	Load	EnT	Qb	Qc	Qd	Qa	Qa	Ripple carry	V _{cc}	See g/							
			116	"	A	"	"	"	"	"	"	"	"	"	"	H	L	"	L	L				H	"			
			117	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"				"	"	"	"	"
			118	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"				"	"	"	"	"
			119	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"				"	"	"	"	"
			120	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"				"	"	"	"	"
			121	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"				"	"	"	"	"
			122	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"				"	"	"	"	"
			123	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"				"	"	"	"	"
			124	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"				"	"	"	"	"
			125	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"				"	"	"	"	"
			126	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"				"	"	"	"	"
			127	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"				"	"	"	"	"
			128	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"				"	"	"	"	"
			129	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"				"	"	"	"	"
			130	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"				"	"	"	"	"
			131	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"				"	"	"	"	"
			132	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"				"	"	"	"	"
			133	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"				"	"	"	"	"
134	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"						
135	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"						
136	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"						
137	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"						
138	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"						
139	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"						
140	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"						
141	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"						
142	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"						
143	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"						
144	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"						
145	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"						
146	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"						
147	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"						
148	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"						
149	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"						
150	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"						
151	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"						
152	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"						
153	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"						
8	Repeat subgroup 7 at $T_c = +125$ and $T_c = -55^\circ C$.																											

See footnotes at end of device types 03, 04, 11, and 12.

TABLE III. Group A inspection for device type 12 - Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	Cases 1/2	Clear	Clock	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Limits		Unit																								
																					Min	Max																									
7 Tc = +25°C	Functional tests Z/	3014	56	B/g/	B/g/	B/g/	A	B	C	B	D	EnP	EnT	Load	Qc	Qb	Qa	Ripple carry	Vcc	4.5 V																											
																								57	B	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
																								58	A	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								59	A	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								60	B	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								61	B	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								62	B	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								63	A	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								64	A	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								65	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								66	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								67	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								68	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								69	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								70	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								71	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								72	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								73	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								74	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								75	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								76	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								77	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								78	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								79	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								80	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								81	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								82	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								83	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								84	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								85	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								86	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								87	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								88	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								89	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								90	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								91	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								92	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								93	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								94	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								95	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								96	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								97	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								98	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								99	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								100	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								101	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								102	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								103	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								104	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								105	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								106	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								107	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								108	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								109	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								110	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								111	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								112	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								113	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								114	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"

See footnotes at end of device types 03, 04, 11, and 12.

TABLE III. Group A inspection for device types 03_04_11_ and 12.
Terminal conditions (pins not designated may be H ≥ 2.0 V, or L ≤ 0.7 V, or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F		1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Limits		Unit	
			Case I/	Test no. (Device types)																	Measured terminal	Min		Max
9 Tc = +125°C	F ₁ MAX	3003 (Fig 6)			Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _b	Q _a	Ripple carry	V _{cc}			MHz	
	t _{pLH4}	"	151	157	154	168					4.5 V	GND	4.5 V	4.5 V					OUT	5.0 V	Q _a	22		
	t _{pLH4}	"	152	158	155	169						"	"	"					OUT	"	Cik to carry	3	40	ns
	t _{pLH4}	"	153	159	156	170						"	"	"					OUT	"	Cik to carry	"	40	"
	t _{pLH5}	"	154	160	157	171						"	"	"				OUT	"	"	Cik to Q _a	"	29	"
	t _{pLH5}	"	155	161	158	172						"	"	"				OUT	"	"	Cik to Q _b	"	"	"
	t _{pLH5}	"	156	162	159	173						"	"	"		OUT				"	Cik to Q _c	"	"	"
	t _{pLH5}	"	157	163	160	174						"	"	"	OUT					"	Cik to Q _d	"	"	"
	t _{pLH5}	"	158	164	161	175						"	"	"				OUT		"	Cik to Q _e	"	32	"
	t _{pLH5}	"	159	165	162	176						"	"	"				OUT		"	Cik to Q _f	"	"	"
	t _{pLH5}	"	160	166	163	177						"	"	"		OUT				"	Cik to Q _g	"	"	"
	t _{pLH5}	"	161	167	164	178						"	"	"	OUT					"	Cik to Q _h	"	"	"
	t _{pLH6}	"	162	168	165	179		IN				"	GND	"				OUT		"	Cik to Q _i	"	29	"
	t _{pLH6}	"	163	169	166	180		IN				"	"	"				OUT		"	Cik to Q _j	"	32	"
	t _{pLH6}	"	164	170	167	181			IN			"	"	"						"	Cik to Q _k	"	29	"
	t _{pLH6}	"	165	171	168	182			IN			"	"	"				OUT		"	Cik to Q _l	"	32	"
	t _{pLH6}	"	166	172	169	183				IN		"	"	"			OUT			"	Cik to Q _m	"	29	"
	t _{pLH6}	"	167	173	170	184				IN		"	"	"			OUT			"	Cik to Q _n	"	32	"
	t _{pLH6}	"	168	174	171	185					IN	"	"	"						"	Cik to Q _o	"	29	"
t _{pLH6}	"	169	175	172	186					IN	"	"	"						"	Cik to Q _p	"	32	"	
t _{pLH7}	"	170	176	173	187						4.5 V	"	4.5 V	IN					OUT	"	EnT to C _v	"	19	"
t _{pLH7}	"	171	177	174	188						4.5 V	"	4.5 V	IN					OUT	"	EnT to C _v	"	19	"
t _{pLH8}	"	172	178	175	189		4.5 V					"	GND					OUT		"	C _v 11/	"	33	"
t _{pLH8}	"	173	179	176	190			4.5 V				"	"							"	Cir to Q _a	"	"	"
t _{pLH8}	"	174	180	177	191						"	"	"							"	Cir to Q _b	"	"	"
t _{pLH8}	"	175	181	178	192					4.5 V		"	"							"	Cir to Q _c	"	"	"
t _{pLH8}	"	175	181	178	192						"	"	"		OUT					"	Cir to Q _d	"	"	"

See footnotes at end of device types 03_04_11_ and 12.

TABLE III. Group A inspection for device types 03, 04, 11, and 12.
Terminal conditions (pins not designated may be H ≥ 2.0 V, or L ≤ 0.7 V, or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F												Measured terminal	Limits		Unit								
			Test no. (Device types)													Min	Max									
			03	04	11	12	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16				
							Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20				
10 T _c = +125°C	F _{MAX} 19/	3003 (Fig 6)	176	182	179	193	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	16	20			
	f _{PH4}	"	177	183	180	194	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20				
	f _{PH4}	"	178	184	181	195	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20				
	f _{PH5}	"	179	185	182	196	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20				
	f _{PH5}	"	180	186	183	197	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20				
	f _{PH5}	"	181	187	184	198	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20				
	f _{PH5}	"	182	188	185	199	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20				
	f _{PH5}	"	183	189	186	200	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20				
	f _{PH5}	"	184	190	187	201	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20				
	f _{PH5}	"	185	191	188	202	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20				
	f _{PH5}	"	186	192	189	203	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20				
	f _{PH6}	"	187	193	190	204	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20				
f _{PH6}	"	188	194	191	205	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20					
f _{PH6}	"	189	195	192	206	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20					
f _{PH6}	"	190	196	193	207	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20					
f _{PH6}	"	191	197	194	208	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20					
f _{PH6}	"	192	198	195	209	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20					
f _{PH6}	"	193	199	196	210	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20					
f _{PH6}	"	194	200	197	211	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20					
f _{PH7}	"	195	201	198	212	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20					
f _{PH7}	"	196	202	199	213	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20					
f _{PH8}	"	197	203	200	214	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20					
f _{PH8}	"	198	204	201	215	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20					
f _{PH8}	"	199	205	202	216	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20					
f _{PH8}	"	200	206	203	217	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q _b	Q _c	Q _a	Ripple carry	V _{cc}	20					
11	Same tests, terminal conditions, and limits as for subgroup 10, except T _c = -55°C.																									

Same terminal conditions as for subgroup 9.

See footnotes at end of device types 03, 04, 11, and 12.

1/ For case 2, pins not referenced are NC.

2/ Apply one pulse prior to measurement as follows:



3/ Apply 0.7 V for types 03 and 11; apply 2.0 V for types 04 and 12.

4/ I_{IL} limits (μA) min/max values for circuits shown:

Parameter	Terminals	Circuits						
		A	B	C	D	E	F	G
	Clear 03	-160/-400	-30/-300	-120/-360	-160/-400	-120/-360	-0/-100	-16/-400
	Clear 04	"	"	"	"	"	"	"
	Clear 11	"	"	"	"	"	"	"
	Clear 12	"	"	-290/-630	"	"	-150/-450	"
	EnP	"	"	-120/-360	"	"	"	"
	A, B, C, D	"	"	-160/-400	"	-120/-360	-150/-380	"
I_{IL5}	Load	-320/-800	-30/-300	-290/-630	-320/-800	-120/-360	-160/-400	-320/-800
	EnT	"	"	-340/-860	"	-240/-720	-300/-760	"
I_{IL6}	Clock	-160/-400	-0/-100	-290/-630	-160/-400	-180/-420	-0/-100	-160/-400

5/ For types 03 and 11, set outputs to 9th count ($Q_A = 1, Q_B = 1, Q_C = 0$) prior to measurement.

For types 04 and 12, set outputs to 15th count (Q_A, Q_B, Q_C and $Q_D = 1$) prior to measurement.

6/ Apply GND for types 03 and 11; apply 4.5 V for types 04 and 12.

7/ Only a summary of attributes data is required.

8/ A = 3.0 V minimum; B = 0.0 V or GND.

9/ H > 1.5 V; L < 1.5 V; X = don't care.

10/ The F_{max} minimum limit specified is the frequency of the input pulse. The output frequency shall be one-half of the input frequency. For type 04, circuit C, 20 MHz minimum.

11/ The limit for circuit B shall be 23 ns.

12/ For types 03 and 04, apply one clock pulse prior to test. For types 11 and 12 apply one clock pulse prior to test and another pulse during test.

13/ I_{IH13} limit for types 11 and 12; 40 μA maximum.

I_{IH14} limit for types 11 and 12; 200 μA maximum.

TABLE III. Group A inspection for device types 05 and 06.
Terminal conditions (pins not designated may be H \geq 2.0 V, or L \leq 0.7 V, or open).

Subgroup	MIL-STD-883 method	Symbol	Cases E, F Cases I/ 2	Test no.	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Limits		Unit								
					U/D	CK	A	B	C	D	EP	GND	L	ET	Q _b	Q _c	Q _B	Q _A	Ripple carry	V _{CC}	Measured terminal	Min		Max							
1	3010	I _{H18}	38	5.5 V	5.5 V															5.5 V	U/D		100	μ A							
					5.5 V																			CK							
					5.5 V	5.5 V																			A						
																										B					
																											C				
																												D			
																												EP			
																													L		
																													ET		
																													Q _b		
2	3011	I _{OS}	47	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	200								
																											Q _b				
																													Q _c		
																													Q _B		
																													Q _A		
3	3005	I _{CC}	52	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND										
																											Ripple carry				
																												V _{CC}			
2	Same tests, terminal conditions, and limits as for subgroup 1, except T _c = +125°C and V _{IC} tests are omitted.																														
3	Same tests, terminal conditions, and limits as for subgroup 1, except T _c = -55°C and V _{IC} tests are omitted.																														

See footnotes at end of device types 05 and 06.

Subgroup	Symbol	MIL-STD-883 method	Cases E, F		1	2	3	4	Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).		9	10	11	12	13	14	15	16	Limits		Unit				
			Cases 1/2	Test no.					U/D	CK									A	B		C	D	EP	GND
7 T _C = +25°C	Functional tests 4/	3014	53	A, 5/	A, 5/	B, 5/	B	B	B	GND	B	B	X	X	X	X	X	X	X						
			54	"	"	A	"	"	"	"	"	B	"	"	L	L	L	L	H/5/	"					
			55	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
			56	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"		
			57	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			58	"	"	A	"	"	"	"	"	"	"	"	"	"	H	H	"	"	"	"	"	"	"
			59	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			60	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			61	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			62	"	"	A	"	"	"	"	"	"	"	"	"	"	H	L	L	"	"	"	"	"	"
			63	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			64	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			65	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			66	"	"	A	"	"	"	"	"	"	"	"	"	"	H	L	L	"	"	"	"	"	"
			67	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			68	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			69	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			70	"	"	A	"	"	"	"	"	"	"	"	"	"	H	L	L	"	"	"	"	"	"
			71	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			72	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			73	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			74	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			75	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			76	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			77	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			78	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			79	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			80	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			81	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			82	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			83	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			84	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			85	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			86	"	"	A	"	"	"	"	"	"	"	"	"	"	H	H	H	"	"	"	"	"	"
			87	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			88	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			89	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			90	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			91	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			92	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			93	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			94	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			95	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			96	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			97	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			98	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			99	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			100	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			101	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			102	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			103	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			104	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			105	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			106	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			107	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			8	Repeat subgroup 7 at T _C = +125 and T _C = -55°C.																					

See footnotes at end of device types 05 and 06.

TABLE III. Group A inspection for device type 06 - Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F		Cases 1/2		Cases 1/2		Cases 1/2		Cases 1/2		Cases 1/2		Cases 1/2		Cases 1/2		Cases 1/2		Cases 1/2		Measured terminal	Limits		Unit					
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20		Min	Max						
7 Tc = +25°C	Functional tests 4/	3014	U/D	B 5/	A	A	A	A	B	ET	Qb	Qc	Qb	Qa	Ripple carry	Vcc															
			Test no.	109	110	111	112	113	114	115	116	117	118	119	120	121	122	123	124	125	126	127	128								
				"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"		
				"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"		
				"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"		
				"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"		
				"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
				"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
				"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
				"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
				"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
				"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
				"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
				"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
				"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
				"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
			8	Repeat subgroup 7 at Tc = +125 and Tc = -55°C.																											

See footnotes at end of device types 05 and 06.

TABLE III. Group A inspection for device type 05 - Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F		1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Limits		Unit		
			Test no.	Cases 1/2	U/D	CK	A	B	C	D	EP	GND	L	ET	Q _b	Q _c	Q _b	Q _a	Ripple carry	V _{cc}	Measured terminal	Min		Max	
9 T _c = +25°C	t _{PHL5}	See fig. 7	108	5.0 V	IN	IN	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK TO Q _a	3	22	ns	
			109	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK TO Q _b	"	"	"
			110	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK TO Q _c	"	"	"
			111	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK TO Q _d	"	"	"
			112	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK TO Q _e	"	"	"
			113	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK TO Q _f	"	"	"
			114	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK TO Q _g	"	"	"
			115	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK TO Q _h	"	"	"
			116	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK TO RC	"	32	"
			117	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK TO RC	"	30	"
			118	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK TO Q _a	"	22	"
			119	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK TO Q _a	"	22	"
			120	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK TO Q _b	"	"	"
			121	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK TO Q _b	"	"	"
			122	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK TO Q _c	"	"	"
123	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK TO Q _c	"	"	"			
124	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK TO Q _d	"	"	"			
125	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK TO Q _d	"	"	"			
126	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK TO Q _e	"	24	"			
127	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK TO Q _e	"	15	"			
128	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	U/D to RC	"	28	"			
129	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	U/D to RC	"	22	"			
130	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	ET to RC	"	24	"			
131	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	ET to RC	"	15	"			
132	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	U/D to RC	"	28	"			
133	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	U/D to RC	"	22	"			
134	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK to Q _h	"	25	MHz			
135	5.0 V	IN	IN	GND	GND	GND	GND	GND	IN	5.0 V	GND	GND	OUT	OUT	OUT	OUT	OUT	5.0 V	CK to Q _h	"	25	MHz			

See footnotes at end of device types 05 and 06.

TABLE III. Group A inspection for device type 05- Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F		Terminal conditions																Measured terminal	Limits		Unit						
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18		19	20		Min	Max				
10 T _c = +125°C	t _{PLH6}	See fig. 7	136	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	CK TO Q _A	3	26	ns	
			137	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	CK TO Q _B	"	"	"	
	t _{PHL5}	"	138	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	CK TO Q _C	"	"	"	
			139	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	CK TO Q _D	"	"	"	
			140	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	CK TO Q _E	"	"	"	
			141	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	CK TO Q _F	"	"	"	
			142	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	CK TO Q _G	"	"	"	
	t _{PHL15}	"	143	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	CK TO Q _H	"	"	"	
			144	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	CK TO Q _I	"	"	"	
			145	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	CK TO RC	"	37	"	
	11	t _{PLH12}	"	146	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	CK TO RC	"	35	"
		t _{PLH6}	"	146	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	CK TO Q _A	"	26	"
		t _{PHL6}	"	147	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	CK TO Q _A	"	"	"
		t _{PHL5}	"	148	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	CK TO Q _B	"	"	"
		t _{PHL5}	"	149	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	CK TO Q _B	"	"	"
		t _{PLH6}	"	150	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	CK TO Q _C	"	"	"
		t _{PHL5}	"	151	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	CK TO Q _C	"	"	"
t _{PHL5}		"	152	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	CK TO Q _C	"	"	"	
t _{PHL5}		"	153	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	CK TO Q _D	"	"	"	
t _{PHL7}		"	154	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	ET to RC	"	28	"	
t _{PHL7}	"	155	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	ET to RC	"	18	"		
t _{PHL11}	"	156	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	U/D to RC	"	33	"		
t _{PLH9}	"	157	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	U/D to RC	"	26	"		
t _{PHL7}	"	158	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	ET to RC	"	28	"		
t _{PHL7}	"	159	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	ET to RC	"	18	"		
t _{PHL11}	"	160	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	U/D to RC	"	33	"		
t _{PLH9}	"	161	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	U/D to RC	"	26	"		
F _{MAX}	"	162	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	CK to Q _n	25		MHz		
F _{MAX}	"	163	U/D	CK	2	3	4	A	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	CK to Q _n	25		MHz		

Same conditions as for subgroup 9.

Same tests, conditions and limits as for subgroup 10 except T_c = -55°C and V_{CC} = 4.5 for F_{MAX}.

See footnotes at end of device types 05 and 06.

TABLE III. Group A inspection for device type 06.
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F		1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Limits		Unit							
			Cases 1/ 2	F	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	19	20	Min		Max						
9 Tc = +25°C	I _{PH5}	See fig. 7	129	5.0 V	U/D	OK	A	B	C	D	EP	GND	L	ET	Q _b	Q _c	Q _b	Q _a	Ripple carry	5.0 V	3	22	ns							
			130	5.0 V	"	"	"	"	"	"	"	"	"	"	"	"	OUT	"	"	"	"	"	"	"	"					
			131	"	"	"	"	"	5.0 V	"	"	"	"	"	"	"	OUT	"	"	"	"	"	"	"	"	"				
	I _{PH5}	"	"	132	"	"	"	"	5.0 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"				
				133	"	"	"	"	5.0 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
				134	"	"	"	"	5.0 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"		
	I _{PH5}	"	"	135	"	"	"	"	5.0 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
				136	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
				137	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
	I _{PH2}	"	"	138	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
				139	GND	"	"	5.0 V	"	"	"	"	"	5.0 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
				140	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
	I _{PH5}	"	"	141	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
				142	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
				143	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
I _{PH5}	"	"	144	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"				
			145	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			146	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
I _{PH7}	"	"	147	5.0 V	" ZI	"	5.0 V	5.0 V	"	"	"	5.0 V	IN	"	"	"	"	"	"	"	"	"	"	"	"					
			148	5.0 V	"	"	"	"	"	"	"	"	"	5.0 V	IN	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
			149	IN	IN ZI	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
I _{PH9}	"	"	150	IN	IN	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"					
			151	GND	IN ZI	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			152	GND	IN	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
I _{PH9}	"	"	153	IN	IN ZI	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"					
			154	IN	IN	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			155	5.0 V	IN	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
F _{MAX}	"	"	156	GND	IN	5.0 V	5.0 V	5.0 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"						
			"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"

See footnotes at end of device types 05 and 06.

TABLE III. Group A inspection for device type 06.
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Measured terminal	Limits		Unit		
																					17	18		19	20
10 T _C = +125°C	t _{PLH5}	See fig. 7	Cases 1/2	U/D	CK	4	5	7	8	9	10	12	13	14	15	17	18	19	20	CK TO Q _A	3	26	ns		
																					CK TO Q _B	"	"	"	
	t _{PHL5}	"	"	Test no.	U/D	CK	4	5	7	8	9	10	12	13	14	15	17	18	19	20	CK TO Q _C	36	"	"	
																						CK TO Q _B	"	"	"
																						CK TO Q _C	"	"	"
																						CK TO Q _D	"	"	"
																						CK TO Q _E	"	"	"
																						CK TO Q _F	"	"	"
																						CK TO Q _G	"	"	"
																						CK TO Q _H	"	"	"
	t _{PHL15}	"	"	"	U/D	CK	4	5	7	8	9	10	12	13	14	15	17	18	19	20	CK TO RC	40	"	"	
																						CK TO RC	"	"	"
	t _{PLH12}	"	"	"	U/D	CK	4	5	7	8	9	10	12	13	14	15	17	18	19	20	CK TO RC	38	"	"	
																						CK TO Q _A	"	"	"
																						CK TO Q _B	"	"	"
																						CK TO Q _C	"	"	"
																						CK TO Q _D	"	"	"
																						CK TO Q _E	"	"	"
																						CK TO Q _F	"	"	"
																						CK TO Q _G	"	"	"
CK TO Q _H																						"	"	"	
CK TO Q _I																						"	"	"	
CK TO Q _J																						"	"	"	
t _{PHL17}																						"	"	"	U/D
	ET to RC	"	"	"																					
	ET to RC	"	"	"																					
	ET to RC	"	"	"																					
	ET to RC	"	"	"																					
	ET to RC	"	"	"																					
	ET to RC	"	"	"																					
	ET to RC	"	"	"																					
	ET to RC	"	"	"																					
	ET to RC	"	"	"																					
	ET to RC	"	"	"																					
	ET to RC	"	"	"																					
t _{PHL11}	"	"	"	U/D	CK	4	5	7	8	9	10	12	13	14	15	17	18	19	20	U/D to RC	37	"	"		
																					U/D to RC	"	"	"	
t _{PLH9}	"	"	"	U/D	CK	4	5	7	8	9	10	12	13	14	15	17	18	19	20	U/D to RC	32	"	"		
																					U/D to RC	"	"	"	
t _{PHLZ}	"	"	"	U/D	CK	4	5	7	8	9	10	12	13	14	15	17	18	19	20	ET to RC	32	"	"		
																					ET to RC	"	"	"	
t _{PHL7}	"	"	"	U/D	CK	4	5	7	8	9	10	12	13	14	15	17	18	19	20	ET to RC	28	"	"		
																					ET to RC	"	"	"	
t _{PHL11}	"	"	"	U/D	CK	4	5	7	8	9	10	12	13	14	15	17	18	19	20	U/D to RC	37	"	"		
																					U/D to RC	"	"	"	
t _{PHH9}	"	"	"	U/D	CK	4	5	7	8	9	10	12	13	14	15	17	18	19	20	U/D to RC	32	"	"		
																					U/D to RC	"	"	"	
F _{MAX}	"	"	"	U/D	CK	4	5	7	8	9	10	12	13	14	15	17	18	19	20	CK to Q _n	25	"	MHz		
																					CK to Q _n	25	"	MHz	

Same conditions as for subgroup 9.

Same tests, conditions and limits as for subgroup 10 except T_C = -55°C and V_{CC} = 4.5 for F_{MAX}.

See footnotes at end of device types 05 and 06.

- 1/ Case 2, pins not referenced are N/C.
- 2/ Apply one clock pulse prior to test as follows:



- 3/ I_{IL} limits (μA) min/max values for circuits shown:

Parameter	Terminals	Circuits						
		A	B	C	D	E	F	G
I_{IL12}	A, B, C, D			-160/-400			-0.5/-400	
I_{IL13}	$\overline{U/D}$, CK, L			-160/-400			-135/-370	
I_{IL14}	EP			160/-400			-150/-385	
I_{IL15}	ET			-140/-720			-280/-760	

- 4/ Only a summary of attributes data is required.
- 5/ A = 3.0 V minimum; B = 0.0 V or GND.
- 6/ H > 1.5 V; L < 1.5 V; X = don't care.
- 7/ Apply one clock pulse with "L" low prior to test.
- 8/ Apply three clock pulses prior to test.
- 9/ Apply one clock pulse with "A" low prior to test.
- 10/ On (Q_A , Q_B , Q_C , and Q_D) shall respond as specified in the truth table with the minimum F_{MAX} frequency input to "CK".

TABLE III. Group A inspection for device types 07 and 08 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F		Cases 1/2		Cases 3/4		Cases 5/7		Cases 6/8		Cases 9/10		Cases 11/12		Cases 13/14		Cases 15/16		Limits		Unit				
			Test no.	Q _A	Q _B	Q _C	Q _D	Q _b	Count down	Count up	Q _c	Q _b	GND	D	C	Load	Ripple Carry	Borrow	Clear	A	V _{CC}	Measured terminal		Min	Max		
1 T _c = +25°C	I _{OS}	3011	2	Q _B	GND																	4/	4/	mA			
			3	Q _A	GND																						
			4	Q _B	GND																						
			5	Q _C	GND																						
			7	Q _C	GND																						
2	I _{CC}	3005	5																								
			7																								
			10																								
3			Same tests, terminal conditions, and limits as for subgroup 1, except T _c = +125°C and V _{IC} tests are omitted.																								
			Same tests, terminal conditions, and limits as for subgroup 1, except T _c = -55°C and V _{IC} tests are omitted.																								

See footnotes at end of device types 07 and 08.

TABLE III. Group A inspection for device types 07 - Continued.
Terminal conditions (pins not designated may be H \geq 2.0 V, or L \leq 0.7 V, or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F Cases 1/2 Test no.	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Measured terminal	Limits		Unit			
				B	Q _B	Q _A	Count down	Count up	Q _C	Q _b	GND	D	C	Load	Ripple Carry	Borrow	Clear	A	V _{CC}		Min	Max				
7 T _c = +25°C	Functional tests 5/	3014	52	A 6/	L	L	L	A	L	L	GND	A	A	A	H	H	A	A	A	See Z/						
			53	"	"	L	L	A	"	"	"	"	"	"	"	"	"	"	"		"	"				
			54	"	"	L	"	"	"	B	"	"	"	"	"	"	"	"	"		"	"	"			
			55	"	"	"	"	H	"	A	"	"	"	"	"	"	"	"	"		"	"	"			
			56	"	"	"	"	H	"	B	"	"	"	"	"	"	"	"	"		"	"	"			
			57	"	"	"	H	"	"	A	"	"	"	"	"	"	"	"	"		"	"	"			
			58	"	"	"	"	L	"	B	"	"	"	"	"	"	"	"	"		"	"	"			
			59	"	"	"	"	"	H	"	A	"	"	"	"	"	"	"	"		"	"	"			
			60	"	"	"	"	"	H	"	B	"	"	"	"	"	"	"	"		"	"	"			
			61	"	"	"	"	L	"	A	"	H	"	"	"	"	"	"	"		"	"	"			
			62	"	"	"	"	"	L	"	B	"	"	"	"	"	"	"	"		"	"	"			
			63	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"		"	"	"			
			64	"	"	"	"	"	"	"	B	"	"	"	"	"	"	"	"		"	"	"			
			65	"	"	"	"	"	H	"	A	"	"	"	"	"	"	"	"		"	"	"			
			66	"	"	"	"	"	L	"	B	"	"	"	"	"	"	"	"		"	"	"			
			67	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"		"	"	"			
			68	"	"	"	"	"	"	"	B	"	"	"	"	"	"	"	"		"	"	"			
			69	"	"	"	"	"	L	"	A	L	H	"	"	"	"	"	"		"	"	"			
			70	"	"	"	"	"	"	"	B	"	"	"	"	"	"	"	"		"	"	"			
			71	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"		"	"	"			
			72	"	"	"	"	"	"	"	B	"	"	"	"	"	"	L	"		"	"	"			
			73	"	"	"	"	"	"	"	A	"	"	"	"	"	"	H	"		"	"	"			
			74	"	"	"	"	"	"	"	B	"	"	"	"	"	"	"	L		"	"	"			
			75	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"		"	"	"			
			76	"	"	"	"	"	"	"	B	"	"	"	"	"	"	"	H		"	"	"			
			77	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"		"	"	"			
			78	"	"	"	"	"	"	"	B	"	"	"	"	"	"	"	"		"	"	"			
			79	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"		"	"	"			
			80	"	"	"	"	"	"	"	B	"	"	"	"	"	"	"	"		"	"	"			
			81	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"		"	"	"			
			82	"	"	"	"	"	"	"	B	"	"	"	"	"	"	"	"		"	"	"			
			83	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"		"	"	"			
			84	"	"	"	"	"	"	"	B	"	"	"	"	"	"	"	"		"	"	"			
			85	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"		"	"	"			
			86	"	"	"	"	"	"	"	B	"	"	"	"	"	"	"	"		"	"	"			
			87	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"		"	"	"			
			88	"	"	"	"	"	"	"	B	"	"	"	"	"	"	"	"		"	"	"			
			89	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"		"	"	"			
			90	"	"	"	"	"	"	"	B	"	"	"	"	"	"	"	"		"	"	"			
			91	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"		"	"	"			
			92	"	"	"	"	"	"	"	B	"	"	"	"	"	"	"	"		"	"	"			
			93	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"		"	"	"			
			94	"	"	"	"	"	"	"	B	"	"	"	"	"	"	"	"		"	"	"			
			95	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"		"	"	"			
			96	"	"	"	"	"	"	"	B	"	"	"	"	"	"	"	"		"	"	"			
			97	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"		"	"	"			
			98	"	"	"	"	"	"	"	B	"	"	"	"	"	"	"	"		"	"	"			
			99	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"		"	"	"			
			100	"	"	"	"	"	"	"	B	"	"	"	"	"	"	"	"		"	"	"			
			101	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"		"	"	"			

See footnotes at end of device types 07 and 08.

TABLE III. Group A inspection for device types 07 - Continued.
Terminal conditions (pins not designated may be high ≥ 2.0 V, or low ≤ 0.7 V, or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F		1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Limits		Unit		
			1	2																	Min	Max			
7 Tc = +25°C	Functional tests 5/	3014	Test no.	B	Q _A	Q _B	Q _A	Count down	Count up	Q _C	Q _D	GND	D	C	Load	Ripple Carry	Borrow	Clear	A	V _{CC}					
			102	A 6/	H	H	A	A	"	"	H	H	GND	A	A	B 6/	H	H	B	A	4.5V				
			103	A	"	"	"	"	"	"	"	"	"	A	A	A	"	"	"	"	A	"	"	"	
			104	B	"	"	"	"	"	"	"	"	"	B	B	A	"	"	"	"	B	"	"	"	
			105	"	"	L	L	"	"	"	"	L	L	"	"	"	B	"	"	"	"	"	"	"	
			106	"	"	"	"	"	"	B	"	"	"	"	"	"	"	"	L	"	"	"	"	"	
			107	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"	H	"	"	"	"	"	
			108	"	"	"	"	"	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
			109	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	
			110	"	"	"	"	"	"	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	
			111	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	A	"	"	"	
			112	"	"	"	"	"	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
			113	"	"	"	"	"	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	
			114	"	"	"	"	"	"	"	A	B	"	"	"	"	"	"	"	"	"	"	"	"	
			115	"	"	"	"	"	"	"	A	A	"	"	"	"	"	"	"	"	"	"	"	"	
8	Repeat subgroup 7 at T _C = +125 and T _C = -55°C.																								

See footnotes at end of device types 07 and 08.

TABLE III. Group A inspection for device types 07 and 08 – Continued.
Terminal conditions (pins not designated may be high ≥ 2.0 V, or low ≤ 0.7 V, or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F		1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Limits		Unit				
			Case 1/ 2	Case 2/ 08	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Min	Max						
9 Tc = +25°C	F_{MAX}^A	3003 9/	116	161			OUT	5.0 V	IN			GND			5.0 V			GND		5.0 V	Count up to Q _A	22		MHz			
			117	162			OUT	5.0 V	IN							5.0 V			GND			Count down to Q _A	22		MHz		
	F_{MAX}^B	"	118	163			OUT												GND	5.0 V		3	45	ns			
			119	164	5.0 V	OUT																					
	t_{PLH9}	"	120	165							OUT				5.0 V												
			121	166								OUT			5.0 V												
	t_{PHL10}	"	122	167					OUT																		
			123	168	GND	OUT																					
	t_{PLH9}	"	124	169							OUT																
			125	170								OUT															
	t_{PHL9}	"	126	171						IN						5.0 V											
			127	172																							
	t_{PLH9}	"	128	173							OUT																
			129	174								OUT															
	t_{PHL9}	"	130	175						IN																	
			131	176								OUT															
	t_{PHL11}	"	132	177																							
			133	178																							
	t_{PHL11}	"	134	179						IN																	
135			180																								
t_{PHL11}	"	136	181																								
		137	182								OUT																
t_{PHL11}	"	138	183						IN																		
		139	184								OUT																
t_{PHL12}	"	140	185																								
		141	186																								
t_{PHL12}	"	142	187																								
		143	188	5.0 V	OUT										10/												
t_{PHL12}	"	144	189							OUT				5.0 V													
		145	190								OUT			5.0 V													

See footnotes at end of device types 07 and 08.

TABLE III. Group A inspection for device types 07 and 08 – Continued.
Terminal conditions (pins not designated may be high $\geq 2.0 V_i$ or low $\leq 0.7 V_i$ or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Measured terminal	Limits		Unit		
																					Case 1/2	(Device type)		07	08
9 $T_c = +25^\circ C$	$F_{MAX}^{B/}$	3003	146	191																Count up to Q_A	22		MHz		
	$F_{MAX}^{B/}$	"	147	192																	Count down to Q_A	22		MHz	
	t_{PLH8}	"	"	148	193																Load to Q_A	3	63	ns	
		"	"	149	194																	Load to Q_B	"	"	"
		"	"	150	195																	Load to Q_C	"	"	"
		"	"	151	196																	Load to Q_B	"	"	"
	t_{PHL10}	"	"	152	197																	Load to Q_A	"	"	"
		"	"	153	198																	Load to Q_B	"	"	"
		"	"	154	199																	Load to Q_C	"	"	"
		"	"	155	200																	Load to Q_B	"	"	"
	t_{PLH9}	"	"	156	201																	Count up to Q_A	"	60	"
		"	"	157	202																	Count up to Q_B	"	"	"
		"	"	158	203																	Count up to Q_C	"	"	"
		"	"	159	204																	Count up to Q_B	"	"	"
		"	"	160	205																	Count down to Q_B	"	"	"
		"	"	161	206																	Count down to Q_C	"	"	"
	t_{PHL11}	"	"	162	207																	Count down to Q_B	"	"	"
"		"	163	208																	Count down to Q_A	"	"	"	
"		"	164	209																	Count up to Q_A	"	73	"	
"		"	165	210																	Count up to Q_B	"	"	"	
"		"	166	211																	Count up to Q_C	"	"	"	
"		"	167	212																	Count up to Q_B	"	"	"	
t_{PHL12}	"	"	168	213																	Count down to Q_B	"	"	"	
	"	"	169	214																	Count down to Q_C	"	"	"	
	"	"	170	215																	Count down to Q_A	"	"	"	
	"	"	171	216																	Clear to Q_A	"	56	"	
	"	"	172	217																	Clear to Q_B	"	"	"	
	"	"	173	218																	Clear to Q_C	"	"	"	
11	Same tests, terminal conditions, and limits as for subgroup 10, except $T_c = -55^\circ C$.	"	174	219																	Clear to Q_C	"	"	"	
		"	175	220																	Clear to Q_B	"	"	"	

Same terminal conditions as for subgroup 9.

See footnotes at end of device types 07 and 08.

- 1/ Case 2, pins not referenced are N/C.
- 2/ Apply 0.7 V for device type 07; apply 2.0 V for device type 08.
- 3/ I_L limits (μA) min/max values for circuits shown:

Parameter	Terminals	Circuits						
		A	B	C	D	E	F	G
I_{L9}	A	-160/-400	-160/-400	-160/-400	-100/-340	-100/-340	-120/-360	-135/-370
	B	"	"	"	"	"	"	"
	C	"	"	"	"	"	"	"
	D	"	"	"	"	"	"	"
I_{L10}	Load	-100/-340	"	-150/-380	-120/-360	-120/-360	"	-100/-340
	Clear	-160/-400	"	-150/-380	"	"	"	-135/-370
I_{L11}	Count up	"	"	"	"	"	"	"
	Count down	"	"	"	"	"	"	"

- 4/ I_{OS} limits (mA) min/max values for circuits shown: -15/-100 for circuits A, C, D, E, F, and G and -15/-110 for circuit B.
- 5/ Only a summary of attributes data is required.
- 6/ A = 3.0 V minimum; B = 0.0 V or GND.
- 7/ H > 1.5 V; L < 1.5 V; X = don't care.
- 8/ F_{MAX} minimum limit specified is the frequency of the input pulse. The output frequency shall be one-half of the input frequency.
- 9/ See figure 8 for device type 07 and figure 9 for device type 08.
- 10/ Apply momentary GND, then 4.5 V minimum prior to input pulses. Maintain 4.5 V minimum for measurement.

TABLE III. Group A inspection for device types 09 and 13 - Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F		1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Limits		Unit						
			Test no.	2																	Min	Max							
1 Tc = +25°C	V _{OL}	3007	1	2	0.7 V	4 mA	4 mA																						
		"	2																										
		"	3																										
		"	4								4 mA																		
		"	5							2.0 V																			
		"	6							0.7 V																			
		3006	7			2.0 V	-0.4 mA																						
		"	8																										
		"	9																										
		"	10																										
		"	11																										
"	12																												
"	13																												
"	14																												
"	15																												
"	16																												
"	17																												
"	18																												
"	19																												
"	20																												
"	21	3009																											
"	22																												
"	23																												
"	24																												
"	25																												
"	26																												
"	27																												
"	28																												
"	29	3010																											
"	30																												
"	31																												
"	32																												
"	33																												
"	34																												
"	35																												
"	36																												
"	37																												

See footnotes at end of device types 09 and 13.

TABLE III. Group A inspection for device types 09 and 13 - Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F Cases 1/ 2	Test no.	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Limits		Unit																										
																					17	18		19	20	Measured terminal	Min	Max																					
1	I _{H18}	3010	38	5.5 V	B	Q _B	Q _A	Enable G	Down/Up	Q _C	Q _B	GND	D	C	Load	Max/Min	Ripple Carry	Clock	A	5.5 V	B	100	"	μA																									
																									39	5.5 V	Down/up	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"		
																									40	5.5 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																									41	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																									42	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																									43	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																									44	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																									45	5.5 V	GND	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																									46	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																									47	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
2	I _{OS}	3011	48	GND	Q _B	Q _A	GND	5.5 V	GND	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	4/	4/	mA																										
																								48	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"				
																								49	GND	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
3	I _{CC}	3005	51	GND	Q _B	Q _A	5.5 V	GND	5.5 V	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	35	"	"																										
																								50	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"				
2	Same tests, terminal conditions, and limits as for subgroup 1, except T _C = +125°C and V _{IC} tests are omitted.																																																
3	Same tests, terminal conditions, and limits as for subgroup 1, except T _C = -55°C and V _{IC} tests are omitted.																																																

See footnotes at end of device types 09 and 13.

TABLE III. Group A inspection for device types 09 - Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883C method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Limits		Unit																									
																				17	18		19	20	Measured terminal	Min	Max																				
7 Tc = +25°C	Functional tests 5/		Cases 1/2	B	Q _B	Q _A	Enable G	Down/up	Q _C	Q _D	GND	D	C	Load	Max/Min	Ripple Carry	Clock	A	V _{CC}	4.5 V																											
																								52	A &/	H	B &/	B	H	A	A	A	A	GND	A	A	B	H	H	A	A	A	A				
																								53	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								54	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								55	B	"	"	"	"	"	"	"	"	"	"	B	B	A	"	"	B	B	B	B	"	"	"
																								56	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								57	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								58	A	"	"	"	"	"	"	"	"	"	"	A	A	"	"	"	"	"	"	"	"	"	"
																								59	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								60	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								61	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								62	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								63	B	"	"	"	"	"	"	"	"	"	"	B	B	"	"	"	"	"	"	"	"	"	"
																								64	A	"	"	"	"	"	"	"	"	"	"	A	A	"	"	"	"	"	"	"	"	"	"
																								65	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								66	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								67	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								68	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								69	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								70	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								71	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								72	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								73	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								74	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								75	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								76	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								77	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								78	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								79	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								80	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								81	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								82	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								83	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								84	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								85	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								86	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								87	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								88	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								89	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								90	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								91	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								92	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								93	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								94	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								95	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								96	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								97	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								98	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								99	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								100	B	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
																								101	A	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"

See footnotes at end of device types 09 and 13.

TABLE III. Group A inspection for device types 13 - Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F		Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).																Measured terminal		Limits		Unit	
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	Min	Max		
7 Tc = +25°C	Functional tests 5/	3014	Test no.	B	B6/	B	A6/	B	GND	Qc	Qb	GND	D	C	Load	Max/Min	Ripple carry	Clock	A	Vcc	4.5V					
			52	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
			53	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			54	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			55	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			56	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			57	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			58	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			59	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			60	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			61	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			62	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			63	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			64	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			65	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			66	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			67	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			68	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			69	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			70	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			71	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			72	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			73	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			74	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			75	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			76	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			77	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			78	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			79	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			80	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			81	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			82	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			83	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			84	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			85	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			86	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			87	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			88	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			89	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			90	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			91	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			92	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			93	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			94	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			95	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			96	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			97	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			98	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			99	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			100	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
			101	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"

See footnotes at end of device types 09 and 13.

TABLE III. Group A inspection for device types 09 and 13 - Continued.
Terminal conditions (pins not designated may be H \geq 2.0 V, or L \leq 0.7 V, or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F		1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Limits		Unit			
			Case 1	Case 2	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19		20	Min	Max
9 Tc = +25°C	F _{MAX} g/	3003						GND							5.0 V								18		MHz	
	t _{PHL10}	"	152	150											IN								3	38	ns	
		"	153	151																						"
		"	154	152	5.0 V	OUT																				"
		"	155	153						OUT					5.0 V											"
		"	156	154							OUT															"
	t _{PHL13}	"	157	155																						"
		"	158	156	GND	OUT																				55
		"	159	157						OUT																"
		"	160	158							OUT				GND											"
	t _{PHL11}	"	161	159												5.0 V										29
		"	162	160			OUT																			"
		"	163	161							OUT															"
		"	164	162																						"
	t _{PHL14}	"	165	163																						41
	"	166	164																						"	
	"	167	165							OUT															"	
	"	168	166																						"	
t _{PHL12}	"	169	167													OUT									47	
t _{PHL15}	"	170	168													OUT									57	

See footnotes at end of device types 09 and 13.

TABLE III. Group A inspection for device types 09 and 13 - Continued.
Terminal conditions (pins not designated may be H \geq 2.0 V, or L \leq 0.7 V, or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F Case 1/2 (Device type)	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Measured terminal	Limits		Unit	
				B	Q _b	Q _a	Enable G	Down/up	Q _c	Q _b	GND	D	C	Load	Max/Min	Ripple carry	Clock	A	V _{cc}		Min	Max		
10 T _c = +125°C	F _{MAX}	3003	171 169																	Ck to Q _a	18		MHz	
	f _{PLH10}	"	172 170																	Load to Q _a	3	53	ns	
	f _{PHL13}	"	"	173 171																Load to Q _b	"	"	"	"
		"	"	174 172																Load to Q _c	"	"	"	"
		"	"	175 173																Load to Q _b	"	"	"	"
	f _{PLH11}	"	"	176 174																Load to Q _a	"	"	77	"
		"	"	177 175																Load to Q _b	"	"	"	"
		"	"	178 176																Load to Q _c	"	"	"	"
	f _{PHL14}	"	"	179 177																Load to Q _b	"	"	"	"
		"	"	180 178																Load to Q _c	"	"	"	"
		"	"	181 179																Ck to Q _a	"	"	41	"
	f _{PHL12}	"	"	182 180																Ck to Q _b	"	"	"	"
		"	"	183 181																Ck to Q _c	"	"	"	"
		"	"	184 182																Ck to Q _b	"	"	"	"
	f _{PHL15}	"	"	185 183																Ck to Q _a	"	"	57	"
"		"	186 184																Ck to Q _b	"	"	"	"	
"		"	187 185																Ck to Q _c	"	"	"	"	
11	Same tests, terminal conditions, and limits as for subgroup 10, except T _c = -55°C.	"	188 186																Ck to Q _b	"	"	"	"	
			189 187																	Ck to Max/Min	"	"	66	"
																			Count up to Q _b	"	"	80	"	

Same terminal conditions as for subgroup 9.

See footnotes at end of device types 09 and 13.

- 1/ Case 2, pins not referenced are N/C.
- 2/ Apply 2.0 for device type 09; apply 0.7 V for device type 13.
- 3/ I_L limits (μA) min/max values for circuits shown:

Parameter	Terminals	Circuits						
		A	B	C	D	E	F	G
I _{L7}	Enable G	-360/-1080	-160/-400	-360/-1080	-360/-1080	-360/-1080	-360/-1080	-360/-1080
I _{L8}	A, B, C, D	-130/-400	-160/-400	-160/-400	-160/-400	-120/-360	-120/-360	-120/-360
	Down/up	"	"	-150/-380	"	"	"	"
	Clock	"	"	"	"	"	"	"
	Load	-100/-340	"	"	-100/-340	"	"	"

- 4/ I_{OS} limits (mA) min/max values for circuits shown: -15/-100 for circuits A, C, D, E, F, and G and -15/-110 for circuit B.
- 5/ Only a summary of attributes data is required.
- 6/ A = 3.0 V minimum; B = 0.0 V or GND.
- 7/ H > 1.5 V; L < 1.5 V; X = don't care.
- 8/ F_{MAX} minimum limit specified is the frequency of the input pulse. The output frequency shall be one-half of the input frequency.
- 9/ See figure 10 for device type 09 and figure 12 for device type 13.

TABLE III. Group A inspection for device types 10.
Terminal conditions (pins not designated may be H \geq 2.0 V; or L \leq 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases A, B, C, D	Terminal conditions (pins not designated may be H \geq 2.0 V; or L \leq 0.7 V; or open)										Limits		Unit					
				1	2	3	4	5	6	7	8	9	10	11	12		13	14	Measured terminal	Min	Max
1 Tc = +25°C	V _{OL}	3007	Test no.	1	NC	NC	V _{CC}	R _O (1)	R _O (2)	Q _B	Q _C	GND	GND	Q _A	Q _B	Q _A	Q _B	0.4	"		
				2	NC	NC	4.5 V	2.0 V	2.0 V	"	"	4 mA	"	GND	GND	2.0 V	Q _B	Q _B	"	"	
	V _{OH}	3006	Test no.	3	"	"	"	"	"	"	"	"	"	"	"	Q _C	Q _B	"	"		
				4	"	"	"	"	"	4 mA	"	"	"	"	"	Q _B	Q _B	"	"		
				5	GND	"	"	"	2/	2/	"	"	"	"	"	2/ 3/	Q _A	Q _A	2.5	"	
				6	2/ 3/	"	"	"	"	"	"	-0.4 mA	"	"	"	GND	Q _B	Q _B	"	"	
	V _{IC}	"	"	7	2/ 4/	"	"	"	"	"	"	-0.4 mA	"	"	"	Q _C	Q _C	"	"		
				8	2/ 5/	"	"	"	"	"	"	-0.4 mA	"	"	"	"	Q _B	Q _B	"	"	
	2	I _{L1}	3009	Test no.	9	"	"	"	"	"	"	"	"	"	"	"	A	A	-1.5	"	
					10	-18 mA	"	"	"	-18 mA	"	"	"	"	"	"	-18 mA	B	B	"	"
11					"	"	"	"	"	"	"	"	"	"	"	"	R _O (1)	R _O (1)	"	"	
12					"	"	"	"	"	-18 mA	"	"	"	"	"	"	R _O (2)	R _O (2)	"	"	
13					5.5 V	0.4 V	5.5 V	5.5 V	0.4 V	5.5 V	"	"	"	"	"	"	R _O (1)	R _O (1)	6/	6/	
14					"	5.5 V	0.4 V	5.5 V	0.4 V	"	"	"	"	"	"	"	R _O (2)	R _O (2)	"	"	
15					"	2/	2/	"	"	"	"	"	"	"	"	"	A	A	"	"	
16					0.4 V	"	"	"	"	"	"	"	"	"	"	"	B	B	"	"	
17					"	2.7 V	GND	2.7 V	GND	"	"	"	"	"	"	"	R _O (1)	R _O (1)	20	20	
18					"	GND	2.7 V	GND	2.7 V	"	"	"	"	"	"	"	R _O (2)	R _O (2)	20	20	
3	I _{CS}	3011	Test no.	19	"	"	"	5.5 V	GND	5.5 V	"	"	"	"	"	R _O (1)	R _O (1)	100	100		
				20	"	"	"	GND	5.5 V	"	"	"	"	"	"	R _O (2)	R _O (2)	100	100		
				21	"	"	"	5.5 V	5.5 V	"	"	"	"	"	"	A	A	80	80		
				22	"	"	"	"	"	"	"	"	"	"	"	5.5 V	A	A	400	400	
				23	2.7 V	"	"	"	"	"	"	"	"	"	"	"	B	B	13/	80	
				24	5.5 V	"	"	"	"	"	"	"	"	"	"	"	B	B	400	400	
				25	GND	"	"	"	2/	2/	"	"	"	"	"	"	Q _A	Q _A	7/	7/	
				26	2/ 3/	"	"	"	"	"	"	"	"	"	"	"	GND	Q _B	Q _B	"	"
				27	2/ 4/	"	"	"	"	"	"	"	"	"	"	"	"	Q _C	Q _C	"	"
				28	2/ 5/	"	"	"	"	"	"	"	"	"	"	"	"	Q _B	Q _B	"	"
29	GND	3005	Test no.	"	"	"	"	"	"	"	"	"	"	V _{CC}	V _{CC}	15	15				
2	Same tests, terminal conditions, and limits as for subgroup 1, except T _C = +125°C and V _{IC} tests are omitted.																				
3	Same tests, terminal conditions, and limits as for subgroup 1, except T _C = -55°C and V _{IC} tests are omitted.																				

See footnotes at end of device type 10.

TABLE III. Group A inspection for device type 10—Continued.
Terminal conditions (pins not designated may be high ≥ 2.0 V, or low ≤ 0.7 V, or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E A, B, C, D Cases 1/2	1	2	3	4	5	6	7	8	9	10	11	12	13	14	Measured terminal	Limits		Unit						
																			14	20		Min	Max				
7 Tc = +25°C	Functional tests g/	3014	Test no.	B	NC	NC	NC	V _{CC}	R _{O(1)}	R _{O(2)}	Q _b	Q _c	GND	Q _b	Q _a	NC	A	See 10/									
				B g/				4.5 V	A g/	A g/	L	L	L	L	GND	L	L			B g/							
				A																							
				B																							
				B							B																
				A																							
				A																							
				A																							
				A																							
				A																							
				A																							
				A																							
				A																							
				A																							
				8	Same tests, terminal conditions, and limits as for subgroup 7, except T _c = +125°C and -55°C.	3003	66					5.0 V	GND				GND			OUT		IN 12/	A to Q _a	29		MHz	
9 Tc = +25°C	F _{MAX}	(Fig 11)	67										11/	A g/		OUT					IN 12/	A to Q _c	3		ns		
											GND		OUT														
10 Tc = +125°C	F _{MAX}		71								OUT						IN 12/	A to Q _a	29		MHz						
11	Same tests, terminal conditions, and limits as for subgroup 10, except T _c = -55°C.		75								OUT																

See footnotes at end of device type 10.

- 1/ Case 2, pins not referenced are N/C.
- 2/ Apply 4.5 volts pulse, then ground prior to taking measurements to set device in the desired state. Maintain ground for measurement.
- 3/ Input pulse must be applied one time after R_O pulse.
- 4/ Input pulse must be applied twice after R_O pulse.
- 5/ Input pulse must be applied four times after R_O pulse.
- 6/ I_L limits (mA) min/max values for circuits shown:

Parameter	Terminals	Circuits						
		A	B	C	D	E	F	G
I _{L1}	R _O (1)	-.12/- .36 "	-.03/- .40 "	-.03/- .40 "	-.03/- .40 "	-.12/- .36 "	-	-
	R _O (2)							
I _{L2}	A	-1.0/-2.0	-1.0/-2.4	-1.0/-2.4	-1.0/-2.4	-0.5/-2.0		
	B	-0.7/-3.2	-0.7/-3.2	-0.7/-3.2	-0.4/-1.6	-0.7/-3.2		

- 7/ I_{OS} limits (mA) min/max values for circuits shown:

Parameter	Measured terminals	Circuits						
		A	B	C	D	E	F	G
I _{OS}	Q _A , Q _B , Q _C , Q _D	-15/-100	-15/-100	-30/-130	-15/-100		-15/-100	

- 8/ Only a summary of attributes data is required.
- 9/ A = 3.0 V minimum; B = 0.0 V or GND.
- 10/ H > 1.5 V; L < 1.5 V; X = don't care.
- 11/ Momentary 3.0 V (min), then ground. Maintain ground for measurement.
- 12/ F_{MAX} min limit specified is the frequency of the input pulse. The output frequency shall be one-half of the input frequency.
- 13/ The minimum limit for circuit F shall be -150 μA.

5. PACKAGING

5.1 Packaging requirements. For acquisition purposes, the packaging requirements shall be as specified in the contract or order (see 6.2). When actual packaging of materiel is to be performed by DoD or in-house contractor personnel, these personnel need to contact the responsible packaging activity to ascertain packaging requirements. Packaging requirements are maintained by the Inventory Control Point's packaging activity within the Military Service or Defense Agency, or within the military service's system command. Packaging data retrieval is available from the managing Military Department's or Defense Agency's automated packaging files, CD-ROM products, or by contacting the responsible packaging activity.

6. NOTES

(This section contains information of a general or explanatory nature which may be helpful, but is not mandatory.)

6.1 Intended use. Microcircuits conforming to this specification are intended for original equipment design applications and logistic support of existing equipment.

6.2 Acquisition requirements. Acquisition documents should specify the following:

- a. Title, number, and date of the specification.
- b. PIN and compliance identifier, if applicable (see 1.2).
- c. Requirements for delivery of one copy of the conformance inspection data pertinent to the device inspection lot to be supplied with each shipment by the device manufacturer, if applicable.
- d. Requirements for certificate of compliance, if applicable.
- e. Requirements for notification of change of product or process to contracting activity in addition to notification to the qualifying activity, if applicable.
- f. Requirements for failure analysis (including required test condition of method 5003 of MIL-STD-883), corrective action, and reporting of results, if applicable.
- g. Requirements for product assurance options.
- h. Requirements for special carriers, lead lengths, or lead forming, if applicable. These requirements shall not affect the part number. Unless otherwise specified, these requirements will not apply to direct purchase by or direct shipment to the Government.
- l. Requirements for "JAN" marking.
- j. Packaging Requirements (see 5.1)

6.3 Superseding information. The requirements of MIL-M-38510 have been superseded to take advantage of the available Qualified Manufacturer Listing (QML) system provided by MIL-PRF-38535. Previous references to MIL-M-38510 in this document have been replaced by appropriate references to MIL-PRF-38535. All technical requirements now consist of this specification and MIL-PRF-38535. The MIL-M-38510 specification sheet number and PIN have been retained to avoid adversely impacting existing government logistics systems and contractor's parts lists.

6.4 Qualification. With respect to products requiring qualification, awards will be made only for products which are, at the time of award of contract, qualified for inclusion in Qualified Manufacturers List QML-38535 whether or not such products have actually been so listed by that date. The attention of the contractors is called to these requirements, and manufacturers are urged to arrange to have the products that they propose to offer to the Federal Government tested for qualification in order that they may be eligible to be awarded contracts or purchase orders for the products covered by this specification. Information pertaining to qualification of products may be obtained from DSCC-VQ, 3990 E. Broad Street, Columbus, Ohio 43123-1199.

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6.5 Abbreviations, symbols, and definitions. The abbreviations, symbols, and definitions used herein are defined in MIL-PRF-38535, MIL-HDBK-1331, and as follows:

GND	Ground zero voltage potential
I_{IN}	Current flowing into an input terminal
V_{IC}	Input clamp voltage
V_{IN}	Voltage level at an input terminal

6.6 Logistic support. Lead materials and finishes (see 3.4) are interchangeable. Unless otherwise specified, microcircuits acquired for Government logistic support will be acquired to device class B (see 1.2.2), lead material and finish A (see 3.4). Longer length leads and lead forming should not affect the part number.

6.7 Substitutability. The cross-reference information below is presented for the convenience of users. Microcircuits covered by this specification will functionally replace the listed generic-industry type. Generic-industry microcircuit types may not have equivalent operational performance characteristics across military temperature ranges or reliability factors equivalent to MIL-M-38510 device types and may have slight physical variations in relation to case size. The presence of this information should not be deemed as permitting substitution of generic-industry types for MIL-M-38510 types or as a waiver of any of the provisions of MIL-PRF-38535.

<u>Military device type</u>	<u>Generic-industry type</u>
01	54LS90
02	54LS93
03	54LS160
04	54LS161
05	54LS168
06	54LS169
07	54LS192
08	54LS193
09	54LS191
10	54LS92
11	54LS162
12	54LS163
13	54LS190

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6.8 Manufacturers' designation. Manufacturers' circuits which form a part of this specification are designated with an "X" as shown in table IV herein.

TABLE IV. Manufacturers' designation.

Device type	Circuit	A	B	G	C	E	F	D
	Manufacturer Commercial Type	Texas Instruments, Incorporated	Signetics Corp.	National Semi-Conductor Corp.	Raytheon Company	Fairchild Semi-conductor	Motorola, Inc.	Advanced Micro Devices Inc.
01	54LS90	X	X		X	X	X	
02	54LS93	X	X	X	X	X	X	
03	54LS160A	X	X	X	X	X	X	X
04	54LS161A	X	X	X	X	X	X	X
05	54LS168			X		X		
06	54LS169A			X		X		
07	54LS192	X	X	X	X	X	X	X
08	54LS193	X	X	X	X	X	X	X
09	54LS191	X	X	X	X	X	X	X
10	54LS92	X		X	X		X	
11	54LS162A	X	X	X	X	X	X	X
12	54LS163A	X	X	X	X	X	X	X
13	54LS190	X	X	X	X	X	X	X

6.9 Change from previous issue. Asterisks are not used in this revision to identify changes with respect to the previous issue, due to the extensiveness of the changes.

MIL-M-38510/315D

Custodians:

Army - CR
Navy - EC
Air Force - 11
DLA - CC

Preparing activity:
DLA - CC

Review activities:

Army – SM, MI
Navy - AS, CG, MC, SH TD
Air Force – 03, 19, 99

(Project 5962-1996)